

GC4016

MULTI-STANDARD QUAD DDC CHIP DATA SHEET

REV 1.0

August 27, 2001

Graychip reserves the right to make changes in circuit design and/or specifications at any time without notice. The user is cautioned to verify that datasheets are current before placing orders. Information provided by Graychip is believed to be accurate and reliable. No responsibility is assumed by Graychip for its use, nor for any infringement of patents or other rights of third parties which may arise from its use. No license is granted by implication or otherwise under any patent rights of Graychip.

REVISION HISTORY

Revision	Date	Description
0.1	February 24, 2000	Original
0.2	April 10, 2000	Rewritten to reflect 2.5volt core, 3.3volt I/O power requirements, Removed all references to TQ100 thin quad flat package, All references to GC4017 are changed to GC4016, Added Vcore and Vpin descriptions throughout, Updated power consumption equations, Simplified AC timing specifications, Corrected Resampler Filter Specs, Corrected typos, and miscellaneous errors.
0.3	April 20, 2000	Corrected Table 10: GC4016 Pin Out Locations, B14 and C14 VCORE and VPAD swapped, other VPAD and GND pins added.
0.4	August 8, 2000	Minor Editing throughout Page 12, Table 2, corrected +90 and -90 values Added TAG_22 descriptions throughout Added four separate frame strobe mode descriptions Added resampler and ratio sync descriptions Added one shot mode descriptions Added parallel output timing diagram Revised initialization procedures
1.0	August 27, 2001	Minor editing throughout Electrical and Timing Specifications in Section 6 updated to match production test References to LVDS levels changed to differential inputs. Diagnostics, GC4016 Configuration Generator, IS95 and UMTS examples added

Table of Contents

1.0	KEY FEATURES	1
2.0	BLOCK DIAGRAM	1
3.0	FUNCTIONAL DESCRIPTION	2
3.1	CONTROL INTERFACE	2
3.2	INPUT FORMAT	4
3.3	THE DOWN CONVERTERS	4
3.4	MULTICHANNEL MODES	10
3.5	RESAMPLER	12
3.6	OVERALL GAIN	15
3.7	PEAK COUNTER	15
3.8	OUTPUT MODES	16
3.9	CLOCKING	22
3.10	POWER DOWN MODES	23
3.11	SYNCHRONIZATION	24
3.12	INITIALIZATION	25
3.13	DATA LATENCY	25
3.14	DIAGNOSTICS	25
3.15	JTAG	25
3.16	MASK REVISION REGISTER	26
4.0	PACKAGING	27
4.1	GC4016-PB 160 Ball Plastic Ball Grid Array (PBGA)	27
5.0	CONTROL REGISTERS	31
5.1	GLOBAL CONTROLS	31
5.2	PAGED REGISTERS	34
5.3	CFIR COEFFICIENT PAGES	35
5.4	PFIR COEFFICIENT PAGES	35
5.5	CHANNEL FREQUENCY PAGES	36
5.6	CHANNEL CONTROL PAGES	37
5.7	RESAMPLER COEFFICIENT PAGES	42
5.8	RESAMPLER CONTROL PAGE	43
5.9	RESAMPLER RATIO PAGE)	45
5.10	CHANNEL OUTPUT PAGES	45
5.11	OUTPUT CONTROL PAGE	46
6.0	SPECIFICATIONS	53
6.1	ABSOLUTE MAXIMUM RATINGS	53
6.2	RECOMMENDED OPERATING CONDITIONS	53
6.3	THERMAL CHARACTERISTICS	53
6.4	POWER CONSUMPTION	54
6.5	DC CHARACTERISTICS	54
6.6	AC CHARACTERISTICS	55
7.0	APPLICATION NOTES	56
7.1	POWER AND GROUND CONNECTIONS	56
7.2	STATIC SENSITIVE DEVICE	56
7.3	MOISTURE SENSITIVE PACKAGE	56
7.4	THERMAL MANAGEMENT	56
7.5	EXAMPLE CFIR FILTER SETS	57
7.6	EXAMPLE PFIR FILTER SETS	58
7.7	EXAMPLE RESAMPLER CONFIGURATIONS	60
7.8	GC4016 CONFIGURATION GENERATOR	61
7.9	EXAMPLE GSM APPLICATION	62
7.10	EXAMPLE IS-136 DAMPS APPLICATION	64
7.11	IS-95 NB-CDMA APPLICATION	66
7.12	UMTS WB-CDMA APPLICATION	68
7.13	DIAGNOSTICS	71
7.14	OUTPUT TEST CONFIGURATION	73

LIST OF FIGURES

Figure 1:	GC4016 Block Diagram	1
Figure 2:	Normal Control I/O Timing	3
Figure 3:	Edge Write Control Timing.....	3
Figure 4:	The Down Converter Channel	5
Figure 5:	Zero Pad Synchronization.....	6
Figure 6:	NCO Circuit.....	6
Figure 7:	Example NCO Spurs.....	7
Figure 8:	NCO Peak Spur Plot.....	7
Figure 9:	Five Stage CIC Decimate by N Filter.....	8
Figure 10:	Typical CFIR Specifications	9
Figure 11:	Typical PFIR Specifications	9
Figure 12:	Resampler Channel Block Diagram.....	12
Figure 13:	The Resampler's Spectral Response	13
Figure 14:	Wide Word Microprocessor Port.....	19
Figure 15:	Serial Output Formats.....	21
Figure 16:	Parallel Mode Timing	23
Figure 17:	GC4016 160 Pin Plastic Ball Grid Array	27
Figure 18:	GC4016 Pin Assignments.....	28
Figure 19:	Overall Spectral Responses of Example Filters.....	59
Figure 20:	Frequency Response for the Example GSM Application.....	62
Figure 21:	Frequency Response for the Example DAMPS Application	64
Figure 22:	Frequency Response for the Example IS95 Application.....	66
Figure 23:	Frequency Response for the Example UMTS Application.....	69

LIST OF TABLES

Table 1:	Input Mode Controls.....	4
Table 2:	Multichannel mode settings	12
Table 3:	Output Mode Controls.....	17
Table 4:	Channel Output Map, Synchronous Four Channel Mode.....	18
Table 5:	Channel Output Map, Synchronous Two Channel Mode.....	18
Table 6:	Channel Output Map, Single Channel Mode	18
Table 7:	Sync Modes	24
Table 8:	Recommended Sync Settings.....	24
Table 9:	Mask Revisions.....	26
Table 10:	GC4016 Pin Out Locations Top View	29
Table 11:	Global Control Registers.....	31
Table 12:	Page Assignments	34
Table 13:	CFIR Coefficient Pages	35
Table 14:	PFIR Coefficient Pages.....	35
Table 15:	Channel Control Registers.....	37
Table 16:	Resampler Coefficient Pages (Single filter mode)	42
Table 17:	Resampler Control Registers.....	43
Table 18:	Resampler Ratio Page.....	45
Table 19:	Output Control Registers	46
Table 20:	Absolute Maximum Ratings	53
Table 21:	Recommended Operating Conditions.....	53
Table 22:	Thermal Data	53
Table 23:	DC Operating Conditions.....	54
Table 24:	AC Characteristics	55
Table 25:	Example CFIR Filters.....	57
Table 26:	Default PFIR Filters.....	58
Table 27:	Resampler Bypass Mode.....	60
Table 28:	Resampler Modes.....	60
Table 29:	Desired GSM Specifications	62
Table 30:	Example GSM Configuration	63
Table 31:	Desired DAMPS Specifications.....	64
Table 32:	Example DAMPS Configuration.....	65
Table 33:	Desired IS95 NB-CDMA Specifications	66
Table 34:	Example IS95 NB-CDMA Configuration	68
Table 35:	Desired UMTS Specifications	68
Table 36:	Example UMTS Configuration	70
Table 37:	Diagnostic Test 1	71
Table 38:	Diagnostic Test 2	71
Table 39:	Diagnostic Test 3	72
Table 40:	Diagnostic Test 4.....	73

1.0 KEY FEATURES

- Input rates up to 100 MSPS
- Four independent digital down convert (DDC) channels
- Single channel GC4011 and Dual channel GC4012 derivatives are available
- Independent decimation and resampling
- Independent tuning, phase and gain controls
- Input Crossbar Switch for:
 - Four 14 bit Inputs, or
 - Three 16 bit Inputs, or
 - Three 12 bit + 3 bit exponent inputs, or
 - Two 14 bit differential inputs.
- Decimation factors of
 - 32 to 16,384 in each channel
 - 16 to 32 by combining two channels
 - 8 to 16 by combining four channels
- Zero padding for lower decimation factors
- Resampler for arbitrary decimation factors
- Peak detection counters for AGC loop controls
- Outputs can be either:
 - Bit serial, or
 - Nibble serial (link port), or
 - Parallel port, or
 - Memory mapped registers
- 12, 16, 20, or 24 bit output samples
- 0.02 Hz tuning resolution
- >100 dB far band rejection
- >115 dB spur free dynamic range
- User programmable 21 tap and 63 tap decimate by two filters, independent per channel.
- Nyquist filtering for QPSK or QAM symbol data
- Resampler provides additional filtering and allows arbitrary input/output rate selections
- Microprocessor interface for control
- Built in diagnostics
- Application examples:
 - Four 4X oversampled GSM, DAMPS, or IS95 CDMA carriers,
 - Two 8X oversampled IS95 CDMA carriers, or
 - Two 2X oversampled 3.84MB UMTS carriers, or
 - One 4X oversampled 3.84MB UMTS carrier
- Core power consumption at 80 MHz, 2.5 volts:
 - 100 mW per DAMPS channel
 - 115 mW per GSM channel
 - 115 mW per IS95 channel
 - 620 mW per 3.84MB UMTS channel
- Industrial temperature range (-40C to +85C)
- GC4016-PB 160 ball PBGA
- (15mm by 15mm) package
- 3.3volt I/O voltage, 2.5volt core voltage
- JTAG Boundary Scan

2.0 BLOCK DIAGRAM

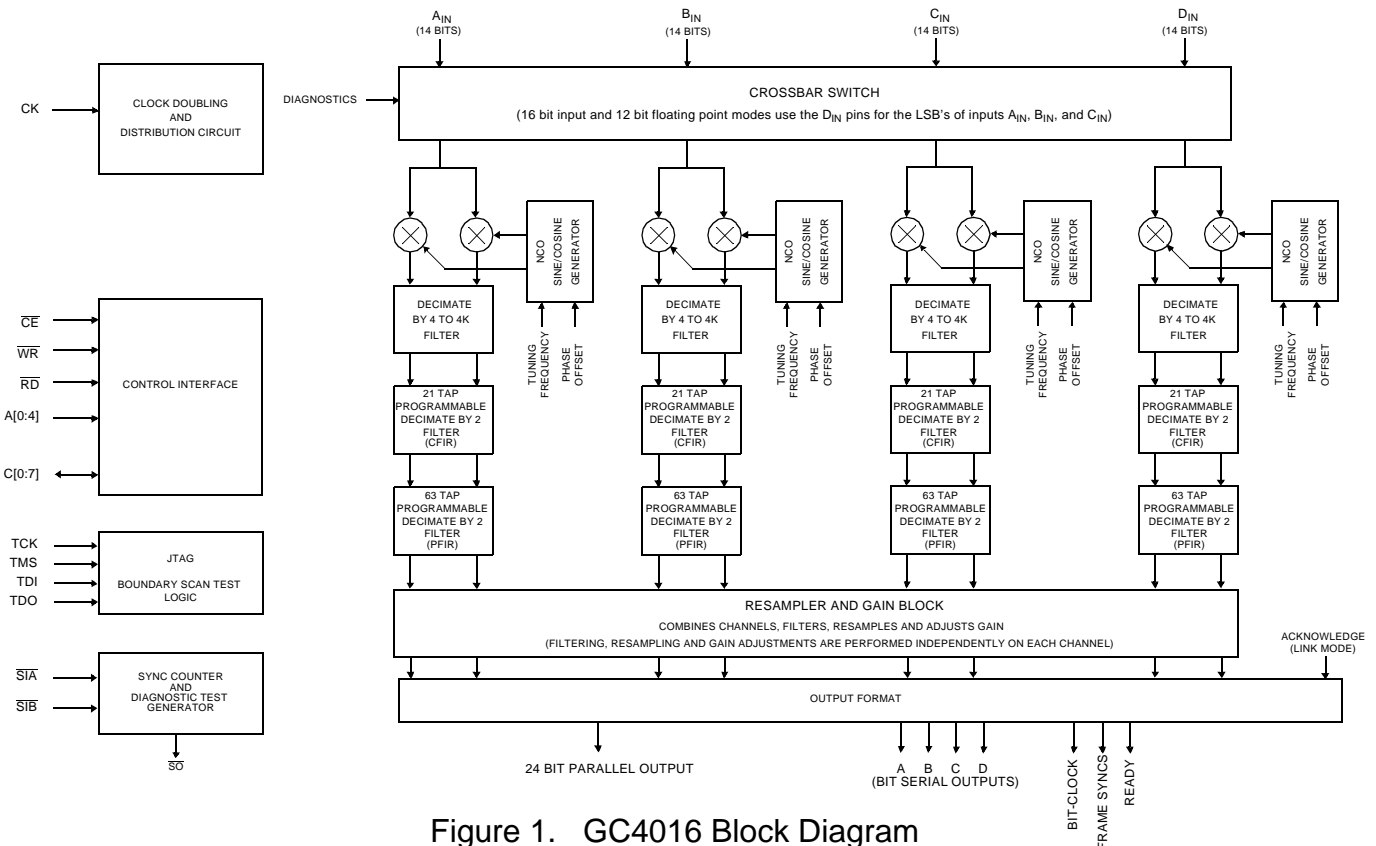


Figure 1. GC4016 Block Diagram

3.0 FUNCTIONAL DESCRIPTION

The GC4016 quad receiver chip contain four identical down-conversion circuits. Each downconvert circuit accepts a real sample rate up to 100 MHz, down converts a selected carrier frequency to zero, decimates the signal rate by a programmable factor ranging from 32 to 16,384 and then resamples the channel to adjust the sample rate up or down by an arbitrary factor. In the real output mode the output sample rate is doubled and the signal is output as a real signal centered at $F_{out}/4$. The channels may be combined to produce wider band and/or oversampled outputs or to process complex input data. The chip outputs the down-converted signals in any one of several formats (microprocessor, four serial lines, one TDM serial line, nibble, LINK, or 24 bit parallel port. The chip contains two user programmable output filters per path which can be used to arbitrarily shape the received data's spectrum. These filters can be used as Nyquist receive filters for digital data transmission. The chip also contains a resampling filter to provide additional filtering and to allow the user complete flexibility in the selection of input and output sample rates.

Two downconverter paths can be merged to be used as a single complex input down-conversion circuit. Two paths may also be combined to support wider band output rates or oversampled outputs. Four paths may be combined to support both wider band output and oversampling.

The downconverters are designed to maintain over 115 dB of spur free dynamic range and over 100 dB of out of band rejection. A five stage CIC and 20 bit internal datapaths support this high dynamic range signal processing requirement. Each downconvert circuit accepts 16 bit inputs and produces 24 bit outputs (can be rounded back to 12, 16, or 20 bits). The frequencies and phase offsets of the four sine/cosine sequence generators can be independently specified, as can the decimation and filter parameters of each circuit.

On chip diagnostic circuits are provided to simplify system debug and maintenance.

The chip receives configuration and control information over a microprocessor compatible bus consisting of an 8 bit data I/O port, a 5 bit address port, a chip enable strobe, a read strobe and a write strobe. The chip's control registers (8 bits each) are memory mapped into the 5 bit address space of the control port.

Sections 7.9 through 7.12 describe how to use the chip for GSM, D-AMPS, CDMA and UMTS applications, including control register values and filter coefficients.

3.1 CONTROL INTERFACE

The chip is configured by writing control information into control registers within the chip. The control registers are grouped into 8 global registers and 128 pages of registers, each page containing up to 16 registers. The global registers are accessed as addresses 0 through 7. Address 2 is the page register which selects which page is accessed by addresses 16 through 31. The contents of these control registers and how to use them are described in Section 5.

The registers are written to or read from using the **C[0:7]**, **A[0:4]**, **\overline{CE}** , **\overline{RD}** and **\overline{WR}** pins. Each control register has been assigned a unique address within the chip. This interface is designed to allow the GC4016 chip to appear to an external processor as a memory mapped peripheral (the pin **\overline{RD}** is equivalent to a memory chip's **\overline{OE}** pin).

An external processor (a microprocessor, computer, or DSP chip) can write into a register by setting **A[0:4]** to the desired register address, selecting the chip using the **\overline{CE}** pin, setting **C[0:7]** to the desired value and then pulsing **\overline{WR}** low. The data will be written into the selected register when both **\overline{WR}** and **\overline{CE}** are low and will be held when either signal goes high. An alternate "edge write" mode can be used to strobe the data into the selected register when either **\overline{WR}** or **\overline{CE}** goes high. This is useful for processors that do not guarantee valid data when the write strobe goes low, but guarantee that the data will be stable before the write strobe goes high. The edge write mode is necessary for these processors, as some control registers (such as most sync or reset registers) are sensitive to transient values on the **C[0:7]** data bus.

To read from a control register the processor must set **A[0:4]** to the desired address, select the chip with the **\overline{CE}** pin, and then set **\overline{RD}** low. The chip will then drive **C[0:7]** with the contents of the selected register. After the processor has read the value from **C[0:7]** it should set **\overline{RD}** and **\overline{CE}** high. The **C[0:7]** pins are turned off (high impedance) whenever **\overline{CE}** or **\overline{RD}** are high or when **\overline{WR}** is low. The chip will only drive these pins when both **\overline{CE}** and **\overline{RD}** are low and **\overline{WR}** is high.

One can also ground the **\overline{RD}** pin and use the **\overline{WR}** pin as a read/write direction control and use the **\overline{CE}** pin as a control I/O strobe. Figure 2 shows timing diagrams illustrating both I/O modes.

The edge write mode, enabled by the EDGE_WRITE control bit in register 0, allows for rising edge write cycles. In this mode the **C[0:7]** data only needs to be stable for a setup time before the rising edge of the write strobe, and held for a small hold time afterwards. This mode is appropriate for

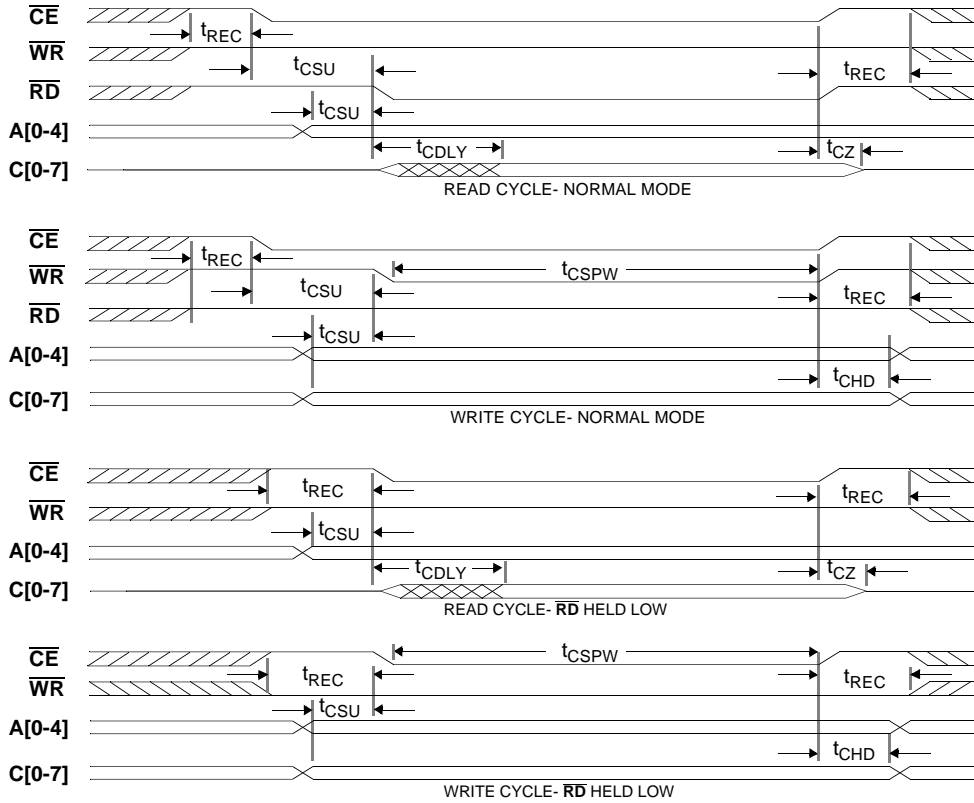


Figure 2. Normal Control I/O Timing

processors that do not provide stable data before the start of the write pulse. Figure 3 shows the timing for this mode.

The setup, hold and pulse width requirements for control read or write operations are given in Section 6.0.

The chip also operates in a four bit address mode which is intended to be used with the 4 address bit TI320C6X DSP

chip's expansion bus. Address pin A3 is grounded in this mode and the LSB of the page register (address 2) is used in its place. The four bit mode is turned on using the 4_BIT_ADDRESS control bit in address 4.

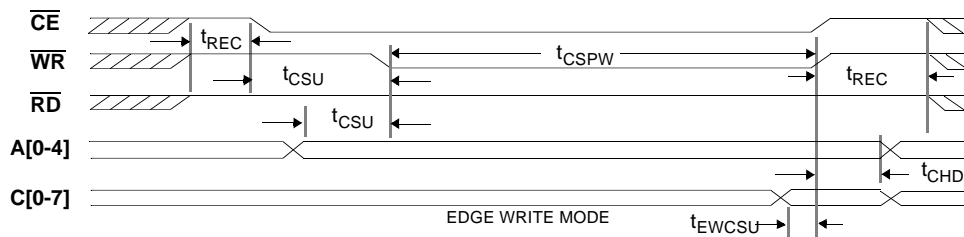


Figure 3. Edge Write Control Timing

3.2 INPUT FORMAT

The chip accept five input formats:

- (1) Four input ports of 14 bit data,
- (2) Three input ports of 16 bit data,
- (3) Two input ports of 14 bit low voltage differential data, (Contact Graychip for more information)
- (4) Three ports of 12 bit with 3 bit exponent floating point data, and
- (5) Three ports of multiplexed, dual channel, 12 bit with 3 bit exponent floating point data

The 12, 14 and 16 bit input words are in a two's complement format. The MSB_POL control bit in address 27 of the channel control pages can be used to convert offset binary data to the desired two's complement format. The 3 bit exponent in the floating point format is an unsigned integer ranging from 0 to 7. All inputs are converted to the internal 19 bit format at the input to each channel. The 14 and 16 bit input words are put into the upper 14 and 16 bits respectfully of the 19 bit word. The unused LSBs are cleared.

The 12 bit floating point word is shifted down and sign extended by the amount specified by the 3 bit exponent and then put into the MSBs of 19 bit word.

A crossbar switch allows the user to route any input source to any downconverter channel.

Table 1 shows the suggested control register settings required for each input mode. See Section 5.6 for detailed descriptions of each control setting

3.3 THE DOWN CONVERTERS

Each down converter contains an NCO and a mixer to quadrature down convert the signal to baseband, followed by a 5 stage Cascade Integrate Comb (CIC)¹ filter and two stages of decimate by two filtering to isolate the desired signal. The signal is then sent to a resampler which can increase or decrease the final output sample rate to match the post-processing requirements for baud rate sampling or oversampling.

A block diagram of the channel is shown in Figure 4.

The INPUT FORMAT circuit converts the selected input data into the 19 bit format described in Section 3.2. The ZERO PAD function allows the user to clock the chip at a higher rate than the input sample rate.

The NCO/Mixer circuit tunes the desired center frequency down to DC where it is low pass filtered by the CIC, CFIR, PFIR and Resampler filters.

The CIC filter reduces the sample rate by a programmable factor ranging from 8 to 4,096. The CIC outputs are followed by a coarse gain stage and then followed by two stages of decimate by 2 filtering. The coarse gain circuit allows the user to boost the gain of weak signals up to 42 dB in 6 dB steps. The first stage of the two stage filter is a 21 tap decimate by 2 filter (CFIR) with user programmable tap weights. The 21 tap symmetrical lowpass filter is downloaded into the chip as 12 words, 16 bits each. This filter is typically programmed to decimate by two, while

1. Hogenhauer, An Economical Class of Digital Filters for Decimation and Interpolation, IEEE transactions on ASSP, April 1981.

Table 1: Input Mode Controls

Control	Address in Channel Control Pages 7, 15, 23 and 31	14 bit mode	16 bit mode	14 bit differential mode	12 + 3 bit exponent mode	Multiplexed 12 + 3 bit exponent mode
SHIFT ¹	16	4 to 7	4 to 7	4 to 7	unused	unused
USE_SHIFT	16	1	1	1	0	0
MIX20B ¹	23	1	1	1	0	0
INPUT_SEL ³	27	0,1,2,3	0,1,2	4,5	0,1,2	0,1,2
SEL_AB	27	0	0	0	0	0 or 1
INPUT_MODE	27	0	1	0	2	2
DIFF_IN	4 (Global Page)	0	0	1	0	0

NOTES: 1. SHIFT is normally left at 4, see Section 3.3.3 for details.
 2. For decimations over 3104, MIX20B should be 0 to allow SHIFT to be less than 4, see Section 3.3.3.
 3. INPUT_SEL is used to select the input port used by each channel, 0=port A, 1=portB, 2=port C, 3=portD.

compensating for the droop in the CIC filter's passband. The second stage is a 63 tap decimate by 2 filter (PFIR) with user programmable tap weights. The user can customize the channel's spectral response using the PFIR filter. A typical use of the PFIR is to perform matched (root-raised cosine) filtering. The 63 tap symmetrical filter is downloaded into the chip as 32 words, 16 bits each. Both filters must be programmed as there are no default filter coefficient sets.

The CIC, CFIR, and PFIR filters can all be configured in a SPLITIQ mode where the channel only processes the real portion of the mixer output. In this case the minimum CIC decimation is 4. By using two channels in parallel one can process twice the output bandwidth by processing the real portion of the mixer output in one channel and the imaginary portion in a second channel (hence the name "split I/Q"). One can also offset the decimation timing between channels so that two or even four channels can be used to generate oversampled data. Using this capability each GC4016 chip can downconvert wideband signals such as 4X oversampled 5.12 Msymbol/sec MCNS data, or 4X oversampled 5 MHz WB-CDMA (UMTS) data, or two 8X oversampled NB-CDMA IS95 signals.

The PFIR will also, if desired, convert the complex output data to real. The complex to real conversion also doubles the output sample rate so that the PFIR does not decimate in this mode. This mode is useful when one wants to output real data.

The PFIR filter is followed by a resampler. The resampler filters the PFIR output to generate new sample points in between the PFIR output samples. The resampler is programmed to generate new output samples spaced in time by "R" times the PFIR output's sample period. The value R is called the resampling ratio. If R is less than one, the resampler will interpolate. If R is greater than one, the resampler will decimate. The value of R is specified as a 32

bit word (6 integer bits and 26 fractional bits). The time resolution of the new sampling points is user programmable down to 1/64th of the PFIR output's sample period. If R is a multiple of the selected time resolution, then the resampling process will have no resampling time jitter. If R is not a multiple of the time resolution, then the output will be generated at the time instant closest to the desired output time.

The resampler is typically used to either generate oversampled output data (for instance 4x oversampled QPSK or GMSK data), or to alter the sampler rate to match a multiple of the baud rate of a QPSK or GMSK signal. The resampling operation allows the user to design a system where the ADC sample rate does not need to be equal to an integer multiple of the baud rate of the desired output signal. The resampler can also be used as a final filtering stage.

A final shift circuit allows the user to shift the data by up to 15 bits to properly place it in the output word. The output word may be rounded to 12, 16, 20, or 24 bits.

The data may be output from the chip via a microprocessor interface, serial pins, or using a parallel port. The parallel port is particularly valuable for wideband output data.

3.3.1 Zero Padding

The input samples are normally clocked into the chip at the clock rate, i.e., the input sample rate is equal to the clock rate. Input rates lower than the clock rate can be accepted by using the zero pad mode. When enabled by setting the ZPAD_EN bit in address 19 of the channel control pages, the zero pad mode will insert "NZERO" zeroes between each input sample, where NZERO ranges from 0 to 15, allowing input data rates down to 1/16th the clock rate. NZERO is set in address 19

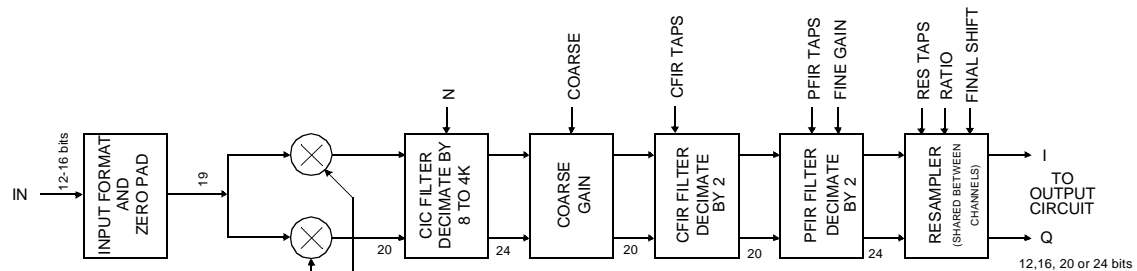


Figure 4. The Down Converter Channel

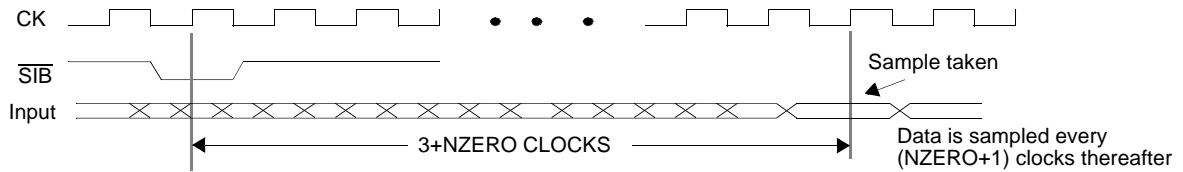


Figure 5. Zero Pad Synchronization

Zero padding lowers the effective decimation ratio. For example, the minimum complex output decimation using a single channel is normally 32. If the input data rate is 5 MSPS and the system can clock the chip at 40 MHz, then the zero pad function can be used to insert seven zeros between each sample, padding the 5 MSPS input data rate up by a factor of eight to 40 MSPS. The minimum decimation of 32 from the 40MHz rate results in an output rate of 1.25 MSPS, which is an effective decimation of 4 relative to the original 5 MSPS data.

A sync signal is used to synchronize the zero padding. The ZPAD_SYNC control in address 19 selects the source of the sync signal. The sync signal can be used to identify when the chip will sample the input data. Figure 5 shows the timing when \overline{SIB} (ZPAD_SYNC=3) is selected as the sync source.

Zero padding can be used to synchronize extracting data from a TDM bus. By adjusting the timing of \overline{SIB} as shown in Figure 5, the user can choose which sample to take from the TDM bus.

The zero pad function has a gain equal to:

$$ZPAD_GAIN = 1/(1+NZERO).$$

3.3.2 The Numerically Controlled Oscillator (NCO)

The tuning frequency of each down converter is specified as a 32 bit word and the phase offset is specified as a 16 bit word. The NCOs can be synchronized with NCOs on other chips. This allows multiple down converter outputs to be coherently combined, each with a unique phase and amplitude. A block diagram of the NCO circuit is shown in Figure 6.

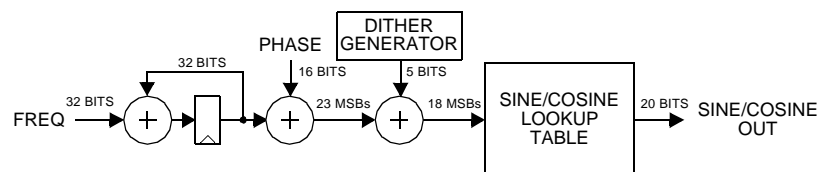


Figure 6. NCO Circuit

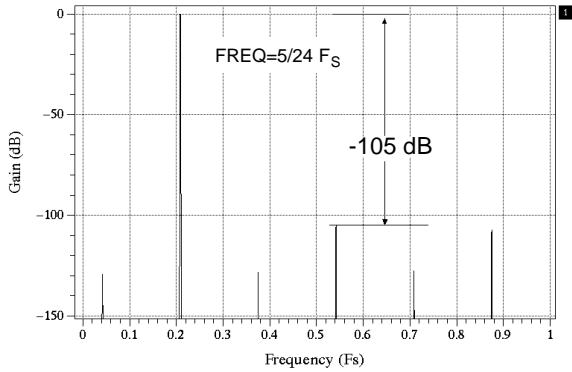
The tuning frequency is set to $FREQ$ according to the formula $FREQ = 2^{32}F/FC_{CK}$, where F is the desired tuning frequency and F_{CK} is the chip's clock rate. The 16 bit phase offset setting is $PHASE = 2^{16}P/2\pi$, where P is the desired phase in radians ranging between 0 and 2π .

Note that a positive tuning frequency should be used to downconvert the signal. A negative tuning frequency can be used to upconvert the negative (spectrally flipped) image of the desired signal. $FREQ$ and $PHASE$ are set in addresses 16 through 21 of each channel frequency pages.

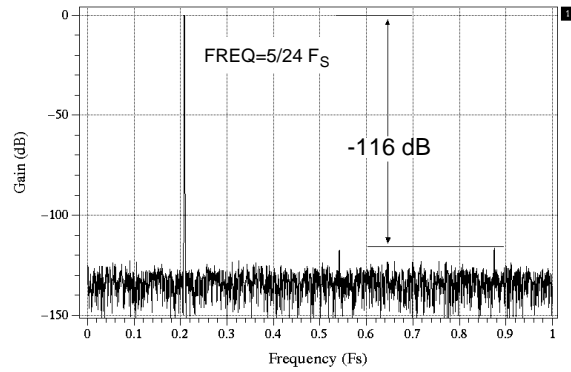
The NCO's frequency, phase and accumulator can be initialized and synchronized with other channels using the $FREQ_SYNC$, $PHASE_SYNC$, and NCO_SYNC controls in addresses 17 and 18 of the channel control pages. The $FREQ_SYNC$ and $PHASE_SYNC$ controls determine when new frequency and phase settings become active. Normally these are set to "always" so that they take effect immediately, but can be used to synchronize frequency hopping or beam forming systems. The NCO_SYNC control is usually set to never, but can be used to synchronize the LOs of multiple channels.

The NCO's spur level is reduced to below -113 dB through the use of phase dithering. The spectrums in Figure 7 show the NCO spurs for a worst case tuning frequency before and after dithering has been turned on. Notice that the spur level decreases from -105 dB to -116 dB. Dithering is turned on or off using the $DITHER_SYNC$ control in address 18.

The worst case NCO spurs at -113 to -116dB, such as the one shown in Figure 7(b), are due to a few frequencies that are related to the sampling frequency by multiples of $F_{CK}/96$ and $F_{CK}/124$. In these cases the rounding errors in

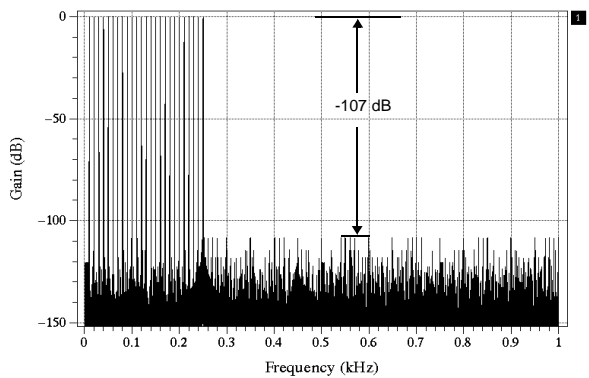


a) Worst case spectrum without dither

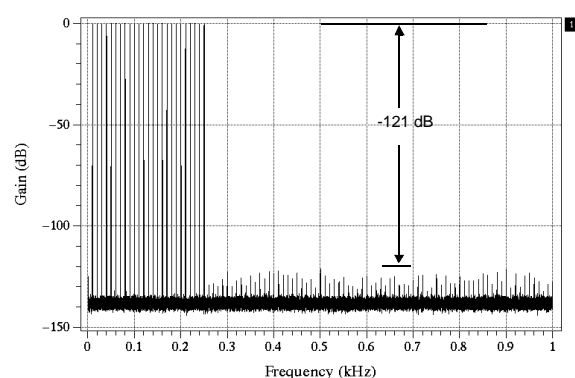


b) Spectrum with dither (tuned to same frequency)

Figure 7. Example NCO Spurs



a) Plot without dither or phase initialization



b) Plot with dither and phase initialization

Figure 8. NCO Peak Spur Plot

the sine/cosine lookup table repeat in a regular fashion, thereby concentrating the error power into a single frequency, rather than spreading it across the spectrum. These worst case spurs can be eliminated by selecting an initial phase that minimizes the errors or by changing the tuning frequency by a small amount (50 Hz). Setting the initial phase to 4 for multiples of $F_{CK}/96$ or $F_{CK}/124$ (and to 0 for other frequencies) will result in spurs below -115 for all frequencies.

Figure 8 shows the maximum spur levels as the tuning frequency is scanned over a portion of the frequency range with the peak hold function of the spectrum analyzer turned on. Notice that the peak spur level is -107 dB before dithering and is -121 dB after dithering has been turned on and the phase initialization described above has been used.

The output of the mixer may be rounded to 16 or 20 bits. Twenty bit rounding (MIX20B is set in address 23) is normally used with the 14 or 16 bit input modes. Sixteen bit rounding (MIX20B disabled) is normally used with the floating point, 12 bit input modes. Sixteen bit rounding is also required to

achieve a CIC gain of less than or equal to unity when the CIC decimation is greater than 3104. See Table 1.

3.3.3 Five Stage CIC Filter

The mixer outputs are decimated by a factor of N in a five stage CIC filter, where N is any integer between 8 and 4096 (between 4 and 2048 for SPLITIQ mode). The value of N is programmed independently for each channel in addresses 21 and 22 of each channel control page. The programmable decimation allows the chip's usable output bandwidth to range from less than 4 kHz to over 3 MHz when the input rate is 100 MHz. Wider output bandwidths are obtainable by using multiple channels (see Section 3.4). A block diagram of the CIC filter is shown in Figure 9.

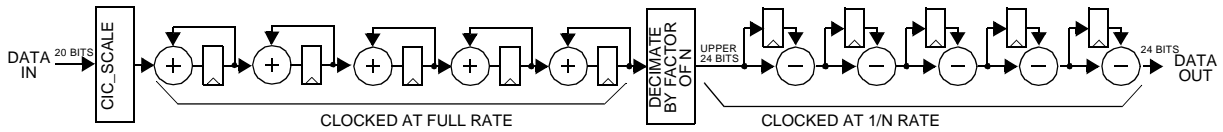


Figure 9. Five Stage CIC Decimate by N Filter

The CIC filter has a gain equal to N^5 which must be compensated for in the “CIC_SCALE” circuit shown in Figure 9. The CIC_SCALE circuit has a gain equal to $2^{(\text{SHIFT}+\text{SCALE}+6*\text{BIG_SCALE}-62)}$, where SCALE ranges from 0 to 5 and BIG_SCALE ranges from 0 to 7. The range of SHIFT is 4-7 if MIX20B is enabled and is 0-7 if MIX20B is disabled. The overall gain of the CIC circuit is equal to:

$$\text{CIC_GAIN} = N^5 2^{(\text{SHIFT} + \text{SCALE} + 6 \times \text{BIG_SCALE} - 62)}$$

The user must select values for SHIFT, SCALE and BIG_SCALE (addresses 16 and 23 of each channel control page) such that CIC_GAIN (including ZPAD_GAIN if blanking is used) is less than one, i.e., SHIFT, SCALE and BIG_SCALE must be selected such that:

$$(\text{SHIFT} + \text{SCALE} + 6 \times \text{BIG_SCALE}) \leq (62 - 5\log_2 N + \log_2(\text{NZERO}+1))$$

Overflows due to improper gain settings will go undetected if this relationship is violated. For example, if N is equal to 8 and SHIFT=4, then this restriction means that BIG_SCALE and SCALE should be less than or equal to 7 and 1 respectively. The SHIFT, BIG_SCALE and SCALE settings are independent for each channel. See Section 3.7 for a description of the channel's overall gain.

3.3.4 Coarse Channel Gain

The gain of each channel can be boosted up to 42 dB by shifting the output of the CIC filter up by 0 to 7 bits prior to rounding it to 20 bits. The coarse gain is:

$\text{COARSE_GAIN} = 2^{\text{COARSE}}$, where COARSE ranges from 0 to 7. COARSE is set in address 25 of each channel control page. Overflows in the coarse gain circuit are saturated to plus or minus full scale. The coarse gain is used to increase the gain of an individual signal after the input bandwidth of the downconverter has been reduced by a factor of N in the CIC filter. If the signal power across the input bandwidth is relatively flat, as is the case in most frequency division multiplexed (FDM) systems, then one would want to boost the signal power out of the CIC filter by a factor of $\text{COARSE_GAIN} = \sqrt{N}$. Each channel can be given its own coarse gain setting. See Section 3.7 for a description of the channel's overall gain.

3.3.5 The First Decimate By Two Filter (CFIR)

The CIC/Coarse gain outputs are filtered by two stages of filtering. The first stage is a 21 tap decimate by 2 filter with programmable 16 bit coefficients. Since this filter decimates by two, a stopband must be created in that portion of the spectrum that would alias into the signal of interest. This filter has very lax transition band specifications so 21 taps is sufficient to both provide the required anti-aliasing stopband, and to provide compensation for the droop in the CIC filter's passband. The CFIR is also used, in some cases, to provide additional stopband rejection for the second stage PFIR filter. Figure 10 illustrates the passband and stopband requirements of the filter. F_{CFIR} is the input sample rate to the CFIR filter. $F_{\text{CFIR}}/4$ is the output sample rate of the channel before resampling.

The user downloaded filter coefficients are 16 bit 2's complement numbers. Unity gain will be achieved through the filter if the sum of the 21 coefficients is equal to 65536. If the sum is not 65536, then CFIR will introduce a gain equal to: $\text{CFIR_GAIN} = \frac{\text{CFIR_SUM}}{65536}$, where CFIR_SUM is the sum of the 21 coefficients. Coefficient sets for a variety of standards in cellular and cable modem applications are given in Section 7. The output of CFIR is rounded to 20 bits (using the round-to-even algorithm). Overflows are detected and hard limited. Overflows can be directed to the channel overflow detection block.

The 21 coefficients are identified as coefficients h_0 through h_{20} , where h_{10} is the center tap. The coefficients are assumed to be symmetric, so only the first 11 coefficients (h_0 through h_{10}) are loaded into the chip. A non-symmetric mode (NO_SYM_CFIR in address 25) allows the user to download an 11 tap non-symmetric filter as taps h_0 through h_{10} . The newest sample is multiplied by h_0 and the oldest is multiplied by h_{10} . NOTE: Filters normally multiply h_0 by the oldest data, hence one may wish to reverse the tap order in the non-symmetric mode.

CFIR has a programmable delay of one CFIR input sample. This delay is used in a multichannel mode to alter

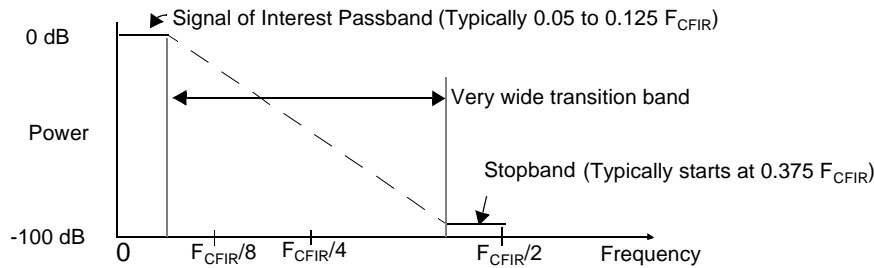


Figure 10. Typical CFIR Specifications

the decimate by two phasing in order to generate oversampled or wider bandwidth output data. This delay is independently programmable for each channel and is also independent for I and Q (QDLY_CFIR and IDLY_CFIR in address 25). A special mode (SPLITIQ in address 24) is also available where CFIR generates two I outputs rather than one I and one Q. See Section 3.4 for details.

3.3.6 The Second Decimate By 2 Filter (PFIR)

The second stage decimate by two filter is a 63 tap decimate by 2 filter with programmable 16 bit coefficients. Fine gain is applied at the output of the PFIR and rounded to 24 bits. Overflows are detected and hard limited. Overflows can be directed to the channel overflow detection block.

PFIR coefficient sets for a variety of standards in cellular and cable modem applications are given in Section 7. The PFIR filter passband must be flat in the region of the signal of interest, and have the desired out of band rejection in the region that will alias into the signal's bandwidth after decimation. Figure 11 below illustrates the passband and stopband requirements of the filter. F_{PFIR} is the input sample rate to the PFIR filter. $F_{PFIR}/2$ is the output sample rate of the channel before resampling.

The externally downloaded coefficients can be used to tailor the spectral response to the user's needs. For example, it can be programmed as a Nyquist (typically a root-raised-cosine) filter for matched filtering of digital data. The user downloaded filter coefficients are 16 bit 2's complement numbers. Unity gain will be achieved through

the filter if the sum of the 63 coefficients is equal to 65536. If the sum is not 65536, then PFIR will introduce a gain equal to: $PFIR_GAIN = \frac{PFIR_SUM}{65536}$, where PFIR_SUM is the sum of the 63 coefficients.

The 63 coefficients are identified as coefficients h_0 through h_{62} , where h_{31} is the center tap. The coefficients are assumed to be symmetric, so only the first 32 coefficients (h_0 through h_{31}) are loaded into the chip. A non-symmetric mode (NO_SYM_PFIR in address 26) allows the user to download a 32 tap non-symmetric filter as taps h_0 through h_{31} . The newest sample is multiplied by h_0 and the oldest is multiplied by h_{31} . NOTE: Filters normally multiply h_0 by the oldest data, hence one may wish to reverse the tap order in the non-symmetric mode.

The output samples can be multiplied by +/- 1 using a 4 bit control (NEG_CTL in register 24). If the LSB of NEG_CTL is a 1 the even time real words are multiplied by -1. The second LSB controls the even time imaginary words. The third controls the odd time real and the fourth the odd time imaginary. These can be used to invert the signal (NEG_CTL=0xF), frequency shift by $F_s/2$ (NEG_CTL=0x3), or flip the spectrum (NEG_CTL=0xA). It is also used in complex to real conversion (see the following section).

A fine gain is applied to the data after filtering and negation. The fine gain is a positive 14 bit integer (FINE) ranging from 0 to 16383. Fine gain is equal to: $FINE_GAIN = \frac{FINE}{1024}$. Setting FINE to zero will clear the channel. The GAIN_SYNC control in address 22 can be used

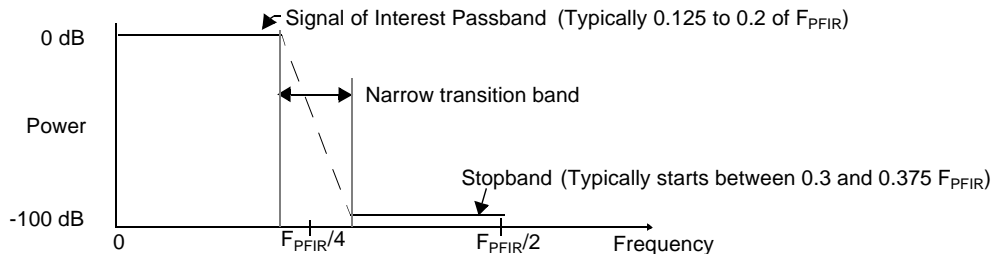


Figure 11. Typical PFIR Specifications

to determine when a new fine gain setting takes effect. It is normally set to take effect immediately, but can be used to synchronize the gain changes between multiple channels in a beam forming system.

PFIR also contains a one PFIR sample input delay that is independently programmable for the I and Q paths and for the four channels (QDLY_P FIR and IDLY_P FIR in address 26). The delay is used when combining channels to allow wider output bandwidth and/or more oversampling. It is also used for complex to real conversion in PFIR.

3.3.7 Complex to Real Mode

PFIR can be used to convert from the complex format to a real format for users desiring real output. This mode uses PFIR to low pass filter the signal so it resides from $-F_{PFIR}/4$ to $F_{PFIR}/4$, where F_{PFIR} is the sample rate into the PFIR (in this mode PFIR does not decimate by two so it is also the output sample rate). The signal is then mixed up by $F_{PFIR}/4$ (so it now resides from 0 to $F_{PFIR}/2$) and the imaginary portion is discarded. In implementation, the samples to be discarded are never generated. This is implemented by delaying the I data by 1 input sample (set IDLY_P FIR in address 26 of the channel's control page) and mixing the PFIR output with $F_{PFIR}/4$ (set NEG_CTL=6 in address 24 of the channel's control page). The QONLY flag in address 24 of the channel's control page also needs set (The Q-half, rather than the I-half is used due to hardware details). When outputting real data the sample rate out of the PFIR filter is $F_{CK}/(2N)$.

The REAL_ONLY bit in address 18 of the output control page can be set to tell the output section to output real samples. If this bit is not set, then the output will be in a complex format with the real samples in the Q-part of the complex word. The REAL_ONLY mode reduces the data rate out of the chip. Note that the REAL_ONLY bit effects all channels, so the chip does not support some channels outputting complex data while other channels output real data.

3.4 MULTICHANNEL MODES

The GC4016 chip contains four independent channels and each channel can output complex sample rates up to $F_{ck}/32^1$. Depending on the filter coefficients and the clock rate, the maximum single channel output bandwidth is just under 2MHz. This output bandwidth can be doubled by

1. The Resampler (Section 3.5) can be used to increase this rate for oversampling.

combining two channels using the SPLITIQ mode. Four channels may be combined to provide 3 to 4 times the single channel output bandwidth (with reduced out of band rejection). The two or four multichannel modes may also be used in the complex to real mode described in Section 3.4.6.

Two channels can also be combined to process complex input data, thereby doubling the input bandwidth going into the chip.² Four channels can be combined to both process complex input data and to double the output bandwidth of the chip.

Combined channels are assigned to a single resampler or output channel using the channel map controls (CHAN_MAP_A, B, C and D) in the resampler's control page.

Finally, for digital modulation formats, the resampler allows the downconverter's output sample rate to be between 1.5 and 2 samples per baud (symbol). The resampler will then up-sample this to exactly 2 or 4 samples per baud. This allows the GC4016 chip to downconvert one 4X oversampled signal at symbol rates up to 8 MBaud, or two 4X oversampled signals at 3MBaud, or four 4X oversampled signals at 1.5MBaud (assuming a 100MHz clock rate).

3.4.1 Double Bandwidth Downconverter Mode (SplitI/Q Mode)

Two channels work together in the SplitI/Q mode to double the output bandwidth of the downconverter. In the splitI/Q mode the real half of the complex output data is processed in one channel and the imaginary half in the other. In the splitIQ mode the CIC has a minimum decimation of 4 instead of 8, which allows channel output sample rates up to $F_{CK}/16$. The two channels being combined in the splitI/Q mode should be programmed identically, including the tuning frequency, except that the imaginary channel should have a +90 degree phase shift (PHASE=0x4000). The IONLY bit in the real channel should be set and the QONLY bit in the imaginary channel should be set. This mode is used in the example UMTS configuration described in Section 7.12.

Typically the chip is configured in the SPLITIQ mode so that channels A and B are combined as one downconverter and C and D are combined as the other. Mixed modes may be used, such as having A and B used as narrowband downconverters while C and D are combined into a double bandwidth downconverter. The resampler's CHAN_MAP_A,B,C and D controls must be set so that the combined channels point to the same resampler channel.

2. The GC2011A digital filter chip can be used to convert sample rates up to 200MSPS into complex sample rates up to 100 MSPS. One GC2011A chip will convert 12 bit data, two chips will convert 24 bit data.

Double rate real output can be generated by combining SPLITIQ and complex to real conversion. The complex to real signal processing is the same as described in Section 3.3.7. Here however, one channel contains the real portion of the signal and another contains the complex portion. To convert this complex data to real, the real channel must be delayed (set QDLY_P FIR=1), multiplied by a pattern 1,-1, 1, -1 (set NEG_CTL=5), and QONLY should be set. The imaginary channel should be multiplied by the sequence -1,1,-1,1 (set NEG_CTL=10) and QONLY should be set. The output is then available as the Q data in the selected resampler and output channel (see CHAN_MAP_A,B,C and D in the resampler's control page, also see REAL_ONLY).

3.4.2 Wideband Downconvert Mode

Even wider output bandwidth is possible by combining all four channels. This is done by noticing that PFIR decimates the signal by two. If one pair of channels in the SPLITIQ mode are used to generate even time sample outputs and the other pair are used to generate odd time sample outputs, then the PFIR filter effectively does not decimate the signal. This allows a wider bandwidth filter to be used in the CFIR and PFIR. Adjacent channel rejection, however, will be reduced due to the increase in the output bandwidth relative to the CIC's stopbands. Also the increase in output bandwidth makes it harder for the CFIR and PFIR to achieve deep stop bands. Fortunately, signals that require wideband processing are also typically signals that do not require as much stop band rejection as narrowband signals such as GSM.

The wide output mode uses the chip in the SPLITIQ mode described in Section 3.5.1. In addition the QDLY_P FIR bits are set in channels A and B. The delay of one input sample into the PFIR will offset the decimate by two operation so that the channel A and B outputs are the real and imaginary parts of the even time samples and the C and D outputs are the real and imaginary parts of the odd time samples. This mode is used in the example UMTS configuration described in Section 7.12.

Performing real to complex conversion in this mode involves setting the controls as above, but also setting QDLY_C FIR on channels A and C; setting NEG_CTL to 15 for channels B and C; setting QONLY=1 (and IONLY=0) for all channels.

3.4.3 Complex Input, Narrowband output

Complex input data can be processed using two channels. The real portion of the input (I_{IN}) is processed in

one channel while the imaginary portion (Q_{IN}) is processed in the next channel. Channels A and B are described here, channels C and D can be combined as well. The desired mixer output is $I_{OUT}=(I_{IN}*\cos-Q_{IN}*\sin)$ and $Q_{OUT}=(I_{IN}*\sin+Q_{IN}*\cos)$. Channel A is used in the normal mode and will output ($I_{IN}*\cos$) and ($I_{IN}*\sin$). A 90 degree offset (PHASE=0x4000) in channel B will cause channel B to output ($-Q_{IN}*\sin$) and ($Q_{IN}*\cos$). The desired result is achieved by adding the channel A outputs to the channel B outputs in the resampler. The resampler is told to add the channels together by setting the ADD_A_TO_B bit for channel A in the resampler's control page.

The complex to real mode described in Section 3.3.7 can be used in conjunction with the complex input mode. If both channels are configured as described in Section 3.3.7, then the combined complex input downconverter will be in the complex to real mode.

3.4.4 Complex Input, Double Bandwidth (SplitI/Q) Mode

The complex input and SPLITIQ modes can be combined. Channels A and D will process the I_{IN} inputs. Channels B and C will process the Q_{IN} input data. Channel A will output ($I_{IN}*\cos$). Channel B will output ($-Q_{IN}*\sin$) if its phase is set to 90 degrees (PHASE=0x4000). Channel C will output ($Q_{IN}*\cos$). Channel D will output ($I_{IN}*\sin$) if its phase is set to -90 degrees (PHASE=0xC000). The I_{OUT} output is formed by adding channel A to channel B, and the Q_{OUT} output is formed by adding channel C to channel D. The IONLY bits must be set for channels A and B, and the QONLY bits must be set for channels C and D.

The complex to real mode can be added to this mode by delaying the I word by half (set QDLY_P FIR in channels A and B) and mixing by $F_s/4$ (set NEG_CTL to 5 in channels A & B and set NEG_CTL to 10 in channels C & D). QONLY instead of IONLY needs to be set in channels A and B.

3.4.5 Multichannel Summary

Table 2 summarizes the settings for the eight multichannel modes. A phase setting of 90 indicates a +90 degree phase offset, or a value of 0x4000. A phase setting of -90 indicates a -90 degree phase offset, or a value of 0xC000.

Table 2: Multichannel mode settings

Input	Real																Complex																			
Output Rate	Two 2X output channels								Single 4x output channel								1x								2x											
Output Format	Complex				Real				Complex				Real				Complex				Real				Complex				Real							
Channel	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D	A	B	C	D
SPLITIQ	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
PHASE	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	90	0	-90	0	90	0	-90	0	90	0	-90
QDLY_CFIR	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
IDLY_PFIR	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
QDLY_PFIR	0	0	0	0	1	0	1	0	1	1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	1	1	0	0
NEG_CTL	0	0	0	0	5	10	5	10	0	0	0	0	0	15	15	0	0	0	0	0	6	6	6	6	0	0	0	0	5	5	10	10	0	0	0	0
IONLY	1	0	1	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0	0	0
QONLY	0	1	0	1	1	1	1	1	0	1	0	1	1	1	1	1	0	0	0	0	1	1	1	1	0	0	1	1	1	1	1	1	0	0	0	0
ADD_TO	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	1	0	1	0	1	0	1	0	1	0	1	0	1	0	1	0
CHAN_MAP	0	0	1	1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	1	1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0

3.5 RESAMPLER

The resampler will independently filter and change the data rate of each channel. The most common application of the resampler is to increase the sample rate of the data so that it will match a desired symbol or bit rate. Demodulators for digital modulation schemes, such as GMSK, QPSK, QAM or CDMA, for example, require sample rates which are 1X, 2X, 4X or 8X times the bit or symbol rate of the modulation. In these cases, the maximum down converter filter performance is achieved when the PFIR output rate is around 1.5 to 2 times the signal's bandwidth¹. The resampler is then used to increase the sample rate up to the required 2X, 4X or 8X rate.

Section 7.7 shows example resampler configurations and their performance.

The resampler can also be used as an additional filter to optimize the passband or stopband response of the channel.

1. The PFIR's 63 tap filter's stopband, transition band and passband ripple performance improves as its output rate decreases relative to the signal's bandwidth. The resampler's performance, however, begins to decrease when the PFIR output rate is below 1.5 times the signal's bandwidth.

3.5.1 Functional Description

The resampler consists of an input buffer, an interpolation filter, and a final shift block. A functional block diagram of the resampler is shown in Figure 12.

The resampler's sampling rate change is the ratio NDELAY/NDEC where NDELAY and NDEC are the interpolation and decimation factors shown in Figure 12. The decimation amount NDEC is a mixed integer/fractional number. When NDEC is an integer, then the exact sampling instance is computed and there is no phase jitter. If NDEC is fractional, then the desired sampling instance will not be one of the possible NDELAY interpolated values. Instead the nearest interpolated sample is used. This introduces a timing error (jitter) of no more than 1/(2*NDELAY) times the input sample period.

The input buffer accepts 24 bit data from the four input channels, and adds them as necessary to form 1,2, or 4 resampler channels (see the ADD_TO control bits in address 21 of the resampler control page). The input buffer serves both as a FIFO between the channels and the resampler, and as a data delay line for the interpolation filter. The 64 complex word input buffer can be configured as four segments of 16 complex words each to support 4 resampler

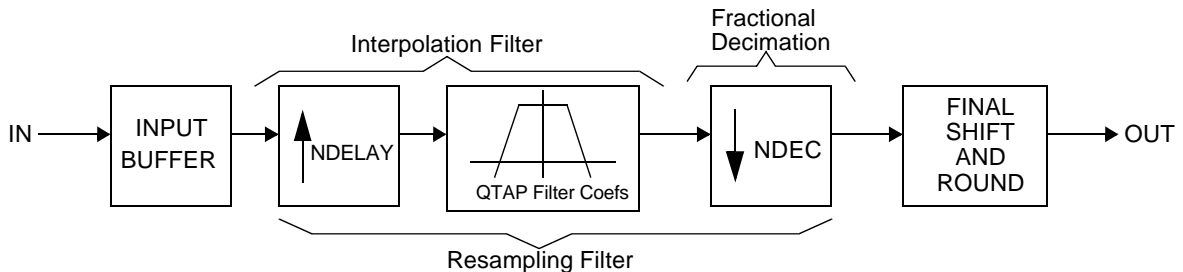


Figure 12. Resampler Channel Block Diagram

channels, or as two segments of 32 complex words each to support 2 resampler channels, or as a single segment of 64 complex words to support a single resampler channel. The number of segments is set by NCHAN in address 16 of the resampler control page.

The interpolation filter zero pads the input data by a factor of NDELAY and then filters the zero padded data using a QTAP length filter. The output of the QTAP filter is then decimated by a factor of NDEC.

The resampling ratio for each channel is determined by setting the 32 bit RATIO controls in addresses 16 through 31 of the resampler ratio page. The value of RATIO is defined as:

$$\text{RATIO} = 2^{26} \left(\frac{\text{NDEC}}{\text{NDELAY}} \right) = 2^{26} \left(\frac{\text{INPUT SAMPLE RATE}}{\text{OUTPUT SAMPLE RATE}} \right)$$

Up to four ratios can be stored within the chip. A ratio map register (address 23) selects which ratio is used by each channel.

The three spectral plots shown in Figure 13 illustrate the steps required to resample the channel data. The first spectral plot shows the data just after zero padding. The sample rate after zero padding is $\text{NDELAY} \cdot F_S$, where F_S is the sample rate into the resampler. The second spectrum shows the shape of the QTAP filter which must be applied to

the zero padded data in order to suppress the interpolation images. The last spectrum shows the final result after decimating by NDEC.

3.5.2 The Resampler Filter

Figure 13(b) illustrates the spectral shape requirements of the QTAP filter. If the desired signal bandwidth is B, then the filter's passband must be flat out to $B/2$ and the filter's stop band must start before $F_S - B/2$. The user designs this filter assuming a sample rate equal to $\text{NDELAY} \cdot F_S$. Section 7.7 contains example resampler filters coefficient sets. Other passband and stopband responses can be used, such as root raised cosine receive filters, as desired. The resampler filter can also be used to augment the CIC, CFIR and PFIR filters' spectral response.

The number of filter coefficients, QTAP, is equal to $\text{NMULT} \cdot \text{NDELAY}$, where NMULT is the number of multiplies available to compute each resampler output, and NDELAY is either 4, 8, 16, 32 or 64 as will be described later. The maximum filter length is 512. The user specifies NMULT in address 17 of the resampler control page.

The filter can be symmetric, or non-symmetric, as selected by the NO_SYM_RES control in address 17 of the resampler control page. The symmetric filter is of even length which means the center tap repeats.

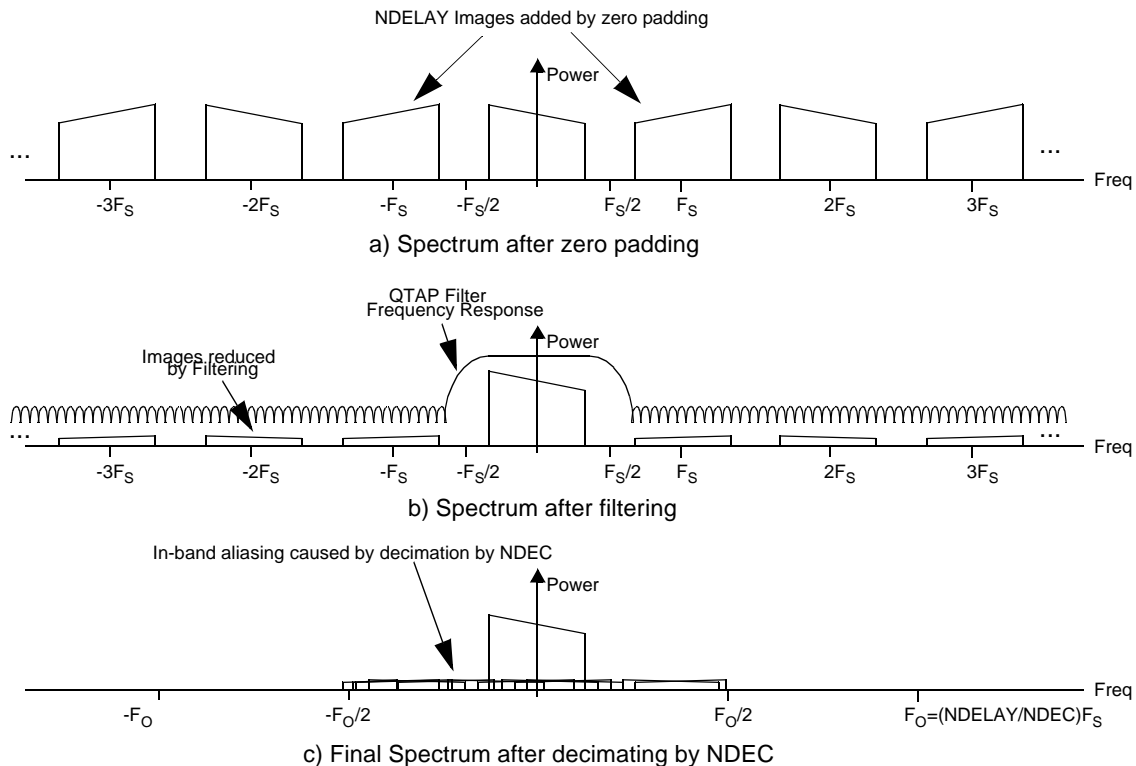


Figure 13. The Resampler's Spectral Response

The 12 bit filter coefficients are stored in a 256 word memory which can be divided into one, two, or four equal blocks. This allows the user to store one symmetric filter of up to 512 taps, two symmetric filters of up to 256 taps each, or four symmetric filters of up to 128 taps each. The number of filters is set by NFILTER in address 16 of the resampler control page. The filter used by each channel is selected using the FILTER_SEL controls in address 18 of the resampler control page. The filter lengths are cut in half if the filters are not symmetric. The coefficients are stored in memory with h_0 stored in the lowest address, where h_0 is the coefficient multiplied by the newest piece of data. The center tap of a symmetric filter is $h_{(QTAP/2)-1}$. The coefficients for multiple filters (NFILTER>1), are interleaved in the 256 word memory.

3.5.3 Restrictions on NMULT

The user does not directly set the value of NDELAY. The chip sets the value of NDELAY using NO_SYM_RES, NMULT and NFILTER according to:

$$NDELAY = \text{Floor}_2 \left[256 \frac{(2 - \text{NO_SYM_RES})}{(\text{NMULT})(\text{NFILTER})} \right]$$

where the function FLOOR_2[X] means the power of two value that is equal to or less than "X". Since NMULT is restricted to be greater than or equal to 6 and less than or equal to 64, then NDELAY is either 4, 8, 16, 32 or 64. The length of the filter is then:

$$QTAP = (\text{NDELAY})(\text{NMULT})$$

The value of NMULT determines both the length of the filter and the number of delays in the resampling operation. In general one would choose the largest value of NMULT which gives an adequately large value of NDELAY. The choice of NMULT, however, must meet several restrictions. NMULT must be greater than a minimum, it cannot exceed the available number of multiplier cycles, and it must be less than the input delay line segment size. These restrictions are described below.

The minimum value of NMULT is determined by the minimum number of clock cycles required to update the resampler's state. This is a hardware restriction imposed by the chip's architecture. This limitation is:

$$\begin{aligned} \text{NMULT} &\geq 6 && \text{if there are two or more outputs} \\ \text{NMULT} &\geq 7 && \text{if there is only one output} \end{aligned}$$

NMULT is the number of complex multiplier operations required to compute an output sample. Since the resampler can perform two multiplies every clock cycle, the value of NMULT cannot exceed two times the number of clock cycles

available to the resampler for each channel. The number of clock cycles available to the resampler is equal to the clock rate to the chip divided by the sum of the output sample rates for each resampler channel. Hence, NMULT must satisfy:

$$\text{NMULT} \leq 2 \times \frac{F_{\text{CK}}}{\sum (\text{OUTPUT RATES})}$$

Note that the resampler's output sample rate is usually much less than the clock rate, so that NMULT is rarely limited by this restriction. NOTE: THE NUMBER OF CLOCK CYCLES AVAILABLE TO THE RESAMPLER IS REDUCED BY THE CLOCK DIVIDER DISCUSSED IN THE NEXT SECTION.

The value of NMULT must also be less than the size of the delay line formed by the input buffer. The size of the delay line is either 16 for four resampler channels, 32 for two channels or 64 for a single channel as set by the NCHAN control in address 16 of the resampler control page. This limits NMULT to be less than or equal to 15, 31 or 63 dependent upon the number of resampler channels¹.

The typical resampler configuration will have four active channels, all using the same filter and the same resampling ratios. The typical configuration has NCHAN set to 4, NFILTER set to 1, NMULT set to 15 and NO_SYM_RES set to 0. This sets NDELAY to 32 and QTAPS to 480. See Section 7.7.

3.5.4 The Resampler Clock Divider

The resampler has a clock divider that can be used to reduce power consumption and to slow the calculation rate of the resampler. The clock divider divides the internal clock by factors of one to 256 using the RES_CLK_DIV control in address 22 of the resampler control page. The clock divider reduces the resampler's computational throughput, so care must be taken not to reduce the clock rate to the point that the computations can not be completed on time.

3.5.5 Final Shift and Round

The gain of each resampler output is adjusted by an up-shift by 0-15 bits (FINAL_SHIFT). This up-shift is applied just before rounding to the 12, 16, 20 or 24 MSBs (ROUND). The values of FINAL_SHIFT and ROUND are set in control register 19 of the resampler control page. The resampler

1. NOTE: If the resampler is being used at much less than its maximum capacity, i.e., NMULT is much less than twice the number of clock cycles available (See also RES_CLK_DIV), AND the channels are synchronous, then NMULT may equal the size of the delay line.

gain is:

$$\text{RES_GAIN} = \left(\frac{\text{RES_SUM}}{32768 \times \text{NDELAY}} \right) (2^{\text{FINAL_SHIFT}})$$

where RES_SUM is the sum of the QTAP coefficients.

3.5.6 By-Passing the Resampler

The resampler is bypassed by using a configuration which has h_0 set to 1024, all other taps set to zero, NMULT set to 7, NO_SYM_RES set to 1, FINAL_SHIFT set to 5, and RATIO set to 2^{26} (0x04000000). Note that the NDELAY term in the RES_GAIN equation shown above does not apply in this case and should be set to unity in the gain equation.

3.5.7 Adaptive Ratio Change

The ratio maps (address 23) can be used to dynamically adjust each channel's resampling ratio. Four different ratios can be loaded into the chip. The ratio map indicates which ratio is to be used by which channel. This feature can be used to lock the resampling to a desired output timing by adaptively selecting ratios which are slightly larger or smaller or equal to the desired ratio. If the timing needs to be accelerated, then the larger ratio is selected, if the timing is correct, then the exact ratio is used and if the timing needs to be retarded, then a smaller ratio is used. The ratio change can be synchronized using the RATIO_SYNC control in address 21.

3.6 OVERALL GAIN

The overall gain of the chip is a function of the amount of blanking (NZEROS), the decimation programmed into the chip (N), the scale circuit setting in the CIC filter (SHIFT, SCALE and BIG_SCALE), the coarse gain setting (COARSE), the sum of the CFIR coefficients (CFIR_SUM), the sum of the PFIR coefficients (PFIR_SUM), the fine gain (FINE_GAIN), the sum of the resampler coefficients (RES_SUM), the number of delays in the resampler filter (NDELAY) and the final shift (FINAL_SHIFT). The overall gain is shown below. The term in braces should be less than or equal to unity. Note that the NDELAY term is unity if the resampler is bypassed (see Section 3.5.6).

Unity gain is defined relative to the MSB of the I/O data. Unity gain means that a maximum DC input with a tuning frequency of zero, will produce a maximum DC output, independent of the I/O words sizes.

$$\text{GAIN} = \left\{ \left(\frac{1}{\text{NZEROS} + 1} \right) N^5 2^{(\text{SHIFT} + \text{SCALE} + 6 \times \text{BIG_SCALE} - 62)} \right\} (2^{\text{COARSE}}) \left(\frac{\text{CFIR_SUM}}{65536} \right) \left(\frac{\text{PFIR_SUM}}{65536} \right) \left(\frac{\text{FINE_GAIN}}{1024} \right) \left(\frac{\text{RES_SUM}}{32768 \times \text{NDELAY}} \right) (2^{\text{FINAL_SHIFT}})$$

3.7 PEAK COUNTER

Each channel has a peak counter which can monitor the input signal's strength, or can count the number of overflows detected at three points within the channel. The peak counter can count overflows due to the COARSE_GAIN circuit, it can count overflows at the output from the CFIR, and it can count overflows at the output of the PFIR.

If PEAK_MODE is set to 0 in address 28 of the channel control page, then the peak counter will monitor the signal strength at the input to the channel. The magnitude of each input sample is compared against a threshold selected by the PEAK_THRESH control in the same address. The threshold can be 1/4, 1/2 3/4 or full scale. The peak counter increments each time the magnitude equals or exceeds the threshold. The input threshold crossings can be used in an AGC loop to optimize the input signal level to the ADC.

If PEAK_MODE is 1, then the peak counter monitors overflows at points selected by the PEAK_SELECT control in address 26 of the channel control page. The peak counter increments each time an overflow is detected. Note that the data value is saturated to plus or minus full scale, as appropriate, when the overflow occurs. The overflow count can be used to check if the signal gain is set too high anywhere along the processing chain.

The counter counts up to 255 and stops. The counter value is saved in a holding register and the counter is cleared by the sync selected by the PEAK_SYNC signal (see register 28). The sync can either be one of the chip's input syncs, a one-shot pulse, or the terminal count of the chip's sync counter. A periodic sync allows the user to count threshold crossings or overflows during fixed time periods.

The user reads the count through the PEAK_COUNT control register at address 29 of the channel control page. The holding register contents are transferred to the PEAK_COUNT register a clock cycle after the user reads the PEAK_COUNT register. This transfer is delayed to prevent the user from reading a peak count value at the same time the circuit is updating the register.

Note that there are two other points in the chip where overflows can occur. The first is at the input to the resampler where samples from two channels can be added together as when processing complex input data. This may cause an overflow even though the samples feeding the resampler did not overflow. If an overflow occurs here, the sample is saturated and a control bit in the status register (address 1)

is set. The user can clear this bit by writing a 0 to the register. The control bit indicates that at least one sample overflowed since the last time the bit was cleared. Since the datapath going into the resampler is 24 bits, it is recommended that the gain be set such that this overflow never occurs. The second overflow point is at the resampler output. The user can check for these overflows by examining the chip's output data for maximum (saturated) values.

3.8 OUTPUT MODES

Data from the resampler can be output in one of several modes:

- (1) The microprocessor mode where the outputs are read from the 8 bit control port,
- (2) The wide word microprocessor mode where the outputs are read as 32 bit integers from a wide word control port,
- (3) The synchronous serial mode where the outputs are output through one or more of the four serial ports,
- (4) The asynchronous serial mode where the channels are output on the same serial stream, but have their own serial frame sync,
- (5) The nibble mode where the outputs are output in a 4-bit at a time nibble serial format,
- (6) The link mode which is compatible with the four bit SHARC link port, or
- (7) The parallel mode which outputs the data as 24 bit words.

Only one mode is supported at a time. The output modes are controlled by writing to addresses 16 through 26 within page 98 (the output control page).

A FIFO memory holds blocks of resampler output data, where each block contains one, two or four complex samples as specified by the BLOCK_SIZE control in address 20. The FIFO is used to buffer the data rate between the resampler and the output. The number of blocks held in the FIFO depends upon the output mode being used.

The data from the resampler can be rounded to 12,16, 20 or 24 bits. The BITS_PER_WORD control in address 20 will set the serial mode word size to be between 12 and 32 bits, or to set nibble and link mode words to be either 16 or 32 bits. If the output word size is larger than the resampler's output size, then the unused LSBs are cleared.

Tag bits (four bits per tag) may be programmed to replace the four LSBs of the specified output word size. The tags are used to identify the source of the data. The user can program eight different tag values in addresses 23, 24, 25

and 26, two for each of the four complex output words. Tags are enabled using the TAG_EN control bit in address 17. A special 2 bit tag mode control (TAG_22 in address 19 of the resampler control page) can be used to output 24 bit words containing 22 bits of data and 2 bits of tag.

The chip supports different decimation ratios and/or different resampling ratios for each channel. If different ratios are used, or if the channels have not been synchronized using the DEC_SYNC controls (See Section 3.11), then the channels are *asynchronous* and tag bits are required in order to sort out the channel data. If the same ratios are used, and the channels have been synchronized, then the output is *synchronous* and the tag bits are not required.

If the complex to real conversion modes of the PFIR described in Section 3.3.7 are used, then the REAL_ONLY control bit in address 18 can be used to output real rather than complex data. The REAL_ONLY control can only be used if all of the channels are in the complex to real mode, a mix of complex and real data is not allowed. If the complex output format is used to output real data (REAL_ONLY=0), then the real outputs are output as the Q-half of the complex output words. The I-half should be ignored.

The suggested control register settings for each of the output modes are shown in Table 3. These settings assume all four channels are active and the outputs are *synchronous*.

The output circuitry is reset upon power up. It is enabled by clearing the OUT_BLK_RESET and PAD_RESET bits in address 0. See Section 3.12 for the proper initialization procedures.

An output block sync is provided (OUT_BLK_SYNC in address 17) which can be used to synchronize the serial clocks of multiple chips. See Section 3.12 for the proper synchronization sequences.

3.8.1 Microprocessor Mode

In the microprocessor mode (OUTPUT_MODE=0 in address 18) the outputs are read in bytes from the control port. The outputs are accessed by reading addresses 16 through 31 in pages 96 and 97.

The output FIFO buffers two blocks of complex samples in this mode. One block is accessed through the microprocessor port as another block is being filled with new data. When the new block is filled, the FIFO swaps the blocks so that the user can access the new data. The block size is usually set to buffer four complex samples per block (BLOCK_SIZE=3). If only one or two channels are being output, then the block size may be reduced, but it is suggested to keep it at four samples per block in order to

Table 3: Output Mode Controls

Control Register	Address (Page 98)	Suggested Default for Each Mode (hex values)							
		Micro-processor mode	Wide Word micro-processor mode	Serial modes			Nibble mode	Link mode	Parallel mode
				Four serial outputs	TDM output (synchronous)	Asynchronous Mode			
Tristate Controls	16	02	FA	7F	7F ¹	7F ¹	7F ¹	7D	FF
Output Formats	17	40	40	40	40	40	40	48	40
Output Modes	18	08	08	28	28 ²	28 ²	4A	CB	6C
Output Frame Controls	19	00	00	01	07 ³	01	07	00	00
Output Word Sizes	20	E8	E8	E9	EF	29	C8	08	E8 ⁵
Output Clocks	21	00	00	B1	01	01	01	01	01
Serial Mux Controls	22	00	00	E4	E4	E4	00	00	00
Output Tag A	23	10			00		10		
Output Tag B	24	32			11		32		
Output Tag C	25	45			22		45		
Output Tag D	26	67			33		67		
Miscellaneous	28	02			03 ⁴		02		

NOTES: 1. For TDM serial or nibble modes the master chip's value should be 7F, the slaves' 7D.
2. For TDM serial or nibble modes the master chip's value should be 28, the slaves' 20.
3. For multi-chip modes the frame length is set as described in Section 3.8.3.
4. Also set the RND22control bit in address 19 (bit 6) of the resampler control page (page 64).
5. For Asynchronous parallel modes set address 20 to 28.

reduce the interrupt rate and to let the user read more samples after each interrupt.

When the user has finished reading the block of data he sets the READY control bit in the Status Register (address1). When the output FIFO has a new block of data ready, it will clear the READY bit. If a block of data completes and the READY bit is not set, then the chip sets the MISSED control bit. The MISSED bit serves as a diagnostic indicating that the processor was too slow and missed a block of data. Note that the rate at which the blocks are filled, and therefore the rate at which the data needs to be read from the microprocessor port, is dependent upon how fast the resampler can generate new output samples. When the resampler is interpolating, which is the resampler's most commonly used mode, it will generate multiple output samples each time it receives a sample from a downconverter channel. The user should use the resampler's clock divider to slow its computation rate if the resampler is generating outputs too fast (See Section 3.5.4).

The RDY pin can serve as an interrupt to inform the processor that a new block of samples is ready. The width and polarity of the RDY pulse is programmable (See EN_RDY in address16 and INV_RDY and RDY_WIDTH in address 17).

The mapping of the output data into registers 16 through 31 is dependent upon the OUTPUT_ORDER control mode in address 21, the number of active channels, and whether the channels are *synchronous* or *asynchronous*.

If OUTPUT_ORDER=0 and BLOCK_SIZE=3, then each block will contain the next four samples output from the

resampler. If the channels are *synchronous*, then the block will contain one sample from each channel. If there are only two active channels, then the block will contain two samples from each channel. If there is only one active output channel, then the block will contain four consecutive samples from the active channel. If the channels are *asynchronous*, or if there are three active channels, then the output block will contain the next four samples computed by the resampler. In this case tags are required to separate the channels. OUTPUT_ORDER=0 must be used for *asynchronous* data.

If OUTPUT_ORDER=1 or 2, then the channels are written into the FIFO using the channel number as part of the address. In this mode the previous block is complete when the Q-half of the output from channel A arrives. If the resampler ratio is the same integral value for all channels, then channels B, C and D can be powered down and back up again while maintaining proper channel ordering. Channel A may not be powered down because it provides the "Block Complete" timing signal. OUTPUT_ORDER settings of 1 and 2 are valid for *synchronous* channels, but NOT for *asynchronous* channels.

The following tables illustrate how the 24 bit channel outputs are mapped into addresses 16 through 31 of pages 96 and 97. Note that addresses 16, 20, 24 and 28 are the unused LSBs of the 32 bit words and always read back zero. Addresses 19, 23, 27 and 31 contain the MSBs of the output. In the 12,16, or 20 bit output mode, all values are rounded into the MSBs and the unused LSBs are cleared. These tables assume that BLOCK_SIZE = 3 which sets the block size to four complex words.

Table 4: Channel Output Map, Synchronous Four Channel Mode

CHANNEL OUTPUT PAGE 96

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	A _{OUT} , I-half	A _{OUT} , I-half	A _{OUT} , I-half
20,21,22,23	A _{OUT} , Q-half	B _{OUT} , I-half	B _{OUT} , I-half
24,25,26,27	B _{OUT} , I-half	A _{OUT} , Q-half	C _{OUT} , I-half
28,29,30,31	B _{OUT} , Q-half	B _{OUT} , Q-half	D _{OUT} , I-half

CHANNEL OUTPUT PAGE 97

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	C _{OUT} , I-half	C _{OUT} , I-half	A _{OUT} , Q-half
20,21,22,23	C _{OUT} , Q-half	D _{OUT} , I-half	B _{OUT} , Q-half
24,25,26,27	D _{OUT} , I-half	C _{OUT} , Q-half	C _{OUT} , Q-half
28,29,30,31	D _{OUT} , Q-half	D _{OUT} , Q-half	D _{OUT} , Q-half

Table 5: Channel Output Map, Synchronous Two Channel Mode

CHANNEL OUTPUT PAGE 96

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	A(i) _{OUT} , I-half	A _{OUT} , I-half	A _{OUT} , I-half
20,21,22,23	A(i) _{OUT} , Q-half	B _{OUT} , I-half	B _{OUT} , I-half
24,25,26,27	B(i) _{OUT} , I-half	A _{OUT} , Q-half	unused
28,29,30,31	B(i) _{OUT} , Q-half	B _{OUT} , Q-half	

CHANNEL OUTPUT PAGE 97

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	A(i+1) _{OUT} , I-half	unused	A _{OUT} , Q-half
20,21,22,23	A(i+1) _{OUT} , Q-half		B _{OUT} , Q-half
24,25,26,27	B(i+1) _{OUT} , I-half		unused
28,29,30,31	B(i+1) _{OUT} , Q-half		

Table 6: Channel Output Map, Single Channel Mode

CHANNEL OUTPUT PAGE 96

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	A(i) _{OUT} , I-half	A _{OUT} , I-half	A _{OUT} , I-half
20,21,22,23	A(i) _{OUT} , Q-half	unused	unused
24,25,26,27	A(i+1) _{OUT} , I-half	A _{OUT} , Q-half	
28,29,30,31	A(i+1) _{OUT} , Q-half	unused	

CHANNEL OUTPUT PAGE 97

ADDRESSES	OUTPUT_ORDER=0	OUTPUT_ORDER=1	OUTPUT_ORDER=2
16,17,18,19	A(i+2) _{OUT} , I-half	unused	A _{OUT} , Q-half
20,21,22,23	A(i+2) _{OUT} , Q-half		unused
24,25,26,27	A(i+3) _{OUT} , I-half		
28,29,30,31	A(i+3) _{OUT} , Q-half		

In the complex to real conversion modes (see Section 3.3.7), the real output is available in the Q portion of the registers and the I portion is invalid. The REAL_ONLY control has no effect upon the microprocessor mode.

Tables 4, 5 and 6 assume the block size control (BLOCK_SIZE in address 20) is set to four samples. If the block size is two and OUTPUT_ORDER is 0, then page 97 is unused. If the block size is one and OUTPUT_ORDER is 0, then only addresses 16 through 23 of page 96 are used.

3.8.2 Wide Word Microprocessor Mode

The wide word microprocessor mode is selected by setting OUTPUT_MODE=0 and by enabling the parallel output port (EN_P0=EN_P1=EN_P2=EN_P3=EN_PAR=1 in address 16). The wide word microprocessor mode allows the user to read 32 bit words, rather than bytes. The 8 bit microprocessor port is augmented with the 24 bit parallel port to provide the 32 bit interface. The bit mapping into the 32 bit port is shown below.

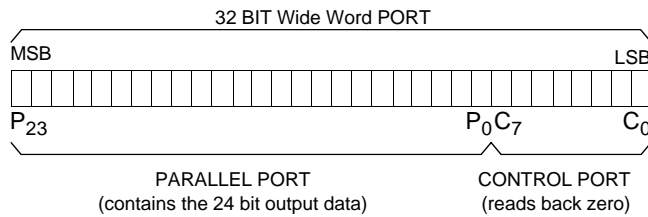


Figure 14. Wide Word Microprocessor Port

The channel outputs are read using addresses 16, 20, 24, and 28 of pages 96 and 97. The channel ordering is the same as described in Section 3.8.1 above and shown in Tables 4, 5 and 6.

The upper 24 bits of the wide word microprocessor port are read only bits. The port and has the same control and timing characteristics as shown in Figures 2 and 3 for the normal microprocessor port.

3.8.3 Synchronous Serial Outputs

The serial mode is selected by setting OUTPUT_MODE=1, MASTER=1 and enabling the serial output pins (EN_SCK=EN_SFS=EN_P0,1,2,3=1 in address 16). The chip provides a bit serial clock (SCK), a frame strobe (SFS) and four data bit lines (SOUT A,B,C and D) to output the data in a serial format. The I and Q parts of complex outputs are always multiplexed onto the same bit-serial pin. The I-part is output first, MSB to LSB, followed by the Q-part. In the real mode (REAL_ONLY=1), only the Q word per

channel is output. The REAL_ONLY mode is used with the complex to real conversion mode of the PFIR.

The serial clock is the input clock (CK) divided by 1-16 (SCK_RATE control in address 21). For even divisions, the serial clock changes on the rising edge of CK. The serial clock has a 50% duty cycle for all divisions. The polarity of the serial clock is programmable (which allows output data to be sampled on the rising or falling edge of SCK).

The serial output word size is programmable to be 12,16,20,24,28, or 32 bits per word (BITS_PER_WORD control in address 20). Note that the maximum word size out of the resampler is 24 bits so for output word sizes of 28 or 32 bits the lower bits are always zero. For complex data outputs, pairs of words, each being 12 to 32 bits, are output.

Synchronous channel outputs can be transmitted as one channel per serial output on four separate bit-serial output pins (SOUTA, SOUTB, SOUTC, and SOUTD), or multiplexed as two channels per pin onto two output pins (SOUTA and SOUTB), or multiplexed as all four channels on the same pin (SOUTA) as specified by the OUTPUT_ORDER and NSERIAL control bits in address 21. The four channel, each on their own serial pin, mode uses NSERIAL=3 and OUTPUT_ORDER=2. The two channels per pin mode uses NSERIAL=1 and OUTPUT_ORDER=1. The four channels on a single pin mode uses NSERIAL=0 and OUTPUT_ORDER=0.

The serial streams SOUTA, SOUTB, SOUTC and SOUTD are normally output on pins P0, P1, P2 and P3, respectfully. If required, the SMUX_0, SMUX_1, SMUX_2 and SMUX_3 controls in address 22 can be used to select which stream is output on which of these pins.

For *synchronous* channels the FIFO block size (BLOCK_SIZE) should be set to match the number of active channels. If four channels are active, then BLOCK_SIZE should be set to 3. If two channels are active, then BLOCK_SIZE should be set to 1. If only one channel is active, then BLOCK_SIZE should be set to 0.

The outputs are output in frames. Output frames start when the previous frame has completed AND a new data block is ready in the FIFO (See BLOCK_SIZE above). The minimum output frame length can be programmed to be 1 to 64 words (up to 32 complex samples) using the FRAME_LENGTH control in address 19. Longer frame sizes can be used to time division multiplex (TDM) channels from multiple chips onto a signal serial bus or to smooth data flow when resampling.

The number of words output on each serial pin during a frame can be programmed to be 1 to 8 words (1 to 4 complex

samples) using the WORDS_PER_FRAME control in address 20. The WORDS_PER_FRAME control is usually set to match the number of active output channels multiplexed onto each serial pin using the NSERIAL control. In real output modes each sample is one word. In complex output modes each sample is two words. NOTE: FRAME_LENGTH must be greater than or equal to WORDS_PER_FRAME.

If the selected number of words have been output, and the frame is not complete, or a new FIFO block is not ready, then the frame strobe (SFS) will remain inactive, the data bits will go tristate, and the serial clock (SCK) will continue. In this case a new frame will start on the next SCK pulse after the frame completes and a new FIFO block is ready. If new outputs are ready before the previous frame is finished, then the FIFO will buffer the new data until the previous frame is complete. THE FRAME LENGTH AND SERIAL CLOCK RATES MUST BE SET SO THAT THE FRAME RATE IS GREATER THAN OR EQUAL TO THE AVERAGE RESAMPLER OUTPUT RATE. This means that:

$$\frac{\text{(Average \# of clocks per resampler output)}}{\text{(Frame length)(bits per word)(clocks per bit)}} \geq 1$$

where the average # of clocks per resampler output is equal to:

$$\frac{\text{(Average \# of clocks per resampler output)}}{\text{(Channel decimation)(NDEC/NDELAY)}}$$

and NDEC/NDELAY is the resampling ratio (see Section 3.5.1).

The frame strobe signal (SFS) is programmable to come once per frame, once per complex word, or once per word using the SFS_MODE control in address 19. SFS is one SCK clock cycle wide and always comes one SCK ahead of the first output bit in the transfer. Its polarity is programmable (INV_SFS in address 17). If the outputs are *synchronous* and the frame strobe signal is once per frame, then a word's position in the frame relative to the SFS strobe can be used to identify which channel each sample belongs to. If not, tags may be used to identify channels. Some processors require an SFS strobe with each word so the position within a frame relative to the SFS strobe cannot be used to identify channels. Tag bits must be used for these processors, but may be turned off once synchronization has been achieved. Note that frames can be generated back to back, specifically, the frame strobe can occur at the same time as the last bit in the previous frame.

The serial frame timing is illustrated below in Figure 15.

Synchronous data from multiple chips may be time division multiplexed (TDM) onto the same serial bus. A master GC4016 chip (MASTER=1 in address 18 and

EN_RDY=1 in address 16) provides the frame strobe signal and serial clock and a RDY start of frame pulse. The bidirectional RDY pin is an output pin from the master chip and is an input pin for the slave chips (MASTER=0, EN_RDY=0). The slave chips use the RDY input frame strobe to identify the start of frame. The master will drive the serial outputs for the first 1-8 words (WORDS_PER_FRAME) of the frame, and then will tristate its serial data out. The slave chips are programmed using the FRAME_LENGTH control to delay the start of their outputs by 1-63 words from the beginning of frame. Note that the delay is programmed in words, NOT complex samples. The delay can be programmed independently for each slave chip so that each chip can have its own block of time in which to output data. For example, a four chip TDM stream can be generated, where each chip is outputting eight words (four complex outputs), by setting WORDS_PER_FRAME=7 (8 words per chip) in all four chips, FRAME_LENGTH=31 in the master chip (32 words per frame), FRAME_LENGTH=7 in the second chip (start at word 8), FRAME_LENGTH=15 in the third chip (start at word 16) and FRAME_LENGTH=23 in the fourth chip (start at word 24).

The TDM mode requires that the serial clocks in the master and slave chips have been synchronized using the OUT_BLK_SYNC control. See Section 3.12 for details.

The TDM mode is intended for use with a single serial output stream (NSERIAL=0), but will also work with one, two or four streams. The TDM outputs are then identified within each stream according to the NSERIAL and OUTPUT_ORDER controls as shown in Figure 15(c).

3.8.4 Asynchronous Serial Outputs

Asynchronous channels must be output on a single serial stream. Tag bits or separate frame strobes must be used to identify the channels. In the asynchronous mode each channel sample is output as a serial word (or complex pair) as soon as the resampler has finished generating it. Tag bits or separate frame strobes are used to match the serial output word with the channel it came from. *Asynchronous* channels must use NSERIAL=0, OUTPUT_ORDER=0, and BLOCK_SIZE=0. WORDS_PER_FRAME and FRAME_LENGTH must be set to 0 for real data and 1 for complex data. Four bit tags are enabled by setting TAG_EN=1 and TAG_22=0. The two bit tag mode (TAGEN=0, TAG22=1) can be used to output 24 bit words that are 22 bits of data plus 2 bits of tag.

Separate frame strobes are enabled by using the two bit tag mode and setting the EN_4_FS control bit (address 28 of

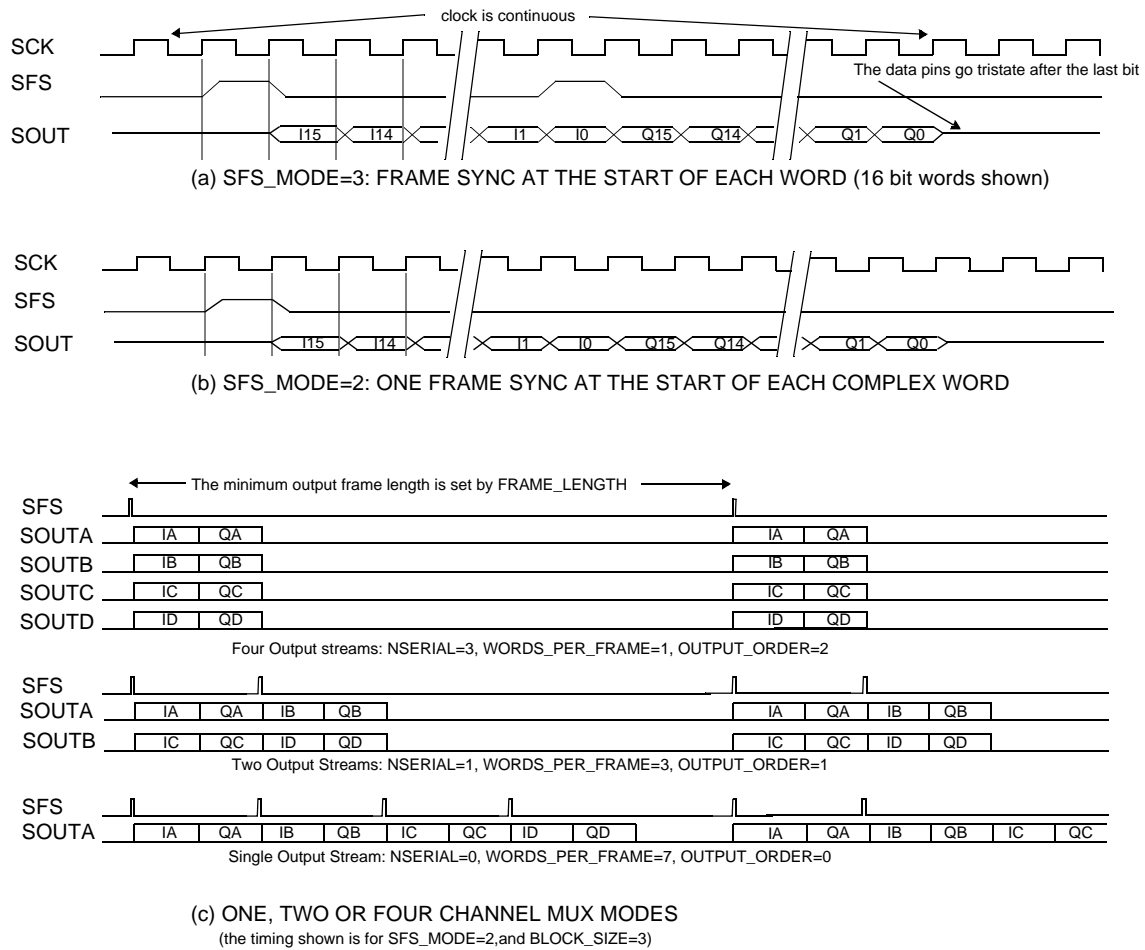


Figure 15. Serial Output Formats

the output page). When the EN_4_FS bit is set, the two bit tag is used to generate the four frame strobes FSA (tag=0), FSB (tag=1), FSC (tag=2) and FSD (tag=3). The timing for these frame strobes are the same as shown for SFS in Figure 15. The separate frame strobe mode (TAG_22=1 and EN_4_FS=1) is valid for all serial word sizes, but the 2 bit tag will only be output for 24, 28 or 32 bit serial word sizes. The four frame strobes share output pins P4, P5, P6 and P7.

3.8.5 Nibble Mode Output

The four serial output pins (P0, P1, P2 and P3), the serial clock pin (SCK) and the frame sync pin (SFS) can be configured as a nibble wide output by setting OUTPUT_MODE=2, MASTER=1 and NIBBLE=1 in address 18. These pins are in a tristate condition when the chip powers up and need to be enabled by setting EN_SCK, EN_SFS, EN_P0, EN_P1, EN_P2 and EN_P3 in address 16. The nibble mode functions the same as the serial mode except 4 bits are output at a time, the word size is restricted

to being 16 or 32 bits, all channels are output on the same nibble port, and the SFS signal is coincident with the first nibble of a transfer, rather than being one SCK clock early.

The nibble mode requires that OUTPUT_ORDER=0 and NSERIAL=0.

For *synchronous* channels, BLOCK_SIZE should be set to the number of active channels, WORDS_PER_FRAME should be set to match the number of active words (two per active channel for complex data) and FRAME_LENGTH should be set to define the minimum number of words per frame.

Asynchronous channels must use BLOCK_SIZE=0 and TAG_EN=1. WORDS_PER_FRAME must be set to 0 for real data and 1 for complex data.

The nibble mode can support TDM of multiple chips, in which case the RDY pin is used to synchronize master and slave chips in the same way it was used in the serial TDM mode. To use the TDM mode set MASTER=1 and

EN_RDY=1 in the master chip, and set MASTER=0 and EN_RDY=0 in the slave chips.

The SFS strobe behaves the same in the nibble mode as in the serial mode except that the SFS strobe is coincident with the first nibble in the word and that the SFS strobe can not come every word in the real 16 bits per word mode (REAL_ONLY=1, BITS_PER_WORD=0). The latter exception means that for 16 bit real data, SFS_MODE must be equal to 0 (one SFS strobe at the beginning of the frame) AND the frame length cannot be one word (FRAME_LENGTH can not equal 0). This restriction does not apply to complex outputs or to 32 bit nibble output modes

The separate frame strobe mode described for asynchronous serial data can also be used in the nibble mode.

3.8.6 LINK Mode Output

The four serial output pins (P0, P1, P2 and P3) and the serial clock (SCK) and RDY pins can be configured as a nibble wide link port by setting OUTPUT_MODE=2, NIBBLE=1 and LINK=1 in address 18. The link port can feed an ADSP-2106x SHARC DSP chip's link port. The P0, P1, P2, P3 and SCK pins are in a tristate condition when the chip powers up and need to be enabled by setting EN_SCK, EN_P0, EN_P1, EN_P2 and EN_P3 in address 16. EN_RDY must be low. In the LINK mode the RDY output pin becomes the ACK (acknowledge) input pin which is tied to the link port "LACK" signal. LACK is used to stall the output until the processor is ready for it.

The outputs are transmitted in four bit nibbles on the rising edge of SCK (INV_SCK in address 17 must be low). If the ACK signal is low at the end of a 32 bit transfer, then the clock will remain high and the transmission of the next word will be delayed until ACK goes high again.

The link port transfers data as 32 bit packets. The user can choose to transmit two 16 bit words per packet, or a single 32 bit word. To transmit two 16 bit words per packet the user must set BITS_PER_WORD to 0 and WORDS_PER_FRAME to 1. To transmit a single 32 bit word per packet the user must set BITS_PER_WORD to 1 and WORDS_PER_FRAME to 0.

The link mode requires OUTPUT_ORDER, NSERIAL and BLOCK_SIZE to be set to 0. FRAME_LENGTH and SFS_MODE are unused and should also be set to 0. The link mode clock rate is set by SCK_RATE.

If the outputs are *synchronous*, and the chip has been initialized properly (see Section 3.12), then the first transfer will be the I part of channel A followed by the Q part, followed

by the I/Q pairs from channels B, C and D. If the channels are *asynchronous*, or initialization is not possible, then tag bits must be used to identify the channel data. The tag bits for *synchronous* data may be disabled once synchronization is achieved.

The link mode normally puts the least significant bit in P0. Note that this is opposite of the GC4014. For pin compatibility with the GC4014 the control SMUX_0 in address 22 should be set to 1. This will put the least significant bit in P3.

When transferring two 16 bit words in a 32 bit link packet the first word will end up in the upper 16 bits of the packet and the second word in the lower 16 bits. This means that the memory order in the DSP chip may end up being (QA, IA, QB, IB, ...) for complex data and (I1, I0, I3, I2, ...) for single channel real data. The REVERSE_IQ control bit in address 18 will eliminate this problem by swapping the I/Q pair (or the I0/I1 pair) in the 32 bit packet.

3.8.7 Parallel Mode Output

The SCK, SFS, RDY and P0 through P23 pins are used in the parallel mode to output 24 bit wide data samples. The mode is enabled by setting the EN_SCK, EN_SFS, EN_RDY, EN_P0, EN_P1, EN_P2, EN_P3 and EN_PAR bits in address 16, and by setting OUTPUT_MODE=3, MASTER=1, and PARALLEL=1 in address 18. The parallel mode also requires NSERIAL=0 and OUTPUT_ORDER=0 in address 21. FRAME_LENGTH is unused and should be set to 0 in address 20.

The 24 bit samples are clocked out on the rising edge of SCK (or the falling edge if INV_SCK is set). The SCK clock is continuous and the SFS and RDY outputs are used to identify when a valid sample has been clocked out. The data valid flags will go high during the SCK clock period when the 24 bit sample is valid. The SFS and RDY flags behave in two modes as controlled by the SFS_MODE control bits in address 19.

If SFS_MODE is 0 or 1, then the SFS is IVALID and RDY is QVALID. If the outputs are *synchronous*, and the chip has been initialized properly (see Section 3.12), then the first valid sample after initialization will be the I part of channel A. The next valid sample will be the Q part, followed by the I/Q pairs from channels B, C and D. If the channels are *asynchronous*, or initialization is not possible, then tag bits must be used to identify the channel data. The tag bits for *synchronous* data may be disabled once synchronization is achieved.

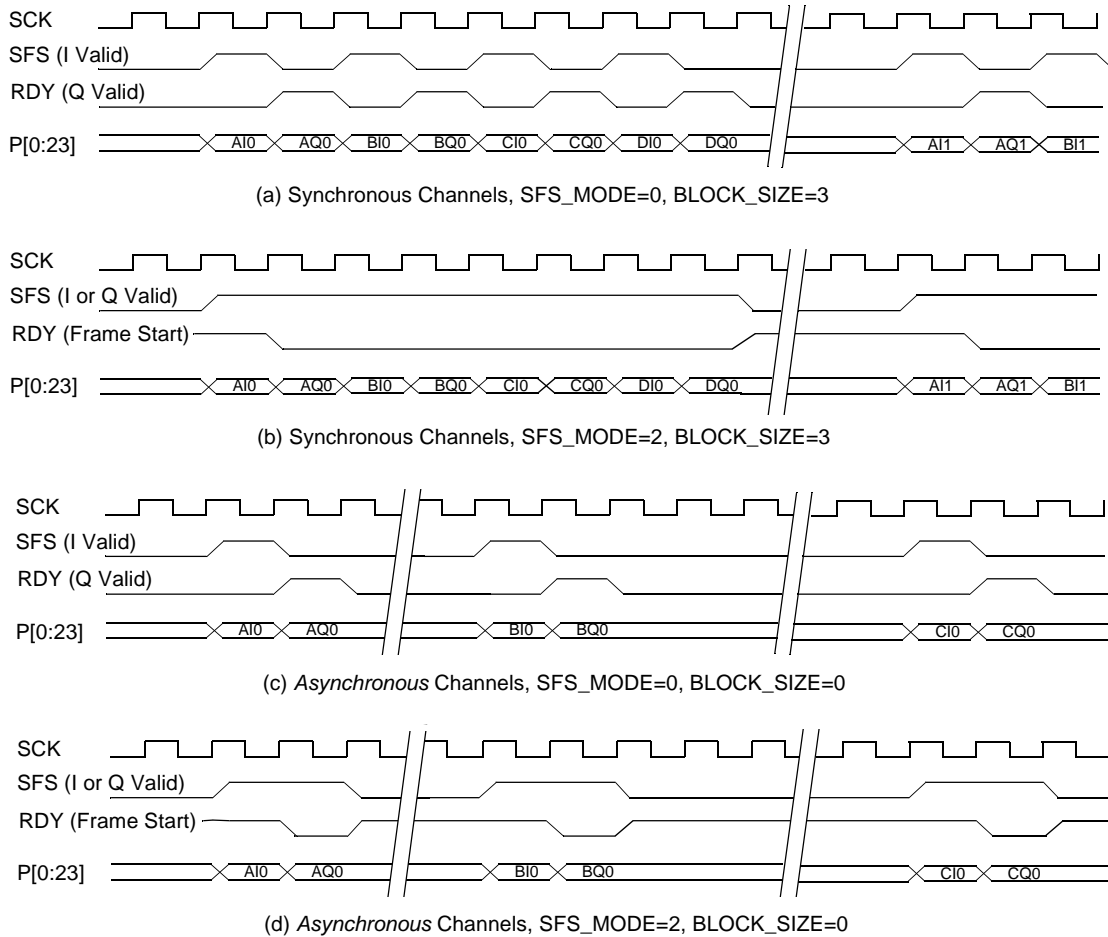


Figure 16. Parallel Mode Timing

If SFS_MODE is 2 or 3, then SFS is a data valid flag (I or Q) and the RDY output is a start of frame flag which identifies the I part of channel A. If the outputs are synchronous, then the channel data can be identified by its position in the frame relative to the RDY flag. If the outputs are *asynchronous*, then tags must be used to identify the channel data. The parallel output timing is illustrated in Figure 16. Note that when SFS_MODE is 2 or 3, then the RDY flag goes high at the end of the frame and goes low after the first word of the next frame. This is illustrated in Figures 16 b and d.

The polarities of the SFS and RDY flags are controlled by the INV_SFS and INV_RDY bits in address 17.

3.9 CLOCKING

The clock rate is equal to the input data rate which can be up to 80 <TBD 90> MHz. An internal clock doubler doubles the clock rate so that the internal circuitry is clocked at twice the data rate. The clock doubler requires a

continuous clock (no deleted clock pulses) for proper operation.

The \overline{DVAL} input is used as an active low data valid signal which is clocked into the chip on the rising edge of CK. The data in the next CK cycle is ignored when \overline{DVAL} is high. The \overline{DVAL} signal operates by gating the output of the clock doubler. It does not affect the clock to the output circuitry, so the output will continue while \overline{DVAL} is high. The DVAL signal allows users to input data in bursts, such as data which is being read from a memory or FIFO. The \overline{DVAL} signal should never be high for more than a 1msec. Normally \overline{DVAL} will be grounded.

The clock doubler can be bypassed and an externally generated 2X clock can be used in its place by setting the CK_2X_EN control bit in address 0. In this mode the \overline{DVAL} pin becomes the external CK_2X input. This mode is intended for test purposes only.

The CK_2X_TEST control bit in address 0 enables the clock test mode where the internal doubled clock is output on the \overline{SO} pin. The \overline{DVAL} pin must be low in this test mode.

3.10 POWER DOWN MODES

The chip has a power down and clock loss detect circuit. This circuit detects if the clock is absent long enough to cause dynamic storage nodes to lose state. If clock loss is detected, an internal reset state is entered to force the dynamic nodes to become static. The control registers are not reset and will retain their values, but any data values within the chip will be lost. When the clock returns to normal the chip will automatically return to normal. In the reset state the chip consumes only a small amount of standby power. The user can select whether this circuit is in the automatic clock-loss detect mode, is always on (power down mode), or is disabled (the clock reset never kicks in) using the CK_LOSS_DETECT and GLOBAL_RESET control bits in address 0. The whole chip, or individual down converter channels can be powered down.

NOTE: Resampler channel 0 provides the “block complete” signal to the output FIFO when OUTPUT_ORDER=1 or 2. This means that the channel feeding resampler channel 0, typically channel A (see CHAN_MAP in the resampler control page), can not be powered down when OUTPUT_ORDER=1 or 2.

3.11 SYNCHRONIZATION

Each GC4016 chip can be synchronized through the use of one of two sync input signals, an internal one shot sync generator, or a sync counter. The sync to each circuit can also be set to be always on or always off. Each circuit within the chip, such as the sine/cosine generators or the decimation control counter can be synchronized to one of these sources. These syncs can also be output from the chip so that multiple chips can be synchronized to the syncs coming from a designated “master” GC4016 chip.

The 3 bit sync mode control for each sync circuit is defined in Table 7:

Table 7: Sync Modes

MODE	SYNC SOURCE
0,1	off (never asserted)
2	SIA
3	SIB
4	ONE_SHOT
5	TC (terminal count of internal counter)
6,7	on (always active)

NOTE: the internal syncs are active high. The \overline{SIA} and \overline{SIB} inputs have been inverted to be the active high syncs SIA and SIB in Table 7.

The ONE_SHOT can either be a level or a pulse as selected by the OS_MODE control bit. The level mode is used to initialize the chip, the pulse mode is used to synchronously switch frequency, phase or gain values.

Typically the decimation counters (DEC_SYNC), the flush circuits (FLUSH_SYNC) and the output block sync (OUT_BLK_SYNC) will be set to SIA, while the NCO phase accumulator syncs (NCO_SYNC) will be set to SIB. The \overline{SIA} input can then be used to initialize and flush the channels and the \overline{SIB} sync input can be used, if desired, to synchronize the phases of the NCOs.

The recommended sync mode settings are summarized in Table 8.

The \overline{SIA} and \overline{SIB} sync inputs are either connected to a user defined sync generator, for example, an FPGA, or are tied to a GC4016 chip’s sync output pin (\overline{SO}). If there are multiple GC4016 chips in the system, then the \overline{SO} pin of one chip can be used to drive the \overline{SIA} input of all chips, and the \overline{SO} pin of another chip can drive the \overline{SIB} inputs of all chips.

Table 8: Recommended Sync Settings

Global Syncs (Addresses 4 and 5)			Channel Syncs (Pages 7, 15, 23 and 31)		
Sync	Value	Description	Sync	Value	Description
DIAG_SYNC	7 (always)	Only used during diagnostics	PHASE_SYNC	7 (always)	Use phase settings as they are loaded
OUTPUT_SYNC	4 (OS)	The SO output is used during initialization	FREQ_SYNC	7 (always)	Use frequency settings as they are loaded
COUNTER_SYNC	4 (OS)	Sync counter with one shot pulse	NCO_SYNC	2 (SIA)	Sync the phase accumulator during initialization. Set to SIB for frequency hopping.
Output Circuit Sync (Page 98)			DITHER_SYNC	0 (never) or 2 (SIA)	Can free run except during diagnostics, or reset during initialization
OUT_BLK_SYNC	2 (SIA)	Sync the output block during initialization	ZPAD_SYNC	2 (SIA)	Sync the zero pad circuit during initialization
Resampler syncs (Page 64)			DEC_SYNC	2 (SIA)	Sync the channel decimation during initialization
RES_SYNC	2 (SIA)	Sync the Resampler during initialization	FLUSH_SYNC	2 (SIA)	Flush the channels during initialization
RATIO_SYNC	7 (always)	Set to always except when synchronously changing ratios	GAIN_SYNC	7 (always)	Use fine gain settings as they are loaded
			PEAK_SYNC	5 (TC)	Periodically capture peak count data

This arrangement allows the user to use the $\overline{S0}$ sync output to synchronously drive the $\overline{S1A}$ or $\overline{S1B}$ sync inputs of all chips. The sync source for $\overline{S0}$ is selected using the OUTPUT_SYNC control bits in address 4.

The resampler time delay accumulator is synchronized by the RES_SYNC control. Typically the resampler is only synchronized during initialization.

3.12 INITIALIZATION

Two initialization procedures are recommended. The first is recommended for multi-GC4016 chip configuration. The second can be used for stand alone GC4016 chips.

3.12.1 Initializing Multiple GC4016 Chips

The multi-GC4016 initialization procedure assumes that the $\overline{S1A}$ sync input pins of all GC4016 chips are tied together and are connected to the $\overline{S0}$ output of the "master" chip, or to a common sync source. The procedure is to:

- (1) Reset the chip by setting address 0, the global reset register, to 0xF8;
- (2) Configure the rest of the chip including setting the DEC_SYNC, RES_SYNC and OUT_BLK_SYNC to be $\overline{S1A}$, the OS_MODE to be 1, and the OUTPUT_SYNC to be OS (see Table 7);
- (3) Assert the $\overline{S1A}$ sync input by setting ONE_SHOT high (or by setting the external $\overline{S1A}$ source low);
- (4) Release the global resets by setting address 0 to 0x08; and
- (5) Release the $\overline{S1A}$ sync by setting ONE_SHOT to 0 (or the external $\overline{S1A}$ source high).

The global resets are asserted before configuring the chip so that the operation of all of the pins, including the directions of the bidirectional and tristate pins, will be established before the global resets release them. The $\overline{S1A}$ sync is asserted before releasing the global resets so that the channels will remain in a reset state after the global resets are released. All channels, the resampler and the output block will then start synchronously by releasing the SIA sync. If there are multiple chips which need synchronized, then synchronously releasing the SIA sync to them all will force them all to be synchronized.

3.12.2 Initializing Stand Alone GC4016 chips

The initialization sequence for a stand alone GC4016 chip is similar to the one for the multi-GC4016 procedure, except that the ONE_SHOT is used to synchronize the chip, not the SIA input sync. The procedure is to:

- (1) Reset the chip by setting address 0, the global reset register, to 0xF8;
- (2) Configure the rest of the chip including setting the DEC_SYNC, RES_SYNC and OUT_BLK_SYNC to be ONE_SHOT (mode 4) and the OS_MODE to be 1;
- (3) Assert the syncs by setting ONE_SHOT high;
- (4) Release the global resets by setting address 0 to 0x08; and
- (5) Release the syncs by setting ONE_SHOT to 0.

3.13 DATA LATENCY

The data latency through the chip is defined as the delay from the rising edge of a step function input to the chip to the rising edge of the step function as it leaves the chip. This delay is dominated by the number of taps in each of the filters. An estimate of the overall latency through the chip, expressed as the number of input clock cycles is:

$$\begin{aligned} &(\text{CIC latency} = 2.5N) + (\text{CFIR latency} = 0.5N \cdot \text{CTAP}) + \\ &(\text{PFIR latency} = N \cdot \text{PTAP}) + (\text{Resampler latency} = \\ &2N \cdot \text{NMULT}) + (\text{Output delay}) + (\text{Pipeline delay}) \end{aligned}$$

where N is the CIC decimation ratio, CTAP is the number of CFIR taps, and PTAP is the number of PFIR taps. CTAP and PTAP are normally 21 and 63. Latency can be reduced by using the NO_SYM_CFIR and NO_SYM_PFIR modes to shorten these filters. The latency in the resampler can be minimized by using the bypass configuration (See Section 3.5.6).

The Output delay depends upon the output mode, but is approximately equal to the fifo block size (BLOCK_SIZE+1) times the output's sample period. The Pipeline delay is approximately 40 clock cycles.

3.14 DIAGNOSTICS

The chip has an internal ramp generator which can be used in place of the data inputs for diagnostics. An internal checksum circuit generates a checksum of the output data to verify the chip's operation. Section 7.13 gives suggested checksum configurations and their expected checksums.

Besides the internal diagnostics, the chip can support board level testing. An output test configuration which can help initial debug as well as production test is described in Section 7.14.

3.15 JTAG

The GC4016 supports a four pin (TDI, TDO, TCK and TMS) boundary scan interface. Contact GRAYCHIP to receive the GC4016's BSDL file.

3.16 MASK REVISION REGISTER

An 8 bit mask revision code (REVISION) can be read from address 27 of the output control page (page 98). The revision code allows users to determine, through software, what version of the GC4016 chips are being used. The current mask revision codes are:

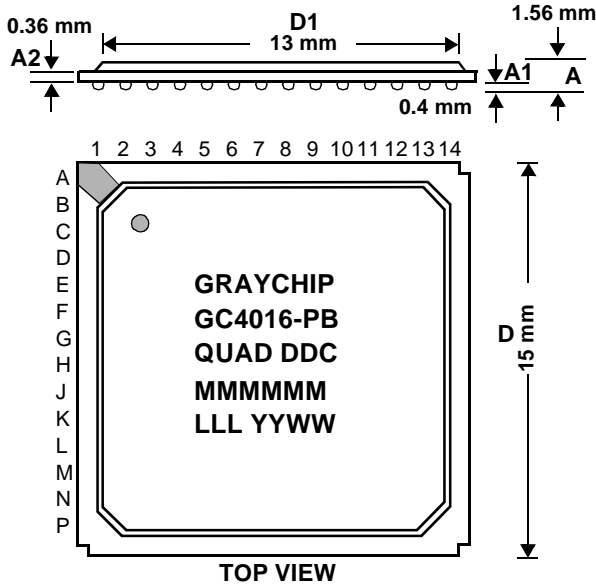
Table 9: Mask Revisions

GC4016			
Revision Code (REVISION)	Release Date	Mask Code on Package	Description
0	April 2000	SAMPLE	Early samples
1	Sept. 2000	1001ACBA	First Release, Has 40 ohm Vcore to Vpad short, no JTAG
2	March 2001	1001ACBB	Production Release, JTAG added, short removed.

4.0 PACKAGING

4.1 GC4016-PB 160 Ball Plastic Ball Grid Array (PBGA)

The GC4016 chip is packaged in a 160 lead plastic ball grid array package.

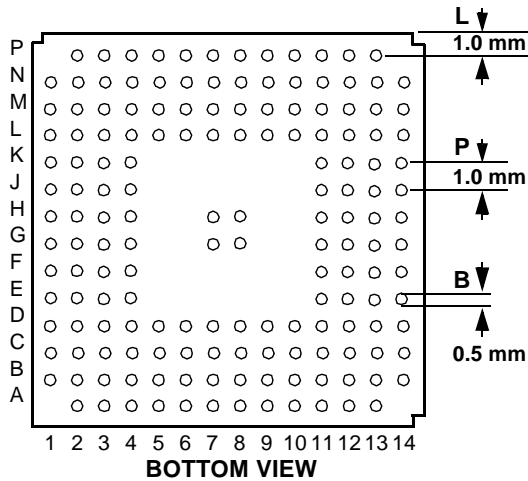


160 BALL PLASTIC BALL GRID ARRAY

DIMENSION	TYP	TOLERANCE
D (width body)	15 mm	+0.05 mm
D1 (width cover)	13 mm	+0.7 -0.05 mm
P (ball pitch)	1.0 mm	+0.05 mm
B (ball width)	0.5 mm	+0.1 mm
L (overhang)	1.0 mm	+0.05 mm
A (overall height)	1.56 mm	+0.19 -0.21 mm
A1 (ball height)	0.4 mm	+0.1 mm
A2 (substrate thickness)	0.36 mm	+0.05 mm

MARKING:

MMMMMM = Mask Code
 LLL = Lot Code
 YYWW = Date Code

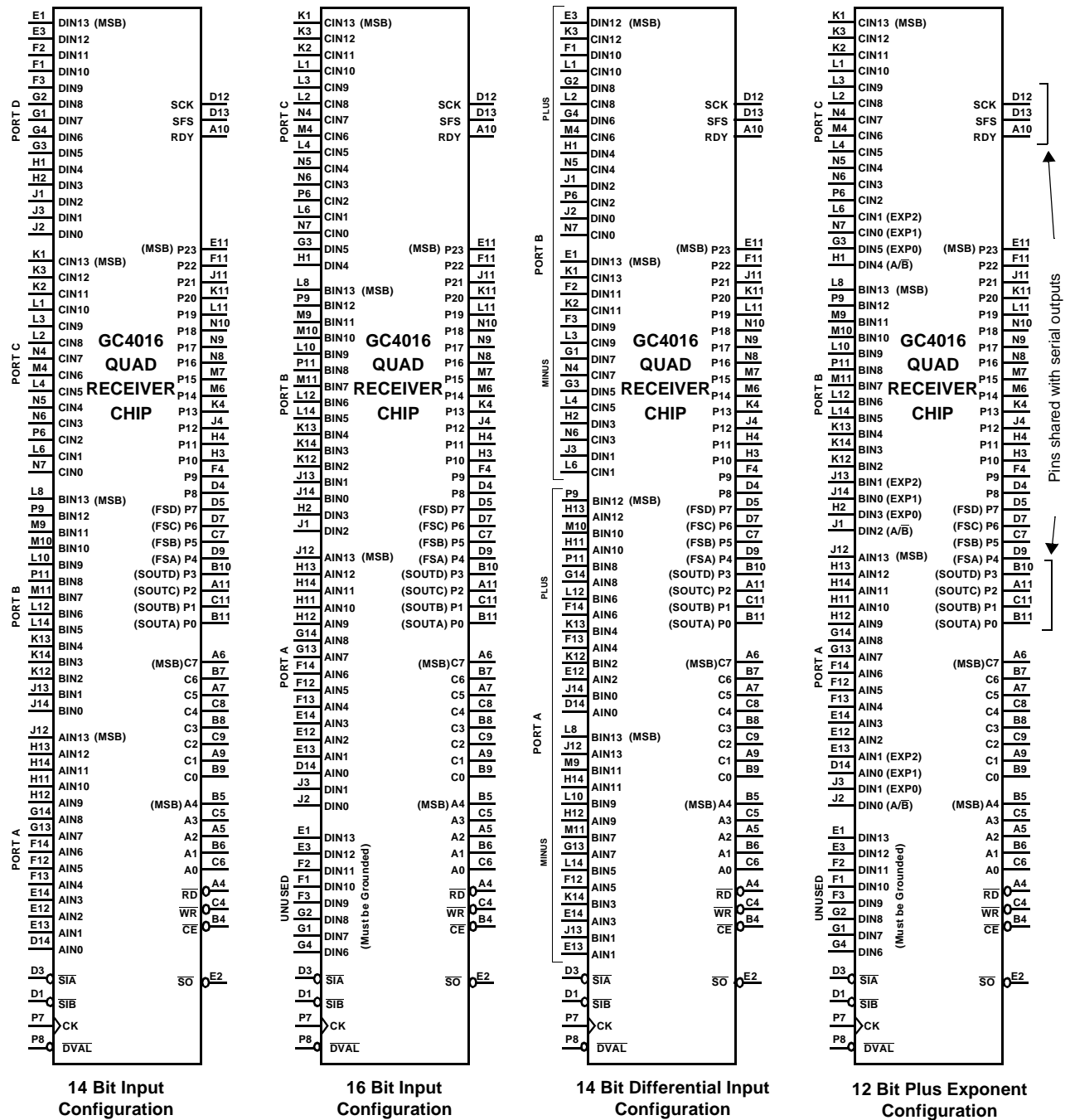


- V_{CORE}: C14, D2, L5, L13, M8, P3, P10
- V_{PAD}: B14, C3, D6, D8, D10, G12, M3, P5, P12
- GND: A3, A12, L7, L9, M1, M5, N11
 A8, A13, C1, D11, E4, G11, M14, N3, P4
- GND (THERMAL): G7, G8, H7, H8
- UNUSED: A2, B1, B2, B3, B13, C2, M2, M12, M13,
 N1, N2, N12, N13, N14, P2, P13
- JTAG: B12 (TCK), C10 (TMS), C12 (TDO), C13 (TDI)

NOTE: 0.01 to 0.1 μf DECOUPLING CAPACITORS SHOULD BE PLACED AS CLOSE AS POSSIBLE TO THE MIDDLE OF EACH SIDE OF THE CHIP

Figure 17. GC4016 160 Pin Plastic Ball Grid Array

Schematic symbols and pin assignments for the GC4016 in each of its input configurations are shown below.



NOTE: All unused inputs must be grounded
 JTAG Pins are: B12 (TCK), C10 (TMS), C12 (TDO), C13 (TDI)

Figure 18. GC4016 Pin Assignments

Table 10: GC4016 Pin Out Locations Top View

	1:	2:	3:	4:	5:	6:	7:	8:	9:	10:	11:	12:	13:	14:
A:		*	GND	\overline{RD}	A2	C7	C5	GND	C1	RDY	P2	GND	GND	
B:	*	*	*	\overline{CE}	A4	A1	C6	C3	C0	P3	P0	TCK	*	VPAD
C:	GND	*	VPAD	\overline{WR}	A3	A0	P5	C4	C2	TMS	P1	TDO	TDI	VCORE
D:	\overline{SIB}	VCORE	\overline{SIA}	P8	P7	VPAD	P6	VPAD	P4	VPAD	GND	SCK	SFS	AIN0
E:	DIN13	\overline{SO}	DIN12	GND							P23	AIN2	AIN1	AIN3
F:	DIN10	DIN11	DIN9	P9							P22	AIN5	AIN4	AIN6
G:	DIN7	DIN8	DIN5	DIN6			TGND	TGND			GND	VPAD	AIN7	AIN8
H:	DIN4	DIN3	P10	P11			TGND	TGND			AIN10	AIN9	AIN12	AIN11
J:	DIN2	DIN0	DIN1	P12							P21	AIN13	BIN1	BIN0
K:	CIN13	CIN11	CIN12	P13							P20	BIN2	BIN4	BIN3
L:	CIN10	CIN8	CIN9	CIN5	VCORE	CIN1	GND	BIN13	GND	BIN9	P19	BIN6	VCORE	BIN5
M:	GND	*	VPAD	CIN6	GND	P14	P15	VCORE	BIN11	BIN10	BIN7	*	*	GND
N:	*	*	GND	CIN7	CIN4	CIN3	CIN0	P16	P17	P18	GND	*	*	*
P:		*	VCORE	GND	VPAD	CIN2	CK	\overline{DVAL}	BIN12	VCORE	BIN8	VPAD	*	

VPAD =Pad Ring Power (3.3v)
 VCORE = Core Power (2.5v)
 TGND = Thermal Ground
 * = unused ball

<u>SIGNAL</u>	<u>DESCRIPTION</u>
A,B,C, DIN	INPUT DATA , <i>Active high input pins</i> The 14 bit 2's complement input data for the four channels. The inputs are clocked into the chip on the rising edge of the clock (CK). These pins can be configured to support three 16 bit ports, two 14 bit differential ports, three 12 bit + 3 bit exponent ports, or three 12 bit + 3 bit exponent + A/B selection ports. See Section 3.2 and Figure 18.
P[0:3]	BIT SERIAL AND NIBBLE OUTPUT DATA , <i>Active high tristate output pins</i> The nibble and bit serial output pins. In the serial mode these are individual outputs, in the nibble mode these form a four bit nibble (P0 is normally the LSB of the Nibble, P3 is the MSB). The output bits are clocked out coincident with the rising edge of SCK (falling edge if INV_SCK=1). These pins are tristated at power up and are enabled by EN_P0 , EN_P1 , EN_P2 and EN_P3 .
P[0:23]	PARALLEL OUTPUT DATA , <i>Active high tri state output pins</i> The 24 bit parallel output port. These output bits are clocked out by CK coincident with the rising edge of SCK (falling edge if INV_SCK=1) with the SFS and RDY pins used to identify valid data (Section 3.8.6). These pins are tristated at power up and are enabled by the EN_PAR control register bit. These pins can be used in the wide word microprocessor mode. In this mode the pins are used as part of the control bus when read from the data output page (See Section 3.8).
SCK	SERIAL DATA CLOCK , <i>Active high or low tristate output pin</i> The serial, nibble, link and parallel data output clock. The SCK signal is clocked out on the rising edge of CK . The SFS , RDY and P output signals are clocked out of the chip coincident with the active edge of this clock. The active edge of the clock is user programmable. This pin is tristated at power up and is enabled by the EN_SCK control register bit.
SFS	SERIAL FRAME STROBE , <i>Active high or low tristate output pin</i> The bit serial word strobe. This strobe identifies the beginning of a frame, a complex pair, or a word within bit serial output streams as controlled by the SFS_MODE control register bits. The polarity of this signal is user programmable. This pin is tristated at power up and is enabled by the EN_SFS control register bit. This pin is also used as a data valid signal for parallel outputs.
RDY	READY FLAG , <i>programmable active high or low bidirectional I/O pin</i> Used to identify when new outputs are available in the serial, nibble and microprocessor output modes. In the link mode RDY is an input signal tied to the LACK output signal from SHARC DSP chips. In the parallel mode it is a data valid flag. The RDY signal is clocked out on the rising edge of CK . This pin is tristated at power up and is enabled by the EN_RDY control register bit.
CK	INPUT CLOCK . <i>Active high input pin</i> The clock input to the chip. The AIN , BIN , CIN , DIN , DVAL , SIA and SIB input signals are clocked into the chip on the rising edge of this clock. The SO , P , SFS , SCK and RDY outputs are clocked out on the rising edge of this clock.
DVAL	DATA VALID . <i>Active low input pin</i> This pin is normally grounded. This pin must be low to enable the internal clock. DVAL is clocked into the chip on the rising edge of CK , and, if high, disables the following CK edge to the channels and resampler. It does not effect the clock to the output circuitry. Since DVAL enables or disables the internal clock, it can be used as a data enable for non-continuous input data. This pin should never be held high for more than 1ms. DVAL is used as a 2X clock input when the CK_2X_EN control bit is high (see Section 3.9).
SIA, SIB	SYNC IN A and B . <i>Active low input pins</i> The sync inputs to the chip. All timers, accumulators, and control counters (except the resampler time delay accumulator) are, or can be, synchronized to SIA or SIB . These syncs are clocked into the chip on the rising edge of the input clock (CK).
SO	SYNC OUT . <i>Active low output pin</i> This signal is either a delayed version of one of the input syncs SIA or SIB , the sync counter's terminal count (TC), or a one-shot strobe. The SO signal is clocked out of the chip on the rising edge of the input clock (CK).
C[0:7]	CONTROL DATA I/O BUS . <i>Active high bidirectional I/O pins</i> This is the 8 bit control data I/O bus. Control registers are written to or read from through these pins. The chip drives these pins when CE is low, RD is low and WR is high. Note that when the output is in the wide word microprocessor mode, the P[0:23] pins are used when reading and will behave the same as the C[0:7] pins. When reading from the output page the P[0:23] pins will output data, when reading from all other pages the P[0:23] pins will read back high.
A[0:4]	CONTROL ADDRESS BUS . <i>Active high input pins</i> These pins are used to address the control registers within the chip. Each of the control registers within the chip are assigned a unique address. A control register can be written to or read from by setting A[0:4] to the register's address and setting the page register appropriately. An alternate method using a 4 bit addressing scheme is available to support using buses with limited addressing (for example the T1320C6X family peripheral host interface bus). See Section 3.1.
RD	READ ENABLE . <i>Active low input pin</i> The register selected by A[0:4] and the page register is output on the C[0:7] pins when RD and CE are low.
WR	WRITE ENABLE . <i>Active low input pin</i> The value on the C[0:7] pins is written into the register selected by the A[0:4] and page register when WR and CE are low.
CE	CHIP ENABLE . <i>Active low input pin</i> This control strobe enables the read or write operations.
TCK,TDI,TMS,TDO	JTAG INTERFACE . <i>Active high input (TCK, TMS, TDI) and tristate output (TDO) pins</i> The JTAG interface (See Section 3.15)

5.0 CONTROL REGISTERS

The chip is configured by writing to eight bit control registers. These registers are accessed for reading or writing using the control bus pins (\overline{CE} , \overline{RD} , \overline{WR} , $A[0:4]$, and $C[0:7]$) described in Section 3.1. The 32 word address space is split into eight global registers (addresses 0-7), eight unused registers (addresses 8-15) and 16 paged registers (addresses 16-31). The global registers are available from each page. Address 2 is the page register which selects which control registers are accessed by addresses 16 through 31.

5.1 GLOBAL CONTROLS

The eight global control registers are:

Table 11: Global Control Registers

ADDRESS	NAME	DESCRIPTION
0	Global Reset	Miscellaneous general controls.
1	Status	uP ready/missed, resampler overflows, checksum ready,
2	Page	Page register for both 4 and 5 bit addressing modes
3	Checksum	Checksum results register
4	General Syncs	Syncs for output, checksum. One shot.
5	Count Sync	Sync for counter, ramp selection
6	Counter Byte 0	Ramp counter least significant byte.
7	Counter Byte 1	Ramp counter most significant byte.

ADDRESS 0: **Global Reset**, Powers up as $0xF0$. Suggested Default is $0xF8$ during configuration, $0x08$ afterwards.

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	CK_LOSS_DETECT	Disable the clock loss detection circuitry. This circuitry protects the chip against a current surge that may result if the clock is inactive for more than 100mS. Setting this bit turns off the clock loss detection circuitry. Used for test, not recommended for general use.
1	R/W	CK_2X_TEST	Test mode to output the doubled clock on SO. \overline{DVAL} must be low. Normally set to zero.
2	R/W	CK_2X_EN	Changes the \overline{DVAL} pin to become a CK_2X input pin. The chip normally uses an internally generated doubled clock (twice the CK clock). Setting this bit allows an externally generated doubled clock to be used. Used in test, not recommended for general use.
3	R/W	EDGE_WRITE	Sets the edge write mode for the control interface. When low the data must be stable while the write strobe is low. When high the outputs are latched on the rising edge of the write strobe ($\overline{WR} \overline{CE}$). A short (approximately 15 nS) write recovery time is required during which time the chip should not be read from or written to. Recommended to be set high.
4	R/W	RESAMPLER_RESET	This bit resets the resampler. This bit is set during power up and is cleared after configuration.
5	R/W	PAD_RESET	Forces SFS and RDY pads to tristate during power up. The user needs to clear this bit for proper operation of SFS and RDY.
6	R/W	OUT_BLK_RESET	This bit resets the output formatter block. This bit is set during power up and is cleared after configuration.
7	R/W	GLOBAL_RESET	This bit powers down the chip and tristates the output pins. This bit is set during power up and is cleared after configuration.

ADDRESS 1: Status Register, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	READY	The user sets this bit after reading the output registers. The chip clears this bit when new values have been loaded and it is time to read them.
1	R/W	MISSED	The chip sets this bit if the user has not set the READY bit before the chip loads the output registers. This bit high indicates that an error has occurred.
2	R/W	RES_IOV	This control bit is set by the chip whenever the resampler I channel overflows. The user can monitor this bit to see if the gain is too high. The user clears the bit by writing a zero to it.
3	R/W	RES_QOV	This control bit is set by the chip whenever the resampler Q channel overflows. The user can monitor this bit to see if the gain is too high. The user clears the bit by writing a zero to it.
4	R/W	CHECK_DONE	This bit is set when the checksum sync is active (see DIAG_SYNC in address 4). The user can count sync cycles by clearing this bit and then waiting for it to be set. The checksum will be complete after it this bit has been cleared and set four times.
5-7 MSB	R	ZERO	Reads back as zero.

The READY bit is used to tell an external processor when new output samples are ready to be read. If desired, the **RDY** pin can be used as an interrupt to the external processor (See Section 3.8.1) to tell the processor when to read new samples. The user does not need to set the READY bit if **RDY** is used. If READY is not set, however, the MISSED flag will not be valid.

ADDRESS 2: Page Register

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	A3	Used in the 4_BIT_ADDRESS mode (see global register 4) as address bit A3. This bit is unused if 4_BIT_ADDRESS=0.
1-7 MSB	R/W	PAGE[0:6]	Page number for addressing different portions of the chip.

In normal mode, the LSB is unused. PAGE is decoded to select the different control pages (see Table 12). Note that addresses 0-7 are globally visible regardless of the PAGE value. Addresses 8-15 are unused. Addresses 16-31 are paged. In the four bit address mode, the LSB provides address bit A3, effectively reducing each page to 8 words and doubling the number of pages.

ADDRESS 3: Checksum Register

BIT	TYPE	NAME	DESCRIPTION
0-7	R	CHECKSUM[0:7]	The checksum.

The checksum register is a read only register which contains the checksum of the output data. The checksum is stored in the checksum register and then starts over again each time the DIAG_SYNC (See address 4) occurs.

ADDRESS 4: General Sync Register, Suggested default = 0x27, Cleared by power up

BIT	TYPE	NAME	DESCRIPTION
0-2 (LSB)	R/W	DIAG_SYNC	The Checksum generator is strobed by this sync. See Table 7 for the possible sync selections.
3-5	R/W	OUTPUT_SYNC	The selected sync is inverted and output on the \overline{SO} pin. See Table 7.
6	R/W	4_BIT_ADDRESS	This mode allows four address bits (such as the expansion bus of the TI320C6202) instead of 5 to be used. In this mode each page contains 8 words (rather than 16). The LSB of the page register is used as address bit A3. Pin A3 should be grounded in this mode.
7 (MSB)	R/W	DIFF_IN	Enables differential receivers. Both this bit and the corresponding bits in each channel must be set to properly receive differential signals. This bit should be cleared for other inputs and for minimum power consumption. Contact Graychip for the use of the differential input mode.

ADDRESS 5: Count Sync Register, Suggested default = 0x50

BIT	TYPE	NAME	DESCRIPTION
0-1 LSB	R/W	DIAG_SOURCE	This two bit field selects the diagnostic input source used when the INPUT_SEL field in each channel's control register is set to 6 or 7 (See channel control address 27). DIAG_SOURCE = 0 selects the 16 LSB's of the counter (see addresses 6&7) as a diagnostic ramp. DIAG_SOURCE=1 is a zero input, DIAG_SOURCE=2 is unused, DIAG_SOURCE= 3 gives a 0x4000 constant input.
2-4	R/W	COUNTER_SYNC	Synchronizes the sync counter. This counter is used to generate the periodic TC sync. See Table 7.
5	R/W	COUNT_TEST	Used during factory tests. Should be set to 0 for normal operation.
6	R/W	OS_MODE	The ONE_SHOT signal is a level, not a pulse when this bit is set.
7 (MSB)	R/W	ONE_SHOT	The one shot sync signal (OS) is generated when this bit is set. If OS_MODE is low, then a one shot pulse (one clock cycle wide) is generated. If OS_MODE is high, then the ONE_SHOT sync is active while this bit is high. This bit must be cleared before another one shot pulse can be generated.

ADDRESS 6: Counter Byte 0, Suggested default = DEC (CIC decimation value)

BIT	TYPE	NAME	DESCRIPTION
0-7	R/W	CNT[0:7]	The LSBs of the counter cycle period

ADDRESS 7: Counter Byte 1, Suggested default = DEC

BIT	TYPE	NAME	DESCRIPTION
0-7	R/W	CNT[8:15]	The 8 MSBs of the counter cycle period

The chip's internal sync counter counts in cycles of $256(\text{CNT}+1)$ clocks. A terminal count signal (TC) is output at the end of each cycle. The counter can be synchronized to an external sync as specified in the Count Sync Register (address 5). If **CNT** is set so that $256(\text{CNT}+1)$ is a multiple of sixteen times the CIC decimation ratio (i.e., a multiple of $16N$), then the terminal count of this counter can be output on the \overline{SO} pin and used to periodically synchronize multiple GC4016 chips.

5.2 PAGED REGISTERS

Addresses 16 to 31 are used in pages as determined by the page map register (address 2).

Table 12: Page Assignments

Page	Description
0,1	Channel A CFIR Coefficients
2-5	Channel A PFIR Coefficients
6	Channel A Frequency
7	Channel A Control
8,9	Channel B CFIR Coefficients
10-13	Channel B PFIR Coefficients
14	Channel B Frequency
15	Channel B Control
16,17	Channel C CFIR Coefficients
18-21	Channel C PFIR Coefficients
22	Channel C Frequency
23	Channel C Control
24,25	Channel D CFIR Coefficients
26-29	Channel D PFIR Coefficients
30	Channel D Frequency
31	Channel D Control
32-63	Resampler Coefficients
64	Resampler Control
65	Resampler Ratios
66-95	unused
96,97	Output Data
98	Output Control
99-127	unused

The following sections describe each of these pages.

5.3 CFIR COEFFICIENT PAGES

The user programmable filter CFIR coefficients are stored using pages 0 and 1 for channel A, pages 8 and 9 for channel B, pages 16 and 17 for channel C, and pages 24 and 25 for channel D.

Table 13: CFIR Coefficient Pages

Address	Pages 0, 8, 16, or 24	Pages 1, 9, 17, or 25
	Description	Description
16	h_0 LSBs (end or first tap)	h_8 LSBs
17	h_0 MSBs (end or first tap)	h_8 MSBs
18	h_1 LSBs	h_9 LSBs
19	h_1 MSBs	h_9 MSBs
20	h_2 LSBs	h_{10} LSBs (center tap)
21	h_2 MSBs	h_{10} MSBs (center tap)
22	h_3 LSBs	unused
23	h_3 MSBs	
24	h_4 LSBs	
25	h_4 MSBs	
26	h_5 LSBs	
27	h_5 MSBs	
28	h_6 LSBs	
29	h_6 MSBs	
30	h_7 LSBs	
31	h_7 MSBs	

Coefficient h_0 is the first coefficient and coefficient h_{10} is the center coefficient of the filter's impulse response. The 16 bit 2's complement coefficients are stored in two bytes, least significant byte first, for example, the LSBs of coefficient 0 are stored in address 16 and the MSBs in address 17.

TO LOAD A COEFFICIENT THE USER MUST WRITE THE LSBYTE FIRST FOLLOWED BY THE MSBYTE. Unknown values will be written into the LSBs if the MSB is written first. The coefficient registers are read/write.

5.4 PFIR COEFFICIENT PAGES

The user programmable filter PFIR coefficients are stored using pages 2, 3, 4 and 5 for channel A, pages 10, 11, 12 and 13 for channel B, pages 18, 19, 20 and 21 for channel C, and pages 26, 27, 28 and 29 for channel D.

Table 14: PFIR Coefficient Pages

Address	Pages 2, 10, 18, or 26	Pages 3, 11, 19, or 27	Pages 4, 12, 20, or 28	Pages 5, 13, 21, or 29
	Description	Description	Description	Description
16	h_0 LSBs (end tap)	h_8 LSBs	h_{16} LSBs	h_{24} LSBs
17	h_0 MSBs (end tap)	h_8 MSBs	h_{16} MSBs	h_{24} MSBs
18	h_1 LSBs	h_9 LSBs	h_{17} LSBs	h_{25} LSBs
19	h_1 MSBs	h_9 MSBs	h_{17} MSBs	h_{25} MSBs
20	h_2 LSBs	h_{10} LSBs	h_{18} LSBs	h_{26} LSBs
21	h_2 MSBs	h_{10} MSBs	h_{18} MSBs	h_{26} MSBs
22	h_3 LSBs	h_{11} LSBs	h_{19} LSBs	h_{27} LSBs
23	h_3 MSBs	h_{11} MSBs	h_{19} MSBs	h_{27} MSBs
24	h_4 LSBs	h_{12} LSBs	h_{20} LSBs	h_{28} LSBs
25	h_4 MSBs	h_{12} MSBs	h_{20} MSBs	h_{28} MSBs
26	h_5 LSBs	h_{13} LSBs	h_{21} LSBs	h_{29} LSBs
27	h_5 MSBs	h_{13} MSBs	h_{21} MSBs	h_{29} MSBs
28	h_6 LSBs	h_{14} LSBs	h_{22} LSBs	h_{30} LSBs
29	h_6 MSBs	h_{14} MSBs	h_{22} MSBs	h_{30} MSBs
30	h_7 LSBs	h_{15} LSBs	h_{23} LSBs	h_{31} LSBs (center tap)
31	h_7 MSBs	h_{15} MSBs	h_{23} MSBs	h_{31} MSBs (center tap)

Coefficient h_0 is the first coefficient and coefficient h_{31} is the center coefficient of the filter's impulse response. The 16 bit 2's complement coefficients are stored in two bytes, least significant byte first, for example, the LSBs of coefficient 0 are stored in address 16 and the MSBs in address 17.

TO LOAD A COEFFICIENT THE USER MUST WRITE THE LSBYTE FIRST FOLLOWED BY THE MSBYTE. Unknown values will be written into the LSBs if the MSB is written first. The coefficient registers are read/write.

5.5 CHANNEL FREQUENCY PAGES

Pages 6, 14, 22, and 30 contain the phase and frequency control settings for the four channels. The frequency and phase for channel A are set in page 6. The frequency and phase for channel B are set in page 146. The frequency and phase for channel C are set in page 22. The frequency and phase for channel D are set in page 30. All registers are read/write.

ADDRESSES 16, 17: Phase

ADDRESS	TYPE	NAME	DESCRIPTION
16	R/W	PHASE[0:7]	Byte 0 (LSBs) of PHASE
17	R/W	PHASE[8:15]	Byte 1 (MSBs) of PHASE

The 16 bit phase offset is defined as:

$$\text{PHASE} = 2^{16}P/2\pi$$

where P is the desired phase in radian from 0 to 2π .

ADDRESSES 18, 19, 20, and 21: Frequency

ADDRESS	TYPE	NAME	DESCRIPTION
18	R/W	FREQ[0:7]	Byte 0 (LSBs) of FREQ
19	R/W	FREQ[8:15]	Byte 1 of FREQ
20	R/W	FREQ[16:23]	Byte 2 of FREQ
21	R/W	FREQ[24:31]	Byte 3 (MSBs) of FREQ

The 32 bit frequency control word is defined as:

$$\text{FREQ} = 2^{32}F/F_{\text{CK}}$$

where F is the desired tuning frequency and F_{CK} is the chip's clock rate (CK). Use positive frequency values to downconvert signals. Use negative frequency values to invert the signal's spectrum. The 32 bit 2's complement frequency words are entered as four bytes, the least significant byte in the lowest address, the most significant in the highest address.

5.6 CHANNEL CONTROL PAGES

These pages contain the various control settings for the four channels. To configure channels A, B, C and D use pages 7, 15, 23, and 31 respectively. All registers are read/write. The following table summarizes the registers:

Table 15: Channel Control Registers

ADDRESS	NAME	DESCRIPTION
16	Channel Reset	Resets the channel and sets SHIFT
17	Frequency Sync	Phase and Frequency syncs
18	NCO sync	NCO and dither syncs
19	Blank	Blank controls
20	Dec Sync	Synchronizes CIC decimation and flush
21,22	Decimation Ratio	Sets CIC decimation and sync for fine gain
23	CIC Scale	Sets CIC gain and MIX20B
24	SplitIQ	SplitIQ and negate control
25	CFIR	Quarter delays, Coarse, Nosym1
26	PFIR	Half delays, Nosym2
27	Input	Selects input format and port.
28	Peak Control	Controls peak and overflow detection counter
29	Peak Read	Number of peaks (overflows) during last sync period.
30,31	Fine Gain	Fine gain control

ADDRESS 16: **Channel Reset** Set to 0x80 on power up, Suggested default = 0x0C

BIT	TYPE	NAME	DESCRIPTION
0-2 (LSBs)	R/W	SHIFT	Value used to shift up the mixer output if USE_SHIFT is high. Note that if USE_SHIFT is high and MIX20B is set, then SHIFT is restricted to the range of 4-7.
3	R/W	USE_SHIFT	Selects SHIFT if high. If low the mixer output shift value is provided by the exponent bits of the floating point input format (see Section 3.2).
4-6	R/W	Unused	
7	R/W	CH_RESET	This bit resets the channel. If high, the channel is in a reset state with the clock disabled.

ADDRESS 17: **Frequency Sync**, Suggested default = 0x77

BIT	TYPE	NAME	DESCRIPTION
0-2 LSB	R/W	PHASE_SYNC	The new phase offset takes effect on this sync
3	R/W	Unused	
4-6	R/W	FREQ_SYNC	The new frequency setting takes effect on this sync.
7 MSB	R/W	Unused	

These syncs use the selections shown in Table 7.

The FREQ_SYNC and PHASE_SYNC are typically set to be “always” so that frequency and phase settings will take effect immediately as they are written into their control registers. Due to the asynchronous nature of the interface in this mode a few samples will be mixed with transient frequencies until the new frequency and phase values are established. If these transients are undesirable OR if the accumulated phase must be controlled, then another sync source should be used.

ADDRESS 18: NCO Sync, Suggested default = 0x22

BIT	TYPE	NAME	DESCRIPTION
0-2 LSB	R/W	NCO_SYNC	The NCO is initialized to the phase setting by this sync
3	R/W	Unused	
4-6	R/W	DITHER_SYNC	The dither circuit is reset by this sync to zero.
7 MSB	R/W	Unused	

These syncs use the selections shown in Table 7.

The NCO_SYNC can be changed to "SIB" so that the $\overline{\text{SIB}}$ sync can be used to synchronize the NCO phases of multiple channels or chips.

The DITHER_SYNC is used to turn on or off the dithering of the NCO phase. Dithering is turned on by setting DITHER_SYNC to "never". Dithering is turned off by setting DITHER_SYNC to "always" which causes it to remain reset to zero.

During diagnostics the NCO_SYNC and DITHER_SYNC should be set to "TC" (5).

If the user wishes to allow the chip to free run, asynchronous to other chips, then these sync settings can be set to "never".

ADDRESS 19: Zero Pad Mode Control Register, Suggested default = 0x20

BIT	TYPE	NAME	DESCRIPTION
0-3 LSB	R/W	NZEROS	The number of zeroes to insert between each sample in the blank mode. Ranges from 0 to 15. Note that this introduces a gain of $1/(NZEROS+1)$.
4-6	R/W	ZPAD_SYNC	The sync selection from Table 7 for the zero pad function (See Figure 5).
7 MSB	R/W	ZPAD_EN	Turn on zero padding for this channel.

ADDRESS 20: Dec and Flush Sync Register, Suggested default = 0x22

BIT	TYPE	NAME	DESCRIPTION
0-2 LSB	R/W	DEC_SYNC	Synchronizes the decimation control counter. The decimation counter controls the filtering of each channel.
3	R/W	Unused	
4-6	R/W	FLUSH_SYNC	Synchronizes the flush sync for this channel.
7 MSB	R/W	Unused	

The decimation counter sync (DEC_SYNC) may be periodic without interrupting processing so long as the sync period is a multiple of 8N. A decimation sync should be issued if the decimation control is changed.

Each channel should be flushed (FLUSH_SYNC) when the chip is being initialized or when the decimation control is changed. The flush lasts for 24N clocks after the sync occurs. The channel flush syncs will normally be left in a "never" mode. During diagnostics the channels will need to be flushed at the beginning of each sync cycle.

The user may wish to flush a channel when a new frequency is selected in order to purge the datapath of the last signal.

ADDRESS 21: Decimation Ratio Byte 0, Suggested default = 0x07

BIT	TYPE	NAME	DESCRIPTION
0-7	R/W	DEC[0:7]	The LSBs of the decimation control

ADDRESS 22: Decimation Ratio Byte 1, Suggested default = 0x70

BIT	TYPE	NAME	DESCRIPTION
0-3	R/W	DEC[8:11]	The 4 MSBs of the decimation control
4-6	R/W	GAIN_SYNC	The new fine gain takes effect on this sync.
7 MSB	R/W	Unused	

The CIC decimation is **N**. When processing in normal mode (not SPLITIQ) **DEC** should be set to **N-1** where **N** ranges from 8 to 4096. When processing in SPLITIQ mode **DEC** should be set to **2N-1** where **N** ranges from 4 to 2048.

ADDRESS 23: CIC Scale, Suggested default = 0x79

BIT	TYPE	NAME	DESCRIPTION
0-2	R/W	SCALE	SCALE ranges from 0 to 5.
3-5	R/W	BIG_SCALE	BIG_SCALE ranges from 0 to 7.
6	R/W	MIX20B	Round mixer output to 20 bits if MIX20B=1 or to 16 bits if MIX20B=0. If MIX20B=1 then SHIFT (see address 16) must be at least 4 to shift the extra 4 bottom bits into the datapath. For very large decimations (>3104) unity gain through the CIC can only be accomplished by using a smaller SHIFT and hence MIX20B must be zero. The default is MIX20B=1.
7	R/W	unused	

The CIC filter has a gain which is equal to N^5 . To remove this gain the CIC inputs are pre-scaled down by $(62 - \text{SHIFT} - \text{SCALE} - 6 \times \text{BIG_SCALE})$ bits before filtering. The values of SHIFT, SCALE and BIG_SCALE must be such that:

$$(\text{SHIFT} + \text{SCALE} + 6 \times \text{BIG_SCALE}) \leq (62 - 5\log_2 N + \log_2(\text{NZERO}+1))$$

Overflows due to improper gain settings will go undetected if this relationship is violated. For example, this restriction means that for N equal to 8, and SHIFT equal to 4, BIG_SCALE and SCALE should be less than or equal to 7 and 1 respectively.

ADDRESS 24: SplitIQ, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0-3	R/W	NEG_CTL	A four bit pattern that multiplies the output of PFIR by +/- 1. This is used to perform complex to real conversion (Fs/4 upconvert), flip the spectrum, or perform an Fs/2 frequency shift.
4	R/W	SPLITIQ	Process only the real data (at twice the throughput). Used to allow two channels to be ganged together for wider output bandwidth.
5	R/W	IONLY	All samples output by this channel are real. Used in the SPLITIQ mode to identify the channel generating the I-half of the complex output.
6	R/W	QONLY	All samples output by this channel are imaginary. Used in the SPLITIQ mode to identify the channel generating the I-half of the complex output. When performing complex to real conversion this bit must be set (amongst others).
7	R/W	Unused	

Sections 3.3 and 3.4 describe how to use these controls.

ADDRESS 25: CFIR, *Suggested default = 0x00*

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	NO_SYM_CFIR	When this bit is high, CFIR is an 11 tap asymmetric filter. Coefficient h_0 is multiplied by the newest data.
1	R/W	QDLY_CFIR	Delay the Q sample stream by one CFIR input sample. Effectively, this is a 1/4 sample delay of the output PFIR. Used in the multi-channel modes (see Section 3.4).
2	R/W	IDLY_CFIR	Delay the I-sample stream by one CFIR input sample. Effectively, this is a 1/4 sample delay of the output PFIR. Used in the multi-channel modes (see Section 3.4).
3	R/W	Unused	
4-6	R/W	COARSE	This introduces a gain of 2^{COARSE} after the CIC but before rounding to 20 bits to feed CFIR. This allows optimization of gain in applications where it is known that most of the signal energy presented to the A/D has been filtered out by the CIC. An example of such an application is an FDM stack.
7	R/W	TEST	Test mode. Should be set to 0.

ADDRESS 26: PFIR, *Suggested default = 0x00*

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	NO_SYM_PFIR	When this bit is high PFIR is an 32 tap asymmetric filter. Coefficient h_0 is multiplied by the newest data.
1	R/W	QDLY_PFIR	Delay the Q sample stream by one PFIR input sample. Effectively, this is a 1/2 sample delay of the output PFIR. Used in the real or multi-channel modes (see Sections 3.3 and 3.4).
2	R/W	IDLY_PFIR	Delay the I-sample stream by one PFIR input sample. Effectively, this is a 1/2 sample delay of the output PFIR. Used in the real or multi-channel modes (see Sections 3.3 and 3.4).
3-4	R/W	PEAK_SELECT	Select the overflow detection source for the peak counter. Only used if PEAK_MODE=1. Selects CFIR, COARSE_GAIN, or PFIR for values 0,1, or 2 respectively (the values 2 and 3 are the same). See address 28 below.
5-7	R/W	Unused	

ADDRESS 27: Input, *Suggested default = 0x00*

BIT	TYPE	NAME	DESCRIPTION
0-2 (LSBs)	R/W	INPUT_SEL	Selects which input port to use for this channel. Values 0-3 select inputs A-D respectively. Values 4 and 5 select differential inputs A and B. Values 6 and 7 select the internal diagnostic source (see general address 5). Note that for differential inputs one must also enable the differential receivers by setting the DIFF_IN bit in register 4.
3	R/W	SEL_AB	Selects the A/\bar{B} channel in the dual 12 bit plus exponent mode (INPUT_MODE=3). If SEL_AB is 0, then the samples with their A/\bar{B} flag low are used. If SEL_AB is high, then the samples with their A/\bar{B} flag high are used.
4-5	R/W	INPUT_MODE	Selects the input format: 0 is the 14 bit input mode, 1 is the 16 bit input mode, 2 is the 12 bit plus exponent mode, and 3 is the dual 12 bit plus exponent mode.
6	R/W	Unused	
7 MSB	R/W	MSB_POL	Invert the MSB polarity. This will convert an offset binary formatted input to 2's complement format.

ADDRESS 28: Peak Control, Suggested default = 0x1D

BIT	TYPE	NAME	DESCRIPTION
0-2 LSB	R/W	PEAK_SYNC	Synchronizes the peak counter circuitry using the mode selected in Table 7. When the selected sync occurs, the counter transfers its contents to a read only control register and clears the counter.
3-4	R/W	PEAK_THRESHOLD	When the input peak detect mode is selected (PEAK_MODE=0), the input word is checked against a threshold. The threshold values are 1/4, 1/2, 3/4, or 4/4 (full scale) for PEAK_THRESH= 0,1,2, or 3 respectively. The absolute value of the top 11 bits is compared to the selected threshold. This is only used when the PEAK_MODE is zero.
5	R/W	PEAK_MODE	If PEAK_MODE is zero, the input word is selected as the source to the peak counter, otherwise one of three overflow bits (see PEAK_SELECT at address 26) is monitored by the peak counter.
6-7	R/W	Unused	

ADDRESS 29: Peak Count, Read only

BIT	TYPE	NAME	DESCRIPTION
0-7	R	PEAK_COUNT	Count of number of overflows or samples above threshold during last sync period. The counter hard-limits at 255.

ADDRESS 30: Fine Gain Byte 0, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0-7	R/W	FINE_GAIN[0:7]	The LSBs of the fine gain control

ADDRESS 31: Fine Gain Byte 1, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0-5	R/W	FINE_GAIN[8:13]	The MSBs of the fine gain control
6-7 MSB	R/W	Unused	

The fine gain control can apply a gain of FINE_GAIN/1024 providing a range of 0 to almost 16. Double buffering and synchronization for data transfer is provided to allow the user to change the gain dynamically without causing glitches in the signal (See GAIN_SYNC in address 22). This also allows the user to synchronously change gain in multiple channels even across different chips.

5.8 RESAMPLER CONTROL PAGE (PAGE 64)

This page controls the resampler. The address assignments are:

Table 17: Resampler Control Registers

ADDRESS	NAME	DESCRIPTION
16	N-channels	Sets the number of channels and filters
17	N-Multiplies	Sets the number of multiplies per output
18	Filter Select	Maps channels to filter sets
19	Final Shift	Sets the final gain shift
20	Channel Map	Maps channels to outputs
21	Add To	Adds channel outputs together
22	Clock Divide	Divides the clock to the resampler
23	Ratio Map	Maps ratios to output channels
24-31	Unused	

ADDRESS 16: N-Channels Out Register, Suggested default = 0x23

BIT	TYPE	NAME	DESCRIPTION
0-1 LSB	R/W	NC	Must be set to $NC=NCHAN-1$, where NCHAN is the number of output channels to be generated. A value of $NC=0$ means one output channel. A value of $NC=1$ means two output channels. Use a value of $NC=3$ for either three or four output channels. A value of 2 is illegal and will produce erroneous results.
2-3	R/W	NF	Must be set to $NF=NFILTER-1$, where NFILTER is the number of resampler filters. Used to partition the resampler coefficient RAM. A value of $NF=0$ means one filter (normal case). A value of $NF=1$ means two filters. A value of $NF=3$ means four filters. A value of 2 is illegal.
4-6	R/W	RES_SYNC	The resampler is synchronized to this sync source (See Table 7). Resets the delay accumulators in all channels at the same time.
7 MSB	R/W	Unused	

ADDRESS 17: N-Multiplies Register, Suggested default = 0x0E

BIT	TYPE	NAME	DESCRIPTION
0-5 LSB	R/W	NM	Must be set to $NM=NMULT-1$, where NMULT is the number of resampler multiplies. The minimum legal value is $NM=5$, the maximum is $NM=63$ but typically the maximum will be set by other constraints (see Section 3.5). In the case of a single channel output the minimum value is $NM=6$.
6	R/W	NO_SYM_RES	The resampler filter is presumed to be symmetric unless this bit is set.
7 MSB	R/W	Unused	

ADDRESS 18: Filter Select Register, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0-1 LSB	R/W	FILTER_SEL_0	The filter map for output channel 0. This select which of the NFILTER filters to use for this channel. Must be less than or equal to NFILTER
2-3	R/W	FILTER_SEL_1	The filter map for output channel 1.
4-5	R/W	FILTER_SEL_2	The filter map for output channel 2.
6-7 MSB	R/W	FILTER_SEL_3	The filter map for output channel 3.

ADDRESS 19: Final Shift Register, Suggested default = 0x34

BIT	TYPE	NAME	DESCRIPTION
0-3 LSB	R/W	FINAL_SHIFT	The final shift up applied to all output channels before rounding and outputting. Legal values are 0-15.
4-5	R/W	ROUND	Round the output to 12 (ROUND=0), 16 (ROUND=1), 20 bits (ROUND=2) or 24 bits (ROUND=3). Note, the data is output from the resampler in all cases as 24 bit words. Rounding is into the MSBs, unused LSBs of the 24 bit output words are not cleared. The chip's output word size is set by BITS_PER_WORD in the output page, not by ROUND.
6	R/W	TAG_22	Two bit tag mode. Replaces the 2 LSBs of the 24 bit resampler output word with the 2 LSBs of the tag words. Changes the 24 bit round mode (ROUND=3), if it is used, to be a 22 bit round mode.
7 (MSB)	R/W	Unused	

ADDRESS 20: Channel Map Register, Suggested default = 0xE4

BIT	TYPE	NAME	DESCRIPTION
0-1 LSB	R/W	CHAN_MAP_A	The channel map for channel A. This tells the hardware which output channel the results of down converter channel A should be directed to.
2-3	R/W	CHAN_MAP_B	The channel map for down converter channel B.
4-5	R/W	CHAN_MAP_C	The channel map for down converter channel C.
6-7 MSB	R/W	CHAN_MAP_D	The channel map for down converter channel D.

This register maps down converter channels to output (resampler) channels. For most applications this will be a simple map of channel A to output channel 0, channel B to output channel 1, etc. However, for multichannel modes (see Section 3.4) such as SPLITIQ two or even four channels may be directed to the same output channel.

ADDRESS 21: Add-To Register, Suggested default = 0x70

BIT	TYPE	NAME	DESCRIPTION
0 LSB	R/W	ADD_A_TO_B	Add down converter channel A to down converter channel B.
1	R/W	ADD_B_TO_C	Add down converter channel B to down converter channel C.
2	R/W	ADD_C_TO_D	Add down converter channel C to down converter channel D.
3	R/W	ADD_D_TO_NEXT_A	Not useful. Must be set to zero.
4-6	R/W	RATIO_SYNC	Changes to the ratio map (address 23) are synchronized to this sync source.
7 MSB	R/W	Unused	

When processing complex input signals partial results are computed in adjacent channels that must be summed together to produce a meaningful result. This control bit informs the resampler to save the data presented to it's input and add it to the next sample presented (if the chip is properly set up this will be from the next channel). In this manner the real and imaginary portions of the input are rejoined prior to resampling.

ADDRESS 22: Resampler Clock Divide Register, Suggested default = 0x00

BIT	TYPE	NAME	DESCRIPTION
0-7	R/W	RES_CLK_DIV	Resampler clock division.

In many applications only a small portion of the resampler computational throughput is required. Power can be reduced by dividing the clock driving the resampler. The resampler clock rate is $2 * F_{CK} / (1 + RES_CLK_DIV)$. Caution must be used to avoid

dividing the clock so far that there is not enough clock cycles to complete the computations (see Section 3.5). It is recommended that an application first be brought up without resampler clock division.

ADDRESS 23: **Ratio Map Register** *Suggested default = 0x00*

BIT	TYPE	NAME	DESCRIPTION
0-1 LSB	R/W	RATIO_MAP_0	The ratio map for channel 0. This tells the hardware which resampler ratio should be use for output channel 0.
2-3	R/W	RATIO_MAP_1	The ratio map for output channel 1.
4-5	R/W	RATIO_MAP_2	The ratio map for output channel 2.
6-7 MSB	R/W	RATIO_MAP_3	The ratio map for output channel 3.

The default ratio maps select ratio 0 for output 0, ratio 1 for output 1, ratio 2 for output 2, and ratio 3 for output 3. The ratio maps can also be used to synchronously switch between resampling ratios. This allows the chip's resampler to be used in timing loops where the ratio must toggle between several values which have been programmed into the chip.

5.9 RESAMPLER RATIO PAGE (PAGE 65)

This page stores four resampler ratios to be used by the resampler channels. Each ratio is a 32 bit ratio of the input sample rate to the output sample rate with an implicit decimal point six bits down from the top. The total range for the ratio is then 0 to 63. The hardware limits the decimation to be less than 32 (hence the MSB of the 32 bit word should always be zero).

Table 18: Resampler Ratio Page

ADDRESS	NAME	ADDRESS	NAME
16	RATIO_0 (LSBs)	24	RATIO_2 (LSBs)
17	RATIO_0	25	RATIO_2
18	RATIO_0	26	RATIO_2
19	RATIO_0 (MSBs)	27	RATIO_2 (MSBs)
20	RATIO_1 (LSBs)	28	RATIO_3 (LSBs)
21	RATIO_1	29	RATIO_3
22	RATIO_1	30	RATIO_3
23	RATIO_1 (MSBs)	31	RATIO_3 (MSBs)

5.10 CHANNEL OUTPUT PAGES (PAGE 96 & 97)

Addresses 16 through 31 on these pages are used to read output values. The outputs are 24 bit two's complement numbers which are read as three 8 bit bytes. Reading address 16 will output 0 on C[0:7]. Reading address 17 will output the least significant byte. Address 18 provides the middle byte. Address 19 provides the most significant byte. If microprocessor mode is enabled, and pin P0-23 are enabled (by setting EN_P0-3, EN_PAR) the full 24 bit word is simultaneously output P[0:23]. These are all read only registers.

See Tables 4, 5 and 6 for the data order in these pages.

5.11 OUTPUT CONTROL PAGE (PAGE 98)

This page controls the output. The following table summarizes the registers:

Table 19: Output Control Registers

ADDRESS	NAME	DESCRIPTION
16	Tristate Controls	Enables serial and parallel ports and controls.
17	Output Format	Sync output. Invert SCK, SFS, and RDY. Set RDY width. Enable tags.
18	Output Mode	Select serial, nibble, parallel, or uP output. Select real or complex output. Enable nibble reverse.
19	Output Frame Control	Select output frame length. Control SFS behavior.
20	Output Word Sizes	Select output word size, output block size, and word per frame.
21	Output Clock Control	Set clock divider for serial clock. Set number of active serial outputs.
22	Serial Mux Control	Route serial streams to serial ports.
23	Output Tag A	Tags for outputs AI and AQ
24	Output Tag B	Tags for outputs BI and BQ
25	Output Tag C	Tags for outputs CI and CQ
26	Output Tag D	Tags for outputs DI and DQ
27	Mask Revision	Reads back the chip's mask revision number
28	Miscellaneous	Output enable for \overline{SO} , four frame strobe mode control

ADDRESS 16: **Tristate Controls**, Cleared on power up, Suggested default = (see Table 3)

BIT	TYPE	NAME	DESCRIPTION
0 (LSB)	R/W	EN_SCK	Enable SCK output. Used in serial, nibble, LINK, and parallel modes.
1	R/W	EN_RDY	Enable RDY output. Used for parallel and uP modes. RDY should be enabled for the master chip in serial or nibble TDM modes. RDY should not be enabled for slave chips, or for the LINK mode.
2	R/W	EN_SFS	Enable SFS output. Used in serial, nibble, and parallel modes. Can be used as an interrupt in LINK mode.
3	R/W	EN_P0	Enable P0. Required for serial mode when outputting on P0, LINK or Nibble modes, wide word uP, and parallel modes.
4	R/W	EN_P1	Enable P1. Required for serial mode when outputting on P1, LINK or Nibble modes, wide word uP, and parallel modes.
5	R/W	EN_P2	Enable P2. Required for serial mode when outputting on P2, LINK or Nibble modes, wide word uP, and parallel modes.
6	R/W	EN_P3	Enable P3. Required for serial mode when outputting on P3, LINK or Nibble modes, wide word uP, and parallel modes.
7 (MSB)	R/W	EN_PAR	Enable P4-P23. Used for parallel output and wideword uP modes.

All outputs except \overline{SO} and the control port (C0-7) power up into a high impedance, tristate, mode until they are enabled. The control port (C0-7) is tristate until both \overline{CE} and \overline{RD} are low and \overline{WR} is high.

ADDRESS 17: Output Format, *Suggested default = 0x40*

BIT	TYPE	NAME	DESCRIPTION
0 (LSB)	R/W	INV_SCK	Invert SCK output. The serial, nibble, link and parallel outputs normally change on the rising edge of SCK. If INV_SCK is set high the clock is inverted so data changes on the falling edge.
1	R/W	INV_RDY	Invert RDY output. RDY is normally active high. This control bit is used for uP and parallel modes. It has no effect in serial, LINK, or nibble modes.
2	R/W	INV_SFS	Invert SFS output. SFS is normally active high.
3	R/W	TAG_EN	Enable tags. The four bit tags replace the four LSBs of the data when TAG_EN is set. The BITS_PER_WORD (address 20) control determines the tag location.
4	R/W	RDY_WIDTH	The RDY pulse is 4 (RDY_WIDTH=0) or 16 (RDY_WIDTH=1) CK cycles. Valid for the uP mode only, must be set to 0 for all other modes.
5-7 (MSB)	R/W	OUT_BLK_SYNC	Output circuit sync source. See table 7 for the sync modes. The OUT_BLK_SYNC is used to synchronize the output timing among multiple GC4016 chips. The OUT_BLK_SYNC should only be made active during initialization. Use during operation may cause unknown output transients.

ADDRESS 18: Output Mode *Cleared on powerup., Suggested default = (see Table 3)*

BIT	TYPE	NAME	DESCRIPTION
0 (LSB)	R/W	LINK	Enable LINK protocol. This mode supports Analog Devices LINK protocol. In this mode the RDY pin serves as LINK Acknowledge and is an input to the GC4016 (EN_RDY must be low). NIBBLE must also be set high (eight bit LINK mode is not supported) and OUTPUT_MODE must be set to 2. The PARALLEL control bit must be low.
1	R/W	NIBBLE	Enable nibble mode. This mode is similar to serial except the four pins P0-3 output one nibble at a time. TDM of several chips is supported with one acting as the master (EN_RDY=MASTER=1) and the others as the slave (EN_RDY=MASTER=0).
2	R/W	PARALLEL	Enable parallel mode.
3	R/W	MASTER	Normally set high. Is set low by slave chips in TDM serial or nibble modes. The RDY pin is an output when MASTER=1, and is an input when MASTER=0.
4	R/W	REAL_ONLY	Normally set low. Is set high when outputting real, instead of complex, data. Normally used with the complex to real modes of the PFIR (see Section 3.3.7).
5-6	R/W	OUTPUT_MODE	The output mode selection is: 0 for microprocessor mode, 1 for serial mode, 2 for nibble or LINK modes, or 3 for parallel mode. Note that only one mode is supported at a time.
7 (MSB)	R/W	REVERSE_IQ	Used when OUTPUT_ORDER=0 to swap I and Q. This is useful for link or nibble mode outputs when packing two 16 bit words into a 32 bit transfer. See Section 3.8.5.

ADDRESS 19: Output Frame Control, Suggested default = (see Table 3)

BIT	TYPE	NAME	DESCRIPTION
0-5 (LSB)	R/W	FRAME_LENGTH	<p>Used in the serial and nibble modes to set the frame length, and is not used in the microprocessor, link or parallel modes.</p> <p>Serial, nibble modes: The output frame length is (FRAME_LENGTH+1) in words (not complex pairs). The frame length must be equal or greater than the number of output words on the serial port. Values larger than the number of output words can be useful to smooth the data output rate by slowing down the output frame rate. The output frame rate must be at least as fast as the average output data rate.</p> <p>In the 16 bit nibble mode (BITS_PER_WORD=0), FRAME_LENGTH must be greater than or equal to one (a frame length of at least two words).</p> <p>If this is the master chip in a multi-chip TDM mode (FRAME_LENGTH+1) sets the TDM frame length. The master chip will occupy the first (WORDS_PER_FRAME+1) time slots of the frame.</p> <p>If this is a slave chip, then (FRAME_LENGTH+1) is the delay, in number of words, from the start of frame before outputting its data.</p> <p>Microprocessor, link or parallel modes: Unused, set to 0</p>
6-7 (MSB)	R/W	SFS_MODE	<p>Used in the serial, nibble and parallel modes to set the frame strobe modes. Not used in the microprocessor or link modes.</p> <p>Serial mode: (See Figure 15) In the serial mode SFS is active for one SCK cycle ahead of the first bit.</p> <p>If SFS_MODE=0 (or = 2), then SFS is active for one SCK cycle at the start of the frame.</p> <p>If SFS_MODE=1, then SFS is active once for each I word.</p> <p>If SFC=3 then SFS is active for each word (I or Q).</p> <p>Link mode: The SFS behavior in the nibble mode is similar except the frame strobe occurs concurrent with the first nibble rather than 1 SCK cycle early.</p> <p>Parallel mode: (See Figure 16) In the parallel mode, SFS and RDY are used as flags to indicate valid output data.</p> <p>If SFS_MODE=0 or 1, then SFS is active for one SCK cycle when the I sample is valid and RDY is active for one SCK cycle when Q is valid.</p> <p>If SFS_MODE=2 or 3, then SFS is active for one SCK cycle when either I or Q are valid and RDY is a start of frame signal which is active for when the first I sample of an output block is valid (see BLOCK_SIZE address 20 and Figure 16). Note that when SFS_MODE=2 or 3 the RDY flag goes high after the last word in a frame and goes low after the first word in the next frame.</p> <p>Microprocessor or link modes: Unused, set to 0</p>

ADDRESS 20: Output Word Sizes, Suggested default = (see Table 3)

BIT	TYPE	NAME	DESCRIPTION
0-2 (LSB)	R/W	WORDS_PER_FRAME	<p>Serial, nibble and parallel modes: The number of output words (not complex pairs) in a frame is (WORDS_PER_FRAME+1). This value should be less than or equal to the frame length. It should also be less than or equal to the number of output channels.</p> <p>Serial or nibble TDM modes: (WORDS_PER_FRAME+1) is the number of words THIS chip inserts into the TDM stream.</p> <p>Link mode: In the link mode only 32 bit transfers are understood. A single 32 bit word is transferred by setting WORDS_PER_FRAME to 0 and BITS_PER_WORD to 1. Two 16 bit words packed together in a single 32 bit transfer is done by setting WORDS_PER_FRAME to 1 and BITS_PER_WORD to 0.</p> <p>Microprocessor mode: Unused, set to 0.</p>
3-5	R/W	BITS_PER_WORD	<p>Sets the number of bits per word in the serial, nibble and link modes and determines the location of tag bits in all modes.</p> <p>Serial mode: For serial outputs the number of bits per serial word is set as $4*(BITS_PER_WORD+1)$, where BITS_PER_WORD ranges from 2 to 7. Values 2-5 create 12-24 bit serial outputs with tags (if enabled) in the least significant nibble. Values 6 and 7 create 28 and 32 bit outputs respectively with the last one or two nibbles zeros and tags in the sixth nibble.</p> <p>Nibble and link modes: For nibble and link modes the number of bits per word are 16 for BITS_PER_WORD=0 and 32 for BITS_PER_WORD=1. Tag bits replace the least significant nibble when BITS_PER_WORD=0, and replace the sixth nibble when BITS_PER_WORD=1. The least significant two nibbles are always zero when BITS_PER_WORD=1.</p> <p>Parallel or microprocessor modes: For parallel or uP outputs BITS_PER_WORD only affects the placement of the tag bits. The least significant four bits of the $4*(BITS_PER_WORD+1)$ bits are replaced. BITS_PER_WORD ranges from 2 to 5 in these modes.</p> <p>Note that rounding is independent and is controlled by the ROUND control in address 19 of the resampler control page.</p>
6-7 (MSB)	R/W	BLOCK_SIZE	<p>Outputs are transferred from the resampler to the output in blocks of size (BLOCK_SIZE+1) complex samples (two words per sample). Values 0,1, and 3 are valid. Value 2 is mapped to be the same as 3.</p> <p>Synchronous serial, nibble and parallel modes: For synchronous serial, nibble and parallel outputs the block size will typically match the number of output channels.</p> <p>Link mode and asynchronous serial, nibble and parallel modes: For link and asynchronous outputs the block size should be minimum (BLOCK_SIZE=0).</p> <p>Microprocessor mode: For the microprocessor modes the BLOCK_SIZE should be 3 which will minimize the interrupt rate to one interrupt per 4 samples (real or complex).</p>

ADDRESS 21: Output Clock Control, Suggested default = (see Table 3)

BIT	TYPE	NAME	DESCRIPTION
0-3 (LSB)	R/W	SCK_RATE	Serial clock rate is $SCK = CK/(1+SCK_RATE)$. SCK_RATE can be 0 to 15. If SCK_RATE=0, then the serial clock rate will be equal to CK. SCK is also the output clock for nibble and parallel modes.
4-5	R/W	NSERIAL	The number of serial pins used to output the data is NSERIAL+1. Values 0,1, and 3 are valid (value 2 is mapped to be the same as value 3). A value of 0 means that all outputs will be multiplexed onto one serial stream. See Figure 15(c). Must be 0 for nibble, and link modes. Unused for uP, and parallel modes.
6-7 (MSB)	R/W	OUTPUT_ORDER	OUTPUT_ORDER is normally set to 0 which will cause the data to be output in the same order as it is computed by the resampler. If the channels are synchronous, then the order will be IA,QA,IB,QB,IC,QC,ID,QD. OUTPUT_ORDER must be set to 0 for asynchronous data. OUTPUT_ORDER equal to 1 or 2 is only valid for synchronous channel data. These modes allow channels B, C and D to be powered up and down without disturbing the channel order. Channel A can not be powered down. OUTPUT_ORDER=1 will cause the output order to be IA,IB,QA,QB,IC,ID,QC,QD. This is appropriate for complex synchronous serial data output on two streams. OUTPUT_ORDER=2 (or 3) will cause the output order to be IA,IB,IC,ID,QA,QB,QC,QD. This is appropriate for synchronous serial data output on four 4 serial streams. See Figure 15(c).

ADDRESS 22: Serial Mux Control, Suggested default = 0xE4

BIT	TYPE	NAME	DESCRIPTION
0-1 (LSB)	R/W	SMUX_0	Serial stream selection for serial pin P0. A four to one multiplexer allows serial streams SOUTA (SMUX_0=0), SOUTB (SMUX_0=1), SOUTC (SMUX_0=2) and SOUTD (SMUX_0=3) to be routed to serial pin P0. See Figure 15 for the definition of serial streams SOUTA, SOUTB, SOUTC and SOUTD. If SMUX_0 is set to 1 in the LINK or NIBBLE output modes then the bit order within the nibble is reversed (nibble LSB will be on P3 rather than P0). This allows backwards compatibility with the GC4014 in LINK mode.
2-3	R/W	SMUX_1	Serial stream selection for serial pin P1 as above. Note that the same serial stream may be routed to more than one serial pin if desired.
4-5	R/W	SMUX_2	Serial stream selection for serial pin P2.
6-7 (MSB)	R/W	SMUX_3	Serial stream selection for serial pin P3.

ADDRESS 23: Output Tag A, Suggested default = 0x10

BIT	TYPE	NAME	DESCRIPTION
0-3 (LSB)	R/W	TAG_AI	Four bit tag for serial stream A, I word.
4-7 (MSB)	R/W	TAG_AQ	Four bit tag for serial stream A, Q word.

ADDRESS 24: Output Tag B, Suggested default = 0x32

BIT	TYPE	NAME	DESCRIPTION
0-3 (LSB)	R/W	TAG_BI	Four bit tag for serial stream B, I word.
4-7 (MSB)	R/W	TAG_BQ	Four bit tag for serial stream B, Q word.

ADDRESS 25: Output Tag C, Suggested default = 0x54

BIT	TYPE	NAME	DESCRIPTION
0-3 (LSB)	R/W	TAG_CI	Four bit tag for serial stream C, I word.
4-7 (MSB)	R/W	TAG_CQ	Four bit tag for serial stream C, Q word.

ADDRESS 26 Output Tag D, Suggested default = 0x76

BIT	TYPE	NAME	DESCRIPTION
0-3 (LSB)	R/W	TAG_DI	Four bit tag for serial stream D, I word.
4-7 (MSB)	R/W	TAG_DQ	Four bit tag for serial stream D, Q word.

Note: in the real output mode (REAL_ONLY=1), only the Q tags will be used.

ADDRESS 27: Mask Revision, Read Only

BIT	TYPE	NAME	DESCRIPTION
0-7	R	REVISION	Mask revision number.

This address allows the user to read the current mask revision code from software. See Section 3.16 for details.

ADDRESS 28 Miscellaneous Controls, Suggested default = 0x02, Cleared by power up.

BIT	TYPE	NAME	DESCRIPTION
0 (LSB)	R/W	EN_4_FS	Enables the four frame strobe mode. The four frame strobe mode is used with asynchronous serial or nibble data to identify words from each channel. TAG_22 in address 19 of the resampler control page must also be set. The two LSBs of the tag words are used to generate the frame strobes. The output timing of the frame strobes are the same as for SFS. If the Tag is 0, then a copy of SFS is output as FSA, if the tag is 1, then a copy of SFS is output on FSB, if the tag is 2 then a copy of SFS is output on FSC, and if the tag is 3, then a copy of SFS is output on FSD.
1	R/W	EN_SO	The output enable control for \overline{SO}
3-7 (MSB)	R/W	unused	

THIS PAGE IS INTENTIONALLY BLANK

6.0 SPECIFICATIONS

6.1 ABSOLUTE MAXIMUM RATINGS

Table 20: Absolute Maximum Ratings

CAUTION: Exceeding the absolute maximum ratings (min or max) may cause permanent damage to the part. These are stress only ratings and are not intended for operation.

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Pad Ring Supply Voltage	V _{PAD}	-0.3	4.1	V	
Core Supply Voltage	V _{CORE}	-0.3	3.0	V	
Input voltage (undershoot and overshoot)	V _{IN}	-0.5	V _{PAD} +0.5	V	
Storage Temperature	T _{STG}	-65	150	°C	
Junction Temperature under operation	T _J		125	°C	1
Lead Soldering Temperature (10 seconds)			300	°C	
ESD Classification	Class 3A Human Body Model (4 kV) (JESD22-A114-B) Class 4 Charged Device Model (1 kV) (JESD22-C101-A)				
Moisture Sensitivity	Class 2				

1. The circuit is designed for junction temperatures up to 125C. Sustained operation above 125C junction temperature will reduce long term reliability.

6.2 RECOMMENDED OPERATING CONDITIONS

Table 21: Recommended Operating Conditions

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Pad Ring Supply Voltage	V _{PAD}	3.0	3.6	V	1
Core Supply Voltage	V _{CORE}	2.3	2.7	V	1
Temperature Ambient, no air flow	T _A	-40	+85	°C	1
Junction Temperature	T _J		100	°C	2

1. DC and AC specifications in Tables 23 and 24 are production tested over these ranges.

2. Thermal management may be required for full rate operation, See Table 22 below and Section 7.4.

6.3 THERMAL CHARACTERISTICS

Table 22: Thermal Data

THERMAL CONDUCTIVITY	SYMBOL	160 PBGA		UNITS
		0.5 Watt	1 Watt	
Theta Junction to Ambient	θ _{JA}	TBD: Estimated at 32		°C/W
Theta Junction to Case	θ _{JC}	TBD	TBD	°C/W

Note: Air flow will reduce θ_{ja} and is highly recommended.

6.4 POWER CONSUMPTION

The maximum power consumption is a function of the operating mode of the chip. The following equation estimates the typical power supply current for the chip. Chip to chip variation is typically +/- 5%. Table 24 provides maximum current in a maximum configuration used in production test.

$$I_{PAD} (TYP) = (V_{PAD}) \left(\frac{F_{out}}{4} \right) (N_{out}) (C_{out} + 2pF)$$

$$I_{CORE} (TYP) = \left(\frac{V_{CORE}}{2.5} \right) \left(\frac{F_{CK}}{80M} \right) \left[10 + A \left(31 + \frac{225}{N} \right) + \frac{23}{R} \right] mA$$

Where A is the number of active channels (0 to 4), N is the CIC decimation ratio, R is the resampler clock division, Fout is the output SCK rate, Nout is the number of active output data pins

, and Cout is the average capacitive load on each data pin. The equation assumes random data transition density of 1 rising edge per four SCK cycles.

6.5 DC CHARACTERISTICS

Table 23: DC Operating Conditions (-40 to 85°C case unless noted)

PARAMETER	SYMBOL	V _{PAD} = 3.0 to 3.6V		UNITS	TEST LEVEL
		MIN	MAX		
Voltage input low	V _{IL}		0.8	V	IV
Voltage input high	V _{IH}	2.0		V	IV
Voltage output low (I _{OL} = 2mA)	V _{OL}		0.5	V	IV
Voltage output high (I _{OH} = -2mA)	V _{OH}	2.4		V	IV
Leakage current (V _{IN} = 0V or V _{PAD}) Inputs or Outputs in tristate condition	I _{IN}		1	uA	IV
Pullup current (V _{IN} = 0V) (TDI, TMS, TCK)	I _{PU}	5	35	uA	IV
Quiescent supply current, I _{CORE} or I _{PAD} (V _{IN} =0 or V _{IN} =V _{PAD} , Address 0 = F0, DIFF_IN=0)	I _{CCQ}		2	mA	IV
Data input capacitance (All inputs except CK)	C _{IN}	4 (typical)		pF	I
Clock input capacitance (CK input)	C _{CK}	13 (typical)		pF	I

Notes:

Currents are measured at nominal voltages, high temperature (85C).
Voltages are measured at low speed. Output voltages are measured with the indicated current load

Test Levels:

- I. Controlled by design and process and not directly tested or recommended practice.
- II. Verified on initial part evaluation.
- III. 100% tested at room temperature, sample tested at hot and cold.
- IV. 100% tested at hot, sample tested cold.
- V. 100% tested at hot and cold.

6.6 AC CHARACTERISTICS

Table 24: AC Characteristics (-40 TO +85°C Case, across recommended voltage range, unless noted)

PARAMETER	SYMBOL	MIN	MAX	UNITS	TEST LEVEL
Clock Frequency	F_{CK}	Note 1	100	MHz	IV
Clock low or high period	$t_{CKL/H}$	3		ns	IV
Clock Duty Cycle (t_{CKH} as a percentage of the clock period)			70	%	II
Clock rise and fall times (V_{IL} to V_{IH})	t_{RF}		2	ns	I
Input setup before CK goes high (AIN , BIN , CIN , DIN , or SI) Single ended	t_{SU}	2		ns	IV
Input hold time after CK goes high	t_{HD}	0.8		ns	IV
Data output delay from rising edge of CK . (P[0:23] , SFS , SCK , RDY , or SO)	t_{DLY}	1	5	ns	IV
Data output skew from rising edge of SCK . (P[0:23] , SFS , or RDY)	t_{SKEW}	-2.5	2.5	ns	IV
JTAG Clock Frequency	F_{JCK}		40	MHz	IV
JTAG Clock low period (Below V_{IL})	t_{JCKL}	10		ns	IV
JTAG Clock high period (Above V_{IH})	t_{JCKH}	10		ns	IV
JTAG Input (TDI or TMS) setup before TCK goes high	t_{JSU}	1		ns	IV
JTAG Input (TDI or TMS) hold time after TCK goes high	t_{HD}	10		ns	IV
JTAG output (TDO) delay from rising edge of TCK .	t_{DLY}		10	ns	IV
Control setup during reads or writes. See Figures 2 and 3.	t_{CSU}	2		ns	IV
Control data setup during writes (edge mode). See Figure 3.	t_{EWCSU}	4		ns	IV
Control hold during writes. See Figures 2 and 3.	t_{CHD}	1		ns	IV
Control strobe (CS and WR low) pulse width (Write operation). See Figures 2 and 3.	t_{CSPW}	20		ns	IV
Control output delay CS and RD low and A stable to C (Read Operation). See Figures 2 and 3.	t_{CDLY}		12	ns	IV
Control recovery time between reads or writes. See Figures 2 and 3.	t_{REC}		20	ns	I
Core dynamic supply current nominal voltages, 100 MHz, 4 channels active, resampler at full speed, high temperature.	I_{CDYN}	100	390	mA	IV

Notes:

1. The minimum clock rate must satisfy $F_{CK}/(4N) > 10\text{KHz}$, where N is the CIC decimation ratio.
2. Timing between signals is measured from mid-voltage ($V_{PAD}/2$) to mid-voltage. Output loading is a 50 Ohm transmission line.

Test Levels:

- I. Controlled by design and process and not directly tested or recommended practice.
- II. Verified on initial part evaluation.
- III. 100% tested at room temperature, sample tested at hot and cold.
- IV. 100% tested at hot, sample tested cold.
- V. 100% tested at hot and cold.

7.0 APPLICATION NOTES

7.1 POWER AND GROUND CONNECTIONS

The GC4016 chips are very high performance chips which require solid power and ground connections to avoid noise on the V_{CORE} , V_{PAD} and GND pins. If possible the GC4016 chip should be mounted on a circuit board with dedicated power and ground planes and with at least two decoupling capacitors (0.01 μ f) adjacent to each side of the chip, one for V_{CORE} and one for V_{PAD} .

IMPORTANT

THE GC4016 CHIP MAY NOT OPERATE PROPERLY IF THESE POWER AND GROUND GUIDELINES ARE VIOLATED.

7.2 STATIC SENSITIVE DEVICE

The GC4016 chips are fabricated in a high performance CMOS process which is sensitive to the high voltage transients caused by static electricity. These parts can be permanently damaged by static electricity and should only be handled in static free environments. See Table 20.

7.3 MOISTURE SENSITIVE PACKAGE

The GC4016 come in level 2 moisture sensitive packages. Dry pack storage is required prior to assembly. If parts are stored out of dry pack for more than 72 hours, then parts must be baked for 24 hours at 100 $^{\circ}$ C prior to assembly.

7.4 THERMAL MANAGEMENT

The parameters in Section 6.0 are tested at a case temperature of 100 $^{\circ}$ C. In any case, the junction temperature must be kept below 125 $^{\circ}$ C for reliable operation. To determine the junction temperature, the user should calculate the chip's power dissipation using the equation for supply current in Section 6.4 and then use the package's thermal conductivity shown in Section 6.3. The junction temperature is calculated by adding the operating ambient temperature (or case temperature) to the product of the power consumption times the thermal conductivity.

For example, the GC4016 chip operating in the GSM mode described in Section 7.9, consumes 0.3 Watts of power. The junction to ambient rise of the PBGA160 package is 32 degrees (TBD) per Watt. This represents a rise of 10 degrees over ambient. This means that under these conditions the ambient temperature has to be less than 90 $^{\circ}$ C to keep the junction temperature below 100 $^{\circ}$ C. Air flow will decrease the thermal resistance by 10% to 40%, allowing ambient temperatures up to 96 $^{\circ}$ C. Increasing the decimation ratio (N) or decreasing the number of active channels (A) will also allow a higher ambient temperature.

7.5 EXAMPLE CFIR FILTER SETS

The CFIR filter must be flat over the output passband of interest, and have a stopband which rejects out of band signals which will fall into the passband of interest. The spectral requirements of this filter are shown in Figure 10 in Section 3.3.5. The CFIR filter must also compensate for the passband roll off of the CIC filter. The following filters compensate for the CIC roll off and provide passband bandwidths which are between 17% and 150% of the down converter's output sample rate (the PFIR output rate before resampling).

The filter taps can be copied from this table, or requested by e-mail from tech-support@graychip.com, or downloaded from the web at www.graychip.com. The filter taps are available in two file formats. The first, <filter_name>.taps, is an ascii listing of the taps. The second, <filter_name>.cmd, is a command file which could be used to write the filter taps into a GC4016 chip. The commands are formatted as "write <address> <data_byte>," where <address> and <data_byte> are unsigned hex integers.

The recommended default filter is cfir_80 which is flat out to 80% of the channel output's usable bandwidth. The narrower filters have less ripple and better out of band rejection. The wider filters (100% and 150%) are designed for the single wideband output per chip mode where all four channels are used as one wideband channel. These modes have more ripple and less out of band rejection than the narrowband filters.

Table 25: Example CFIR Filters

Name	Usable Output Bandwidth	Passband Cutoff	Passband Ripple (pk to pk)	Stopband Start	Stopband Rejection	CFIR Gain (CFIR_SUM)	Applications	Taps (first 11)
cfir_17	17%	0.085	0.01dB	1.5	110dB	2.0413 (133781)	8x oversampled outputs.	5 39 -166 -1301 -3009 -2848 1280 9009 18952 28546 32767
cfir_34	34%	0.17	0.01dB	1.5	110dB	1.5429 (101113)	4x oversampled outputs, 2X GSM or EDGE outputs	-24 74 494 548 -977 -3416 -3672 1525 13074 26547 32767
cfir_68	68%	0.34	0.02dB	1.55	100dB	1.2665 (83001)	2x oversampled outputs, 1X GSM or EDGE outputs	12 -93 -62 804 1283 -1273 -5197 -3512 8332 24823 32767
cfir_80 (default)	80%	0.4	0.025dB	1.5	100dB	0.9899 (64877)	1.5x oversampled outputs, Default filter for most applications	5 -8 -172 -192 806 1493 -1889 -6182 1085 21109 32767
cfir_100	100%	0.5	0.08dB	1.5	100dB	0.9109 (59695)	Single wideband DDC mode (See Section 3.4.2)	-3 40 -75 -437 291 1951 -489 -6365 -1185 19736 32767
cfir_150	150%	0.75	0.6dB	1.25	60dB	0.9154 (59993)	Single wideband DDC mode (See Section 3.4.2)	47 -102 -1184 -1274 1487 3243 -1798 -7760 15 20939 32767

Key:

The Usable Output Bandwidth is the passband bandwidth expressed as a percentage of the DDC channel output sample rate.

The Passband Cutoff frequency is relative to the DDC channel output sample rate.

The Stopband Start frequency is relative to the DDC channel output sample rate.

The Taps are the first 11 taps of the 21 tap filter. The final 10 taps are a mirror image of the first 10 taps. The center taps are scaled to the full scale positive value of 32767.

The Gain is CFIR_SUM/65536, the value in parenthesis is the CFIR_SUM

7.6 EXAMPLE PFIR FILTER SETS

The spectral requirements of the PFIR filter are shown in Figure 11 in Section 3.3.6. The filters in Table 26 provide passband bandwidths which are between 17% and 150% of the down converter channel output sample rate (before resampling).

The filter taps can be copied from this table, or requested by e-mail from tech-support@graychip.com, or downloaded from the web at www.graychip.com. The filter taps are available in two file formats. The first, <filter_name>.taps, is an ascii listing of the taps. The second, <filter_name>.cmd, is a command file which could be used to write the filter taps into a GC4016 chip. The commands are formatted as "write <address> <data_byte>", where <address> and <data_byte> are unsigned hex integers.

Table 26: Default PFIR Filters

Name	Usable Output Bandwidth	Passband Cutoff	Passband Ripple (pk to pk)	Stopband Start	Stopband Rejection near/far	PFIR Gain	Applications	Taps (first 32)
pfir_17	17%	0.085	0.01dB	0.125	97dB/ 120dB	3.1262 (204881)	8x oversampled outputs.	6 17 33 49 54 33 -28 -132 -263 -380 -424 -329 -49 408 964 1461 1690 1445 597 -826 -2589 -4252 -5228 -4908 -2819 1222 7006 13910 20982 27118 31289 32767
pfir_34	34%	0.17	0.02dB	0.3	83dB/ 108dB	2.2370 (146605)	4x oversampled outputs, 2X GSM or EDGE outputs	14 30 41 27 -29 -118 -200 -212 -95 150 435 598 475 5 -680 -1256 -1330 -653 669 2112 2880 2269 101 -2996 -5632 -6103 -3091 3666 13042 22747 30053 32767
pfir_68	68%	0.34	0.015dB	0.5	90dB/ 98dB	1.2140 (79563)	2x oversampled outputs, 1X GSM or EDGE outputs	2 1 -11 -23 -2 45 43 -48 -117 -8 191 155 -189 -375 26 579 358 -601 -918 248 1469 618 -1680 -1995 1104 3690 845 -5354 -5506 6574 24277 32767
pfir_80	80%	0.4	0.15dB	0.5	78dB/ 93dB	1.1494 (75329)	1.5x oversampled outputs, Default filter for most applications	31 136 208 107 -123 -181 69 277 46 -353 -235 358 483 -246 -750 -24 967 470 -1046 -1081 884 1817 -360 -2608 -689 3365 2594 -3992 -6527 4407 23277 32767
pfir_100	100%	0.5	0.2dB	0.6	75dB/ 84dB	0.9189 (60221)	Single wideband DDC mode (See Section 3.4.2)	-30 -141 -180 2 151 -34 -186 87 232 -171 -273 293 292 -458 -270 668 181 -916 4 1192 -325 -1479 837 1758 -1647 -2005 3015 2201 -5914 -2326 19169 32767
pfir_150	150%	0.75	0.75dB	0.82	50dB/ 65dB	0.6320 (41417)	Single wideband DDC mode (See Section 3.4.2)	-32 -234 98 -24 -74 165 -199 138 13 -198 329 -323 149 145 -437 577 -456 73 445 -867 955 -576 -213 1138 -1778 1706 -659 -1331 3909 -6474 8360 32767

Key:

The Usable Output Bandwidth is the passband bandwidth expressed as a percentage of the DDC channel output sample rate.

The Passband Cutoff frequency is relative to the DDC channel output sample rate.

The Stopband Start frequency is relative to the DDC channel output sample rate.

The Taps are the first 32 taps of the 63 tap filter. The final 31 taps are a mirror image of the first 31 taps. The center taps are scaled to the full scale positive value of 32767.

The Gain is PFIR_SUM/65536, the value in parenthesis is the PFIR_SUM

The recommended default filter is PFIR_80 which is flat out to 80% of the channel output's usable bandwidth. The narrower filters have less ripple and better out of band rejection. The wider filters (100% and 150%) are designed for the single wideband output per chip mode where all four channels are used as one wideband channel. These modes have more ripple and less out of band rejection than the narrowband filters.

The PFIR can also be used to apply receive filters for digital modulation formats such as QPSK, OQPSK or QAM. The most common receive filter is the root-raised cosine (RRC) filter. A program (written in C) designed to generate RRC pfir filters is available from graychip by e-mail or from the web. This program asks for the input sample rate, the baud rate and the desired roll off (alpha) factor. The output is a 63 tap PFIR filter tap file and a GC4016 command file.

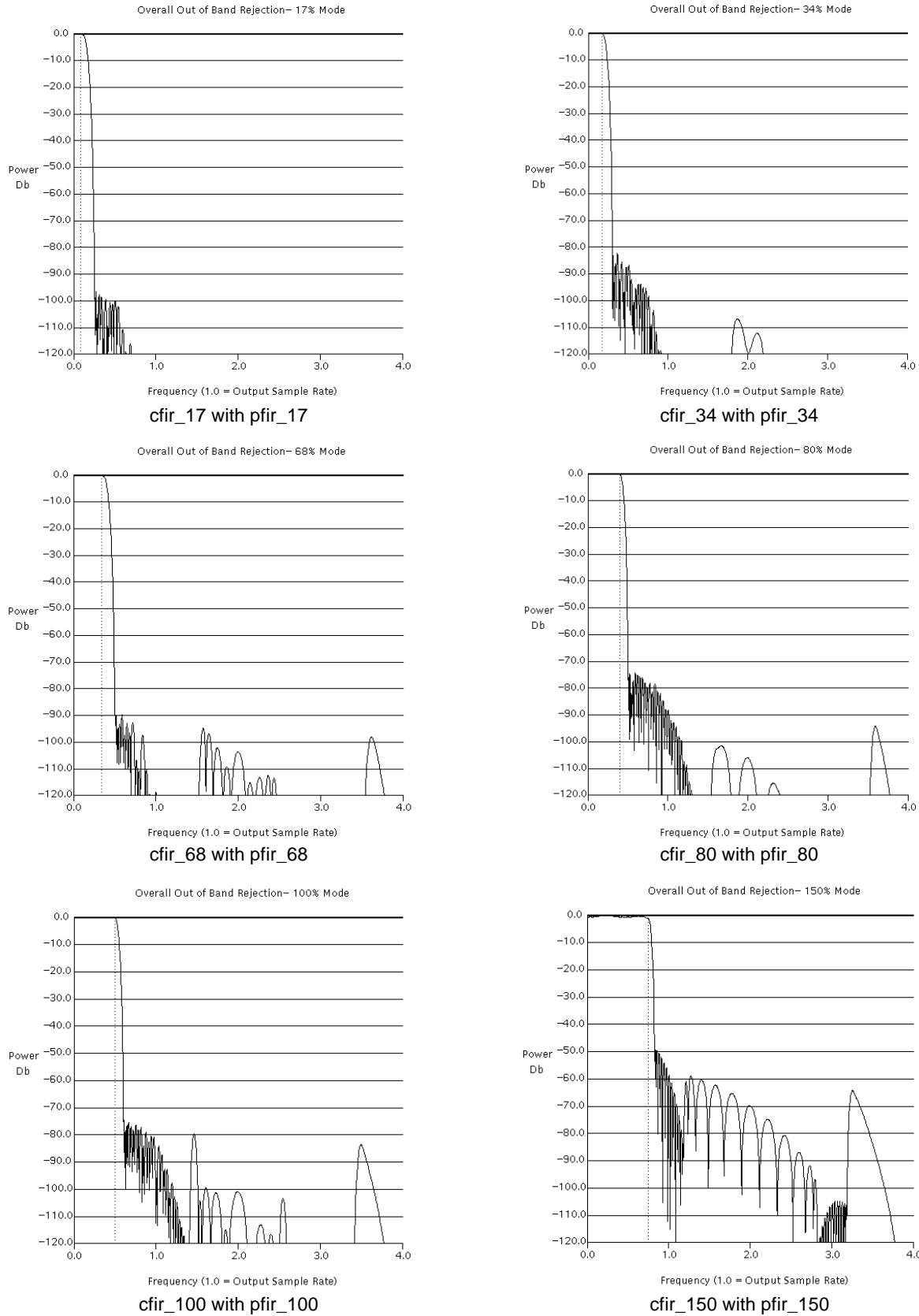


Figure 19. Overall Spectral Responses of Example Filters

7.7 EXAMPLE RESAMPLER CONFIGURATIONS

This Section describes some commonly used resampler configurations and the filter coefficient sets used for them.

7.7.1 Bypass Mode

The resampler is bypassed by using a configuration which has h_0 set to 1024, all other taps set to zero, NMULT set to 7, NO_SYM_RES set to 1, FINAL_SHIFT set to 5, and RATIO set to 2^{26} (0x04000000). Note that the NDELAY term in the RES_GAIN equation does not apply in this case and should be set to unity in the gain equation. The resampler control register setting for this mode are shown in Table 27.

Table 27: Resampler Bypass Mode

Address	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
Page 32	00	04	00													
Pages 33-63	00															
Page 64	23	46	00	35	E4	70	00	00	unused							
Page 65	00	00	00	04	00	00	00	04	00	00	00	04	00	00	00	04

7.7.2 Resampling Modes

Several resampler configurations are summarized in Table 28. These configurations use the default values for the resampler controls except for NMULT in address 17, which must be set to the value in Table 28. The defaults (hex) are 23, NM, 00, 34, E4, 00, 00 and 00, respectively for addresses 16 through 23 of page 64. NM is NMULT-1.

Table 28: Resampler Modes

Configuration Name	NMULT	%BW	PB Ripple (dB)	Image Rejection (dB)	RES_SUM	Application
Configurations with NDELAY = 64, These offer the best resampling phase jitter performance (-48dB inband noise), but the % input bandwidth must be 60% or less						
res_6x64_60	6	60	0.18	52	134786	Use if NMULT must be 6
res_7x64_60	7		0.16	55	138292	Use if NMULT must be less than 8
res_8x64_60	8	60	0.03	62	134782	SUGGESTED DEFAULT- Best 60% bandwidth mode, Adequate for most applications
res_8x64_80		80	0.7	43	139894	An 80% mode with NMULT=8
Configurations with NDELAY = 32, These offer higher % bandwidth, but fewer resampling delays (-42dB inband jitter noise)						
res_9x32_60	9	60	0.01	63	64700	Best 60% mode for interpolating by integer amounts
res_12x32_80	12	80	0.11	48	65610	Alternate if NMULT must be less than 15
res_15x32_80	15		0.05	58	66482	Best 80% mode, Very good for interpolating by integer amounts
Configurations with NDELAY = 16, These are restricted to single or dual channel modes, very good for interpolating by integer amounts.						
res_19x16_80	19	80	0.02	65	32988	Good filter, but only for single or dual channel modes

The %BW column reflects the percentage passband of the signal relative to the sample rate going into the resampler. The resampler's response is flat over this bandwidth to within the passband ripple indicated above. The image rejection is the amount that the resampling images are rejected relative to the signal.

The filter taps for these configurations can be requested by e-mail from tech-support@graychip.com, or downloaded from the web at www.graychip.com. The filter taps are available in two file formats. The first, <filter_name>.taps, is an ascii listing of the taps. The second, <filter_name>.cmd, is a command file which could be used to write the filter taps into a GC4016 chip. The commands are formatted as "write <address> <data_byte>", where <address> and <data_byte> are unsigned hex integers.

7.8 GC4016 CONFIGURATION GENERATOR

A GC4016 configuration generator is available from Graychip in the form of a “C” program which can be obtained via email or the web. The program is described below.

```
Usage: cmd4016 [-gc100 | -TI | -sim] <config_file>
```

where <config_file> is a file containing a list of control register settings of the form:

```
<parameter> <value>
print [gc100 | TI | sim ]
channel [0-3]
copy_channel [0-3]
cfir_coef <file>
pfir_coef <file>
res_coef <file>
```

where <parameter> is one of the gc4016 control register fields identified in the datasheet or quick reference guide.

Cmd4016 reads the file of control register settings and creates output files which summarize the control register values needed to program the chip. The program creates config_file.tbl, which contains a summary of all of the control register settings in a table format.

A second file is created which is in a format suitable for programming the chip. Three formats are supported: gc100, TI, and sim. The format is either chosen on the command line, or is chosen using the “print [gc100 | TI | sim]” command. These options create config_file.gc100, config_file.ti or config_file.sim output files.

The gc100 format is used by the gc100 test card interface. This format contains commands of the form:

```
write <address> <data>
or
write_block <starting_address> <data0> <data1> <data2> ...
```

The TI format is for use with the 4 bit addressing mode and contains commands of the form:

```
<address> <data>
```

The sim format is used by the “ifan” simulator and contains commands of the form:

```
writec <address> <data>
```

The “4_bit_address” mode is required in the TI mode, it is illegal in the gc100 or sim modes. A warning will be printed and the appropriate 4_bit_address mode will be forced if this is violated. cmd4016 then checks the configuration for sanity and calculates the gains throughout the chip.

Example configuration files can also be provided by email, or downloaded from the web.

7.9 EXAMPLE GSM APPLICATION

This section describes how to configure the chip to downconvert GSM (or EDGE) signals and meet the stringent GSM processing specifications. The desired GSM Specifications are:

Table 29: Desired GSM Specifications

Specification	Value	Comment
Clock (CK)	69.333MHz =256*270.833KHz	Can be any value equal to 4NB, where N is the CIC decimation ratio and B is the GSM bit rate of 270.833KHz
Input Sample Rate	Same as clock rate	Can be 1/2, 1/3, 1/4, ..., 1/N times the clock rate using the zero pad feature.
Input Format	A port, 14 Bit, 2's Complement	Can be modified as desired
Spur free dynamic range	> -110dB	The GC4016 NCO provides more than 115 dB of spur free dynamic range
Output Sample Rate	270.833KHz, complex data	Can be 2X, 4X, 8X or any multiple of this rate by changing the resampler ratios
Passband Width	160KHz	The filter response must be flat over this bandwidth to within the passband ripple
Passband Ripple	< 0.1dB peak to peak	To meet the GSM BER specification
Stopband Rejection	Set by GSM Specification	See the GSM adjacent channel and blocker mask in Figure 20
Output Format	Four serial streams, 24 bit I and Q data	Can be modified as desired

7.9.1 GSM Filter Response

Figure 20 shows the overall response using CFIR filter, cfir_68, and a set of PFIR coefficients tuned for GSM. The GSM out of band rejection mask is also shown. The passband ripple is less than 0.1 dB (peak to peak). The passband ripple specification for GSM is not directly specified. Instead it is specified in terms of bit error rate (BER). Trade offs between transition bandwidth and passband ripple in order to optimize the BER can easily be made by reprogramming the PFIR filter.

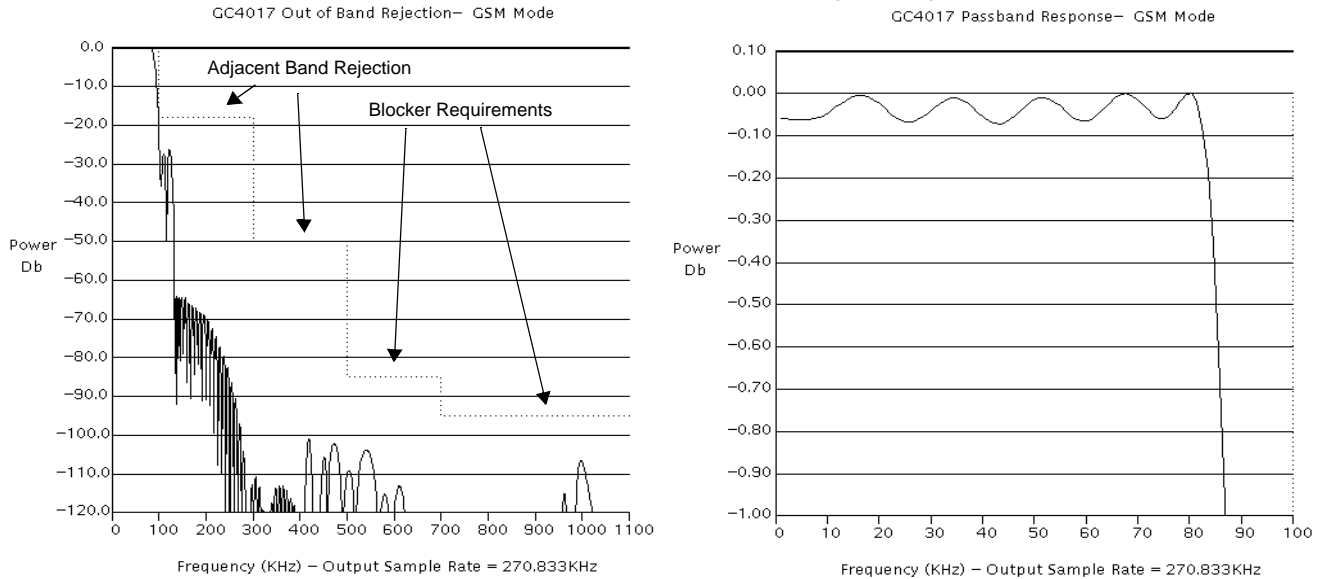


Figure 20. Frequency Response for the Example GSM Application

The PFIR coefficients are:

132 182 1 -309 -330 119 560 343 -424 -834 -278 696 960 149 -916 -1132 -212 1075 1514
 421 -1518 -2374 -673 2529 3817 726 -4796 -6888 -650 12967 26898 32767

These coefficients are available by e-mail or over the web as pfir_gsm.taps. The PFIR_SUM for this set of coefficients is 96277.

7.9.2 Oversampling Using the Resampler

This example assumes the input sample rate is equal to 4*N*B, where N is the decimation in the CIC filter (See Section 5.6) and B is the GSM bit rate (270.833 KHz). The outputs are one complex sample per bit (270.833 KHz) with the resampler set to interpolate by unity (no interpolation). The output rate can be doubled or quadrupled as desired by changing the resampler ratio. The resampler uses the configuration res_8x64_60. (See Section 7.7). This configuration introduces 0.03dB of passband ripple and -62dB inband noise, neither being large enough to effect the BER.

The resampler ratio for one sample per bit (270.833KHz) is 0x04000000. It is 0x02000000 for two samples per bit (541.666KHz) and it is 0x01000000 for four samples per bit (1.08333MHz).

7.9.3 Gain

The example configuration assumes a CIC decimation of N=64, which corresponds to an ADC clock rate (CK) of 69.333248 MHz. The values of SCALE and BIG_SCALE must be chosen to satisfy: (SHIFT + SCALE + 6 × BIG_SCALE) ≤ (62 - 5log₂N) . N is 64 and SHIFT is 4, so (SCALE + 6 × BIG_SCALE) ≤ 28 , which is satisfied by setting SCALE=4 and BIG_SCALE=4. If other values of N are chosen, then SCALE and BIG_SCALE need to be modified as necessary. The overall gain is adjusted using FINE_GAIN and FINAL_SHIFT. The overall gain is:

$$GAIN = \left\{ \left(\frac{1}{NZEROS+1} \right) N^{5 \cdot 2^{(SHIFT + SCALE + 6 \times BIG_SCALE - 62)}} \right\} \left(2^{COARSE} \right) \left(\frac{CFIR_SUM}{65536} \right) \left(\frac{PFIR_SUM}{65536} \right) \left(\frac{FINE_GAIN}{1024} \right) \left(\frac{RES_SUM}{32768 \times NDELAY} \right) \left(2^{FINAL_SHIFT} \right)$$

where NZEROS=0, N=64, SHIFT=4, SCALE=4, BIG_SCALE=4, COARSE=0, CFIR_SUM=83001, PFIR_SUM=96277, RES_SUM=134782 and NDELAY=64. Because of the loss of 1/2 when converting real data to complex, the desired gain is 2.0. This can be achieved by setting FINE_GAIN to 1070 and FINAL_SHIFT equal to 4.

7.9.4 GSM Configuration

The control register settings for this example are shown in table 30. It is assumed that output pin $\overline{S0}$ is tied to input pin $\overline{S1A}$.

Table 30: Example GSM Configuration

Global Registers																
Address	0	1	2	3	4	5	6	7								
	F8	00	00	-	27	DC	00	00	After configuration set address 0 to 08, then set address 5 to 5C							
Paged Registers																
Address	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CH A	Pages 0,1	Load CFIR coefficients: cfir_68.taps														
	Pages 2-5	Load PFIR coefficients: pfir_gsm.taps														
	Page 6	00	00	FREQ				unused								
	Page 7	0C	77	00	20	22	3F	70	64	00	00	00	00	1D	-	2E
CH B	Pages 8,9	Load CFIR coefficients: cfir_68.taps														
	Pages 10-13	Load PFIR coefficients pfir_gsm.taps														
	Page 14	00	00	FREQ				unused								
	Page 15	0C	77	00	20	22	3F	70	64	00	00	00	00	1D	-	2E
CH C	Pages 16,17	Load CFIR coefficients: cfir_68.taps														
	Pages 18-21	Load PFIR coefficients: pfir_gsm.taps														
	Page 22	00	00	FREQ				unused								
	Page 23	0C	77	00	20	22	3F	70	64	00	00	00	00	1D	-	2E
CH D	Pages 24,25	Load CFIR coefficients: cfir_68.taps														
	Pages 26-29	Load PFIR coefficients: pfir_gsm.taps														
	Page 30	00	00	FREQ				unused								
	Page 31	0C	77	00	20	22	3F	70	64	00	00	00	00	1D	-	2E
RES	Page 32-63	Load resampler coefficients: res_8x64_60.taps														
	Page 64	23	07	00	34	E4	00	00	00	unused						
	Page 65	00	00	00	04	00	00	00	04	00	00	00	04	00	00	00
OUT	Page 98	7F	40	28	01	E9	B0	E4	10	32	54	76	02	unused		

7.10 EXAMPLE IS-136 DAMPS APPLICATION

This section describes how to configure the chip to downconvert DAMPS signals, apply the root-raised-cosine receive filter, and output samples at two times, four times or eight times the DAMPS symbol rate. The desired DAMPS Specifications are:

Table 31: Desired DAMPS Specifications

Specification	Value	Comment
Clock (CK)	62.208MHz =8*320*24.3KHz	Can be any value equal to 8NB, where N is the CIC decimation ratio and B is the DAMPS symbol rate of 24.3KHz
Input Sample Rate	Same as clock rate	Can be 1/2, 1/3, 1/4, ... 1/N of the clock rate by using the zero pad feature.
Input Format	A port, 14 Bit, 2's Complement	Can be modified as desired
Spur free dynamic range	> -110dB	The GC4016 NCO provides more than 115 dB of spur free dynamic range
Output Sample Rate	48.6KHz, complex data (2X)	Can be 4X, 8X or any multiple of the symbol rate by changing the resampler ratios
Passband Response	RRC with alpha=0.35	Matches the required receive filter
Stopband Rejection	Set by DAMPS Specification	See the DAMPS rejection mask in Figure 21
Output Format	Four serial streams, 24 bit I and Q data	Can be modified as desired

7.10.1 DAMPS Filter Response

Figure 21 shows the overall response using CFIR filter, cfir_68, and a set of RRC PFIR coefficients tuned for 2X oversampled output data. The DAMPS out of band rejection mask is also shown.

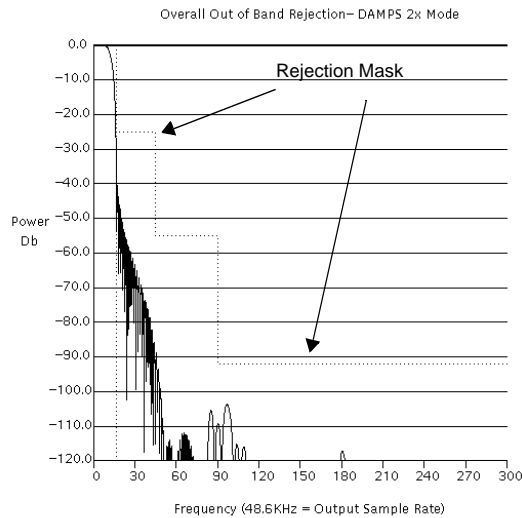


Figure 21. Frequency Response for the Example DAMPS Application

The RRC PFIR coefficients are:

```
-12 -117 -113 8 127 112 -38 -175 -134 82 275 224 -71 -348 -307 61 398 286 -286 -761
-442 766 1954 1708 -660 -4042 -5641 -2533 6187 18177 28625 32767
```

These coefficients are available by e-mail or over the web as pfir_damps_2x.taps. The PFIR_SUM for this set of coefficients is 119387.

7.10.2 Oversampling Using the Resampler

This example assumes the input sample rate is equal to $8 \cdot N \cdot B$, where N is the decimation in the CIC filter (See Section 5.6) and B is the DAMPS symbol rate (24.3 KHz). The outputs are two complex samples per symbol (48.6 KHz) with the resampler set to interpolate by unity (no interpolation). The output rate can be doubled or quadrupled as desired by changing the resampler

ratio. The resampler uses the configuration res_15x32_80. (See Section 7.7). This configuration introduces 0.05dB of passband ripple and -58dB inband noise, neither being large enough to effect the BER.

The resampler ratio for two samples per symbol (48.6KHz) is 0x04000000, for four samples per symbol (97.2KHz) is 0x02000000, and for eight samples per symbol (194.4KHz) is 0x01000000.

7.10.3 Gain

The example configuration assumes a CIC decimation of N=320, which corresponds to an ADC clock rate (CK) of 62.208 MHz. The values of SCALE and BIG_SCALE must be chosen to satisfy: $(SHIFT + SCALE + 6 \times BIG_SCALE) \leq (62 - 5\log_2 N)$. N is 320 and SHIFT=4, so $(SCALE + 6 \times BIG_SCALE) \leq 16.4$, which is satisfied by setting SCALE=4 and BIG_SCALE=2. If other values of N are chosen, then SCALE and BIG_SCALE need to be modified as necessary. The overall gain is adjusted using FINE_GAIN and FINAL_SHIFT. The overall gain is:

$$GAIN = \left\{ \left(\frac{1}{NZEROS + 1} \right) N^5 2^{(SHIFT + SCALE + 6 \times BIG_SCALE - 62)} \right\} (2^{COARSE}) \left(\frac{CFIR_SUM}{65536} \right) \left(\frac{PFIR_SUM}{65536} \right) \left(\frac{FINE_GAIN}{1024} \right) \left(\frac{RES_SUM}{32768 \times NDELAY} \right) (2^{FINAL_SHIFT})$$

where NZEROS=0, N=320, SHIFT=4, SCALE=4, BIG_SCALE=2, COARSE=0, CFIR_SUM=83001, PFIR_SUM=119387, RES_SUM=66554 and NDELAY=32. Because of the loss of 1/2 when converting real data to complex, the desired gain is 2.0. This can be achieved by setting FINE_GAIN to 1147 and FINAL_SHIFT equal to 4.

7.10.4 DAMPS Configuration

The control register settings for this example are shown in table 32. It is assumed that output pin \overline{SO} is tied to input pin \overline{SIA} .

Table 32: Example DAMPS Configuration

Global Registers																	
Address	0	1	2	3	4	5	6	7									
	F8	00	00	-	27	DC	00	00	After configuration set address 0 to 08, then set address 5 to 5C								
Paged Registers																	
Address	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	
CH A	Pages 0,1	Load CFIR coefficients: cfir_68.taps															
	Pages 2-5	Load PFIR coefficients: pfir_damps_2x.taps															
	Page 6	00	00	FREQ				unused									
	Page 7	0C	77	00	20	22	3F	71	54	00	00	00	00	1D	-	7B	04
CH B	Pages 8,9	Load CFIR coefficients: cfir_68.taps															
	Pages 10-13	Load PFIR coefficients pfir_damps_2x.taps															
	Page 14	00	00	FREQ				unused									
	Page 15	0C	77	00	20	22	3F	71	54	00	00	00	00	1D	-	7B	04
CH C	Pages 16,17	Load CFIR coefficients: cfir_68.taps															
	Pages 18-21	Load PFIR coefficients: pfir_damps_2x.taps															
	Page 22	00	00	FREQ				unused									
	Page 23	0C	77	00	20	22	3F	71	54	00	00	00	00	1D	-	7B	04
CH D	Pages 24,25	Load CFIR coefficients: cfir_68.taps															
	Pages 26-29	Load PFIR coefficients: pfir_damps_2x.taps															
	Page 30	00	00	FREQ				unused									
	Page 31	0C	77	00	20	22	3F	71	54	00	00	00	00	1D	-	7B	04
RES	Page 32-63	Load resampler coefficients: res_15_32_80.taps															
	Page 64	23	0E	00	34	E4	00	00	00	unused							
	Page 65	00	00	00	04	00	00	00	04	00	00	00	04	00	00	00	04
OUT	Page 98	7F	40	28	01	D9	B1	E4	10	32	54	76	02	unused			

7.11 EXAMPLE IS-95 NB-CDMA APPLICATION

This section describes how to configure the chip to downconvert IS-95 NB-CDMA signals and output samples at two times (2X), four times (4X) or eight times (8X) the IS-95 symbol rate of 1.2288MHz. The desired IS-95 Specifications are:

Table 33: Desired IS-95 NB-CDMA Specifications

Specification	Value	Comment
Clock (CK)	58.9824MHz =48*1.2288MHz	Can be any value greater than this, does not need to be a multiple of 1.2288MHz.
Input Sample Rate	Same as clock rate	Can be 1/2, 1/3, 1/4, ... 1/N times the clock rate using the zero pad feature
Input Format	A port, 14 Bit, 2's Complement	Can be modified as desired
Spur free dynamic range	> -110dB	The GC4016 NCO provides more than 115 dB of spur free dynamic range
Output Sample Rate	4.9152MHz, complex data (4X)	Can be 2X or 4X multiple of the symbol rate by changing the resampler ratio. Can be 8X by using the dual channel mode.
Passband Width	615kHz	1.25MHz signal spacing
Passband Ripple	0.4 dB	
Stopband Rejection	50 dB at 750kHz, 87dB at 900kHz offset	Far band rejection > 120dB
Output Format	Parallel output, 24 bit I and Q data	Can be modified as desired, allows simple AGC in an FPGA or ASIC to 4 or 6 bits.

7.11.1 IS-95 Filter Response

Figure 22 shows the overall response when the channel decimates to 1.5 times the baud rate. This uses the CFIR filter, `cfir_68`, and the PFIR filter `pfir_is95_1.5x`. The passband ripple is less than 0.4 dB (peak to peak).

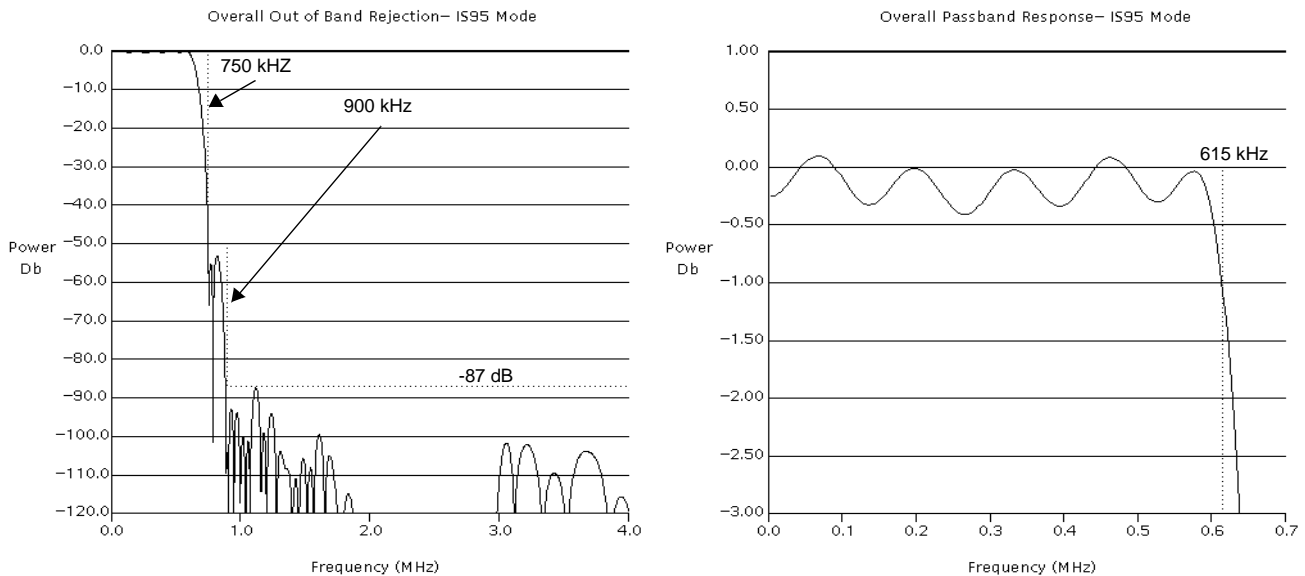


Figure 22. Frequency Response for the Example IS95 Application

The PFIR coefficients are:

-4 -45 -166 -349 -452 -299 96 420 302 -225 -612 -321 471 881 267 -866 -1191-64 1461 1516 -388 -2351 -1826 1303 3804
2088 -3358 -6915 -2266 11185 26207 32767

These coefficients are available by e-mail or over the web as `pfir_is95_1.5x.taps`. The PFIR_SUM for this set of coefficients is 89373.

7.11.2 Oversampling Using the Resampler

This example assumes the input sample rate is equal to $6*N*B$, where N is the decimation in the CIC filter (See Section 5.6) and B is the IS95 symbol rate (1.2288 MHz). The PFIR filter output rate is 1.5 samples per symbol (1.5X). The outputs are two complex samples per symbol (2.4576 MHz) if the resampler is set to interpolate by 4/3. The output rate can be 4X or 8X as desired by changing the resampler ratio. The resampler uses the configuration `res_6x64_60`. (See Section 7.7). This configuration introduces -58dB inband noise, not enough to effect the BER. The spectral effect of the resampler is included in Figure 22.

The resampler ratio for two samples per symbol (2.4576MHz) is 0x03000000, for four samples per symbol (4.9152MHz) it is 0x01800000, and for eight samples per symbol (9.8304MHz) it is 0x00C00000. Note that the resampler can only handle two channels at eight samples per symbol.

Sample rates other than $6*N*B$ can be accepted. To use these rates one needs to customize the PFIR filter to match the bandwidth when the sample rate has been decimated by $4*N$, and then the resampling ratio needs to be adjusted to match the desired output rate. Call Graychip for details.

7.11.3 Gain

The example configuration assumes a CIC decimation of $N=8$, which corresponds to an ADC clock rate (CK) of 58.9824MHz. The values of SCALE and BIG_SCALE must be chosen to satisfy: $(SHIFT + SCALE + 6 \times BIG_SCALE) \leq (62 - 5\log_2 N)$. N is 8 and $SHIFT=4$, so $(SCALE + 6 \times BIG_SCALE) \leq 43$, which is satisfied by setting $SCALE=1$ and $BIG_SCALE=7$. If other values of N are chosen, then SCALE and BIG_SCALE need to be modified as necessary. The overall gain is adjusted using FINE_GAIN and FINAL_SHIFT. The overall gain is:

$$GAIN = \left\{ \left(\frac{1}{NZEROS+1} \right) N^5 2^{(SHIFT + SCALE + 6 \times BIG_SCALE - 62)} \right\} \left(2^{COARSE} \right) \left(\frac{CFIR_SUM}{65536} \right) \left(\frac{PFIR_SUM}{65536} \right) \left(\frac{FINE_GAIN}{1024} \right) \left(\frac{RES_SUM}{32768 \times NDELAY} \right) (2^{FINAL_SHIFT})$$

where $NZEROS=0$, $N=8$, $SHIFT=4$, $SCALE=1$, $BIG_SCALE=7$, $COARSE=0$, $CFIR_SUM=83001$, $PFIR_SUM=89373$, $RES_SUM=134786$ and $NDELAY=64$. Because of the loss of 1/2 when converting real data to complex, the desired gain is 2.0. This can be achieved by setting FINE_GAIN to 1153 and FINAL_SHIFT equal to 4.

7.11.4 IS95 NB-CDMA Configuration

The control register settings for this example are shown in table 34. It is assumed that output pin $\overline{S0}$ is tied to input pin $\overline{S1A}$.

Table 34: Example IS95 NB-CDMA Configuration

Global Registers																	
Address	0	1	2	3	4	5	6	7									
	F8	00	00	-	27	DC	00	00	After configuration set address 0 to 08, then set address 5 to 5C								
Paged Registers																	
Address	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	
CH A	Pages 0,1	Load CFIR coefficients: cfir_68.taps															
	Pages 2-5	Load PFIR coefficients: pfir_is95_1.5x.taps															
	Page 6	00	00	FREQ				unused									
	Page 7	0C	77	22	20	22	07	70	79	00	00	00	00	1D	-	81	04
CH B	Pages 8,9	Load CFIR coefficients: cfir_68.taps															
	Pages 10-13	Load PFIR coefficients: pfir_is95_1.5x.taps															
	Page 14	00	00	FREQ				unused									
	Page 15	0C	77	22	20	22	07	70	79	00	00	00	00	1D	-	81	04
CH C	Pages 16,17	Load CFIR coefficients: cfir_68.taps															
	Pages 18-21	Load PFIR coefficients: pfir_is95_1.5x.taps															
	Page 22	00	00	FREQ				unused									
	Page 23	0C	77	22	20	22	07	70	79	00	00	00	00	1D	-	81	04
CH D	Pages 24,25	Load CFIR coefficients: cfir_68.taps															
	Pages 26-29	Load PFIR coefficients: pfir_is95_1.5x.taps															
	Page 30	00	00	FREQ				unused									
	Page 31	0C	77	22	20	22	07	70	79	00	00	00	00	1D	-	81	04
RES	Page 32-63	Load resampler coefficients: res_6x64_60.taps															
	Page 64	23	05	00	14	E4	70	00	E4	unused							
	Page 65	00	00	80	01	00	00	80	01	00	00	80	01	00	00	80	01
OUT	Page 98	FF	40	6C	87	EF	00	E4	10	32	54	76	02	unused			

7.12 UMTS WB-CDMA APPLICATION

This section describes how to configure the chip to downconvert UMTS WB-CDMA signals and output samples at two times or four times the UMTS symbol rate. The desired UMTS Specifications are:

Table 35: Desired UMTS Specifications

Specification	Value	Comment
Clock (CK)	61.44MHz = 16*3.84MHz	Can be any value greater than this, does not need to be a multiple of 3.84MHz.
Input Sample Rate	Same as clock rate	May be an integer division of the clock rate (30.72MHz, 20.48MHz, etc.)
Input Format	A port, 14 Bit, 2's Complement	Can be modified as desired
Spur free dynamic range	> -80dB	The GC4016 NCO provides more than 115 dB of spur free dynamic range
Output Sample Rate	15.36MSPS, complex data (4X)	Can be 2X or 4X multiple of the symbol rate by changing the resampler ratio. Can do two channels at 2X if the clock rate is greater than 92.16MHz.
Passband Width	4.6848MHz	RRC filter with alpha=0.22 give a bandwidth of 1.22*3.84MHz
Passband Ripple	0.1 dB	Filter gives 0.05dB passband ripple
Stopband Rejection	60 dB at 5MHz, 80dB at > 5MHz offset	Rejection > 80dB at 2.6MHz offset
Output Format	Parallel output, 16 bit I and Q data	Can be modified as desired, allows simple AGC in an FPGA to 4 or 6 bits.

7.12.1 UMTS Filter Response

Figure 23 shows the overall response using specially tuned CFIR and PFIR filters. The PFIR filter is a specially optimized root-raised-cosine 63 tap filter with an alpha of 0.22. The filter is designed to have less than -50dB of inter symbol interference (ISI) noise.

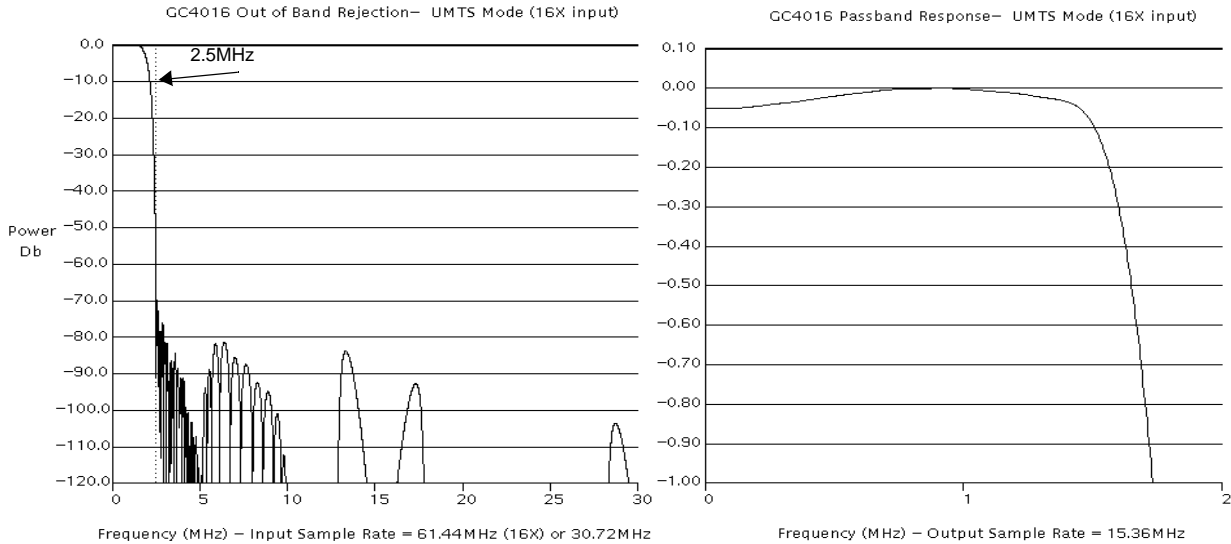


Figure 23. Frequency Response for the Example UMTS Application

These coefficients are available by e-mail or over the web as `cfir_umts.taps` and `pfir_umts.taps`. The `CFIR_SUM` for `cfir_umts.taps` is 58827. The `PFIR_SUM` for `pfir_umts.taps` is 61821.

7.12.2 Oversampling Using the Resampler

This example assumes the input sample rate is equal to $4*N*B$, where N is the decimation in the CIC filter (See Section 5.6) and B is the UMTS symbol rate (3.84 MHz). The outputs are two complex samples per symbol (7.68MHz) with the resampler set to interpolate by unity (no interpolation). The output rate can be doubled or quadrupled as desired by changing the resampler ratio. The resampler uses the configuration `res_8x64_60`. (See Section 7.7). This configuration introduces 0.03dB of passband ripple and -62dB inband noise, neither being large enough to effect UMTS demodulation.

The resampler ratio for two samples per symbol (7.68MHz) is `0x04000000` and for four samples per symbol (15.36MHz) it is `0x02000000`.

Sample rates other than $4*N*B$ can be accepted by adjusting the PFIR filter to match the desired RRC filter and by using the resampler to adjust the final sample rate to be exactly 2X or 4X the symbol rate.

7.12.3 Gain

The example configuration assumes a CIC decimation of $N=4$, which corresponds to an ADC clock rate (CK) of 61.44 MHz. The values of `SCALE` and `BIG_SCALE` must be chosen to satisfy: $(SHIFT + SCALE + 6 \times BIG_SCALE) \leq (62 - 5\log_2 N)$. N is 4 and `SHIFT`=4, so $(SCALE + 6 \times BIG_SCALE) \leq 48$, which is satisfied by setting `SCALE`=5 and `BIG_SCALE`=7, which are their maximum values. If other values of N are chosen, then `SCALE` and `BIG_SCALE` need to be modified as necessary. The overall gain is adjusted using `COARSE`, `FINE_GAIN` and `FINAL_SHIFT`. The overall gain is:

$$GAIN = \left\{ \left(\frac{1}{NZEROS+1} \right) N^5 2^{(SHIFT + SCALE + 6 \times BIG_SCALE - 62)} \right\} \left(2^{COARSE} \right) \left(\frac{CFIR_SUM}{65536} \right) \left(\frac{PFIR_SUM}{65536} \right) \left(\frac{FINE_GAIN}{1024} \right) \left(\frac{RES_SUM}{32768 \times NDELAY} \right) (2^{FINAL_SHIFT})$$

where `NZEROS`=0, `N`=4, `SHIFT`=4, `SCALE`=5, `BIG_SCALE`=7, `COARSE`=1, `CFIR_SUM`=58827, `PFIR_SUM`=61821,

RES_SUM=134782 and NDELAY=64. Because of the loss of 1/2 when converting real data to complex, the desired gain is 2.0. This can be achieved by setting FINE_GAIN to 2352 and FINAL_SHIFT equal to 4.

7.12.4 UMTS Configuration

The control register settings for this example are shown in table 36. It is assumed that output pin $\overline{S0}$ is tied to input pin $\overline{S1A}$.

Table 36: Example UMTS Configuration

Global Registers																
Address	0	1	2	3	4	5	6	7								
	F8	00	00	-	27	DC	00	00	After configuration set address 0 to 08, then set address 5 to 5C							
Paged Registers																
Address	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CH A	Pages 0,1	Load CFIR coefficients: cfir_umts.taps														
	Pages 2-5	Load PFIR coefficients: pfir_umts.taps														
	Page 6	00	00	FREQ			unused									
	Page 7	0C	77	22	20	22	07	70	7D	30	10	06	00	1D	-	30
CH B	Pages 8,9	Load CFIR coefficients: cfir_umts.taps														
	Pages 10-13	Load PFIR coefficients: pfir_umts.taps														
	Page 14	00	C0	FREQ			unused									
	Page 15	0C	77	22	20	22	07	70	7D	50	10	06	00	1D	-	30
CH C	Pages 16,17	Load CFIR coefficients: cfir_umts.taps														
	Pages 18-21	Load PFIR coefficients: pfir_umts.taps														
	Page 22	00	00	FREQ			unused									
	Page 23	0C	77	22	20	22	07	70	7D	30	10	00	00	1D	-	30
CH D	Pages 24,25	Load CFIR coefficients: cfir_umts.taps														
	Pages 26-29	Load PFIR coefficients: pfir_umts.taps														
	Page 30	00	C0	FREQ			unused									
	Page 31	0C	77	22	20	22	07	70	7D	50	10	00	00	1D	-	30
RES	Page 32-63	Load resampler coefficients: res_8x64_60.taps														
	Page 64	20	07	00	14	00	70	00	00	unused						
	Page 65	00	00	00	02	00	00	00	2	00	00	00	02	00	00	00
OUT	Page 98	FF	40	6C	80	29	01	00	10	32	54	76	02	unused		

7.13 DIAGNOSTICS

The following four tables contain the diagnostic test configurations. To run the diagnostics, load the GC4016 with the configuration, set address 0 to 00 in order to clear the resets, set address 5 to 00 to release the counter, wait for the checksum to stabilize (approximately 2²⁰ clock cycles) and then read the checksum, which should match the expected value.

Table 37: Diagnostic Test 1, Expected Checksum = E0

GLOBAL REGISTERS																
ADDRESS	0	1	2	3	4	5	6	7								
VALUE	F0	00	00	00	2D	1C	FF	01								
PAGED REGISTERS																
PAGE	ADDRESS															
	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CFIR COEFFICIENT PAGES: 0,1,8,9,16,17,24,25																
0,8,16,24	FF	7F	00	00	00	00	00	00	00	00	00	00	00	00	00	00
1,9,17,25	00	00	00	00	00	00										
PFIR COEFFICIENT PAGES: 2,3,4,5,10,11,12,13,18,19,20,21,26,27,28,29																
2	FF	7F	00	00	00	00	00	00	00	00	00	00	00	00	00	00
3,4,5	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
FREQUENCY TUNING PAGES:																
6	AA	AA	56	34	12	00										
14	55	55	67	45	23	00										
22	55	55	78	56	34	00										
30	AA	AA	89	67	45	00										
GENERAL CONTROL PAGES:																
7,15,23,31	0C	77	55	50	55	07	70	78	00	01	01	07	00	-	00	20
RESAMPLER COEFFICIENT PAGES:																
32	FF	07	00	00	00	00	00	00	00	00	00	00	00	00	00	00
33-63	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
RESAMPLER CONTROL PAGE:																
64	53	46	00	14	E4	50	00	E4								
RESAMPLER RATIO PAGE:																
65	00	00	00	04	00	00	04	00	00	00	04	00	00	00	00	04
OUTPUT PAGE:																
98	00	A1	6C	C1	D9	00	E4	21	43	65	87	00	02			

Table 38: Diagnostic Test 2, Expected Checksum = 4C

PAGED REGISTERS																
PAGE	ADDRESS															
	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CFIR COEFFICIENT PAGES: 0,1,8,9,16,17,24,25																
0,8,16,24	42	00	2C	01	93	01	6C	FE	0B	F8	A0	F5	2E	FE	CA	10
1,9,17,25	2A	27	FD	39	91	41										
PFIR COEFFICIENT PAGES: 2,3,4,5,10,11,12,13,18,19,20,21,26,27,28,29																
2	1C	00	AD	00	0D	00	4C	FF	2A	FF	51	00	9D	01	2B	01
3	EA	FE	58	FD	CA	FE	25	02	8B	03	D5	00	A1	FC	CD	FB
4	D5	FF	B2	04	EE	04	9E	FF	C3	F9	9A	F9	69	00	8A	08
5	A1	09	23	00	6C	F2	57	EE	23	FF	88	22	E2	46	4A	56
FREQUENCY TUNING PAGES:																
6	AA	AA	67	45	23	00										
14	55	55	78	56	34	00										
22	55	55	89	67	45	00										
30	AA	AA	9A	78	56	00										
GENERAL CONTROL PAGES:																
7,15,23,31	0C	77	55	50	55	0F	70	71	00	00	00	07	00	-	00	08
RESAMPLER COEFFICIENT PAGES:																
32	FF	07	00	00	00	00	00	00	00	00	00	00	00	00	00	00
33-63	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
RESAMPLER CONTROL PAGE:																
64	53	46	00	14	E4	50	00	E4								
RESAMPLER RATIO PAGE:																
65	00	00	00	04	00	00	04	00	00	00	04	00	00	00	00	04
OUTPUT PAGE:																
98	00	A1	6C	C1	D9	00	E4	21	43	65	87	00	02			

Table 39: Diagnostic Test 3, Expected Checksum = EF

PAGED REGISTERS																
PAGE	ADDRESS															
	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CFIR COEFFICIENT PAGES: 0,1,8,9,16,17,24,25																
0,8,16,24	0C	00	A3	FF	C2	FF	24	03	03	05	07	FB	B3	EB	48	F2
1,9,17,25	8C	20	F7	60	FF	7F										
PFIR COEFFICIENT PAGES: 2,3,4,5,10,11,12,13,18,19,20,21,26,27,28,29																
2	02	00	01	00	F5	FF	E9	FF	FE	FF	2D	00	2B	00	D0	FF
3	8B	FF	F8	FF	BF	00	9B	00	43	FF	89	FE	1A	00	43	02
4	66	01	A7	FD	6A	FC	F8	00	BD	05	6A	02	70	F9	35	F8
5	50	04	6A	0E	4D	03	16	EB	7E	EA	AE	19	D5	5E	FF	7F
FREQUENCY TUNING PAGES:																
6	AA	AA	89	67	45	FF										
14	55	55	94	78	56	FF										
22	55	55	45	89	67	FF										
30	AA	AA	56	94	78	FF										
GENERAL CONTROL PAGES:																
7,15,23,31	0C	77	55	50	55	1F	70	6A	00	00	00	07	00	-	55	05
RESAMPLER COEFFICIENT PAGES:																
32	F7	0F	F6	0F	F6	0F	F6	0F	F5	0F	F5	0F	F4	0F	F4	0F
33	F4	0F	F3	0F	F2	0F	F1	0F	F1	0F	F0	0F	EF	0F	EE	0F
34	EE	0F	ED	0F	EC	0F	EB	0F	EB	0F	EA	0F	E9	0F	E9	0F
35	E8	0F	E8	0F	E7	0F	E7	0F	E6	0F	E6	0F	E6	0F	E6	0F
36	E5	0F	E5	0F	E5	0F	E6	0F	E6	0F	E6	0F	E6	0F	E7	0F
37	E7	0F	E8	0F	E9	0F	EA	0F	EB	0F	EC	0F	ED	0F	EE	0F
38	F0	0F	F1	0F	F3	0F	F5	0F	F6	0F	F8	0F	FB	0F	FD	0F
39	FF	0F	02	00	04	00	07	00	9	00	0C	00	0F	00	12	00
40	15	00	19	00	1C	00	1F	00	22	00	26	00	29	00	2D	00
41	30	00	34	00	37	00	3B	00	3E	00	42	00	45	00	48	00
42	4C	00	4F	00	52	00	55	00	58	00	5B	00	5E	00	60	00
43	62	00	65	00	67	00	69	00	6A	00	6C	00	6D	00	6E	00
44	6E	00	6F	00	6F	00	6F	00	6E	00	6D	00	6C	00	6B	00
45	69	00	67	00	65	00	62	00	5F	00	5B	00	57	00	53	00
46	4F	00	4A	00	44	00	3F	00	39	00	32	00	2C	00	24	00
47	1D	00	15	00	0D	00	05	00	FC	0F	F3	0F	EA	0F	E0	0F
48	D7	0F	CD	0F	C3	0F	B8	0F	AE	0F	A3	0F	98	0F	8D	0F
49	83	0F	78	0F	6D	0F	62	0F	57	0F	4C	0F	41	0F	36	0F
50	2C	0F	22	0F	17	0F	0E	0F	4	0F	FB	0E	F2	0E	EA	0E
51	E2	0E	DA	0E	D3	0E	CD	0E	C7	0E	C1	0E	BD	0E	B9	0E
52	B5	0E	B3	0E	B1	0E	B0	0E	AF	0E	B0	0E	B1	0E	B4	0E
53	B7	0E	BB	0E	C1	0E	C7	0E	CE	0E	D6	0E	E0	0E	EA	0E
54	F5	0E	02	0F	10	0F	1E	0F	2E	0F	3F	0F	51	0F	65	0F
55	79	0F	8E	0F	A5	0F	BD	0F	D6	0F	EF	0F	0A	00	26	00
56	43	00	61	00	80	00	A0	00	C1	00	E3	00	05	01	29	01
57	4D	01	72	01	98	01	BE	01	E5	01	0D	02	35	02	5D	02
58	86	02	B0	02	D9	02	03	03	2E	03	58	03	83	03	AD	03
59	D8	03	02	04	2D	04	57	04	81	04	AB	04	D4	04	FD	04
60	25	05	4D	05	74	05	9B	05	C1	05	E6	05	0A	06	2E	06
61	50	06	72	06	92	06	B1	06	CF	06	EC	06	08	07	23	07
62	3C	07	53	07	6A	07	7F	07	92	07	A4	07	B4	07	C3	07
63	D0	07	DC	07	E6	07	EE	07	F5	07	FA	07	FD	07	FF	07
RESAMPLER CONTROL PAGE:																
64	53	7	00	14	E4	50	00	E4								
RESAMPLER RATIO PAGE:																
65	56	34	12	04	89	67	45	02	00	89	67	05	90	68	47	04
OUTPUT PAGE:																
98	00	A1	6C	C1	19	00	E4	21	43	65	87	00	02			

Table 40: Diagnostic Test 4, Expected Checksum = 18

PAGED REGISTERS																
PAGE	ADDRESS															
	16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	31
CFIR COEFFICIENT PAGES: 0,1,8,9,16,17,24,25																
0,8,16,24	2F	00	9A	FF	60	FB	06	FB	CF	05	AB	0C	FA	F8	B0	E1
1,9,17,25	0F	00	CB	51	FF	7F										
PFIR COEFFICIENT PAGES: 2,3,4,5,10,11,12,13,18,19,20,21,26,27,28,29																
2	E0	FF	16	FF	62	00	E8	FF	B6	FF	A5	00	39	FF	8A	00
3	0D	00	3A	FF	49	01	BD	FE	95	00	91	00	4B	FE	41	02
4	38	FE	49	00	BD	01	9D	FC	BB	03	C0	FD	2B	FF	72	04
5	0E	F9	AA	06	6D	FD	CD	FA	45	0F	B6	E6	A8	20	FF	7F
FREQUENCY TUNING PAGES:																
6	00	00	67	45	23	01										
14	00	C0	67	45	23	01										
22	00	00	71	56	34	02										
30	00	C0	71	56	34	02										
GENERAL CONTROL PAGES: 7,15,23,31																
7,23	0C	77	55	50	55	7F	70	64	30	00	02	07	00	-	00	04
15,31	0C	77	55	50	55	7F	70	64	50	00	02	07	00	-	00	04
RESAMPLER COEFFICIENT PAGES:																
32	FF	07	00	00	00	00	00	00	00	00	00	00	00	00	00	00
33-63	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00
RESAMPLER CONTROL PAGE:																
64	53	46	00	14	E4	50	00	E4								
RESAMPLER RATIO PAGE:																
65	00	00	00	04	00	00	00	04	00	00	00	04	00	00	00	04
OUTPUT PAGE:																
98	0F	A8	28	C1	19	00	E4	21	43	65	87	00	02			

Electronic versions of these tables are available by email or from the web as diag_tests.txt.

7.14 OUTPUT TEST CONFIGURATION

The output test takes advantage of the tag modes. To perform the output tests, first configure the chip according to the desired mode, and then change the configuration so that:

TAG_EN=1 and FLUSH_SYNC=7 (always) in all four channels.

TAG_EN turns on the tag mode, and FLUSH_SYNC clears the channels, but allows the channels to continue to operate and output zeroes. Then follow the suggested initialization sequence described in Section 3.12. This will force the output words to be zeroes with the tag bits (see addresses 23-26 in the output page) in the LSBs.

Graychip reserves the right to make changes in circuit design and/or specifications at any time without notice. The user is cautioned to verify that datasheets are current before placing orders. Information provided by Graychip is believed to be accurate and reliable. No responsibility is assumed by Graychip for its use, nor for any infringement of patents or other rights of third parties which may arise from its use. No license is granted by implication or otherwise under any patent rights of Graychip.

GC4016 REGISTER ASSIGNMENT QUICK REFERENCE GUIDE.

Page	Address	Name	7(MSB)	6	5	4	3	2	1	0(LSB)	Suggested Default		
Global	0	Global Reset	GLOBAL_RESET	OUT_BLK_RESET	PAD_RESET	RESAMPLER_RESET	EDGE_WRITE	CK_2X_EN	CK_2X_TEST	CK_LOSS_DETECT	F8 then 08 See below		
	1	Status	ZERO			CHECK_DONE	RES_QOV	RES_IOV	MISSED	READY	00		
	2	Page	PAGE[0:6]							A3	00		
	3	Checksum	CHECKSUM[0:7]								read only		
	4	General Syncs	LVDS	4_BIT_ADDR	OUTPUT_SYNC			DIAG_SYNC			27		
	5	Count Sync	ONE_SHOT	OS_MODE	COUNT_TEST	COUNTER_SYNC			DIAG_SOURCE		D0 then 50		
	6	Counter Byte 0	CNT[0:7]								00		
	7	Counter Byte 1	CNT[7:15]								00		
CHANNEL A	0,1	16-31	CFIR Coef								11 CFIR Coefficients for Channel A, Load LSBs in even addresses, MSBs in odd addresses		
	2,3,4,5	16-31	PFIR Coef								32 PFIR Coefficients for Channel A, Load LSBs in even addresses, MSBs in odd addresses		
	6	16,17	PHASE								16 bit channel A phase, LSBs in 16, MSBs in 17, PHASE= $2^{16}P/2\pi$	0000	
		18,19,20,21	FREQ								32 bit channel A tuning frequency, LSBs in 18, MSBs in 21, FREQ = $2^{32}F/F_{CK}$	00000000	
	Channel A Control Page	7	16 (0x10)	CH_RESET	-			USE_SHIFT	SHIFT			0C	
		17 (0x11)	Frequency Sync		-	FREQ_SYNC			-	PHASE_SYNC		77	
		18 (0x12)	NCO Sync		-	DITHER_SYNC			-	NCO_SYNC		22	
		19 (0x13)	Zero Pad		ZPAD_EN	ZPAD_SYNC			NZEROS			20	
		20 (0x14)	Dec and Flush		-	FLUSH_SYNC			-	DEC_SYNC		22	
		21 (0x15)	Dec Byte 0		DEC[0:7]								07
		22 (0x16)	Dec Byte 1		-	GAIN_SYNC			DEC[8:11]			70	
		23 (0x17)	CIC Scale		-	MIX20B	BIG_SCALE			SCALE			79
		24 (0x18)	SplitIQ		-	QONLY	IONLY	SPLITIQ	NEG_CTL				00
		25 (0x19)	CFIR		TEST	COARSE			-	IDLY_CFIR	QDLY_CFIR	NO_SYM_CFIR	00
		26 (0x1A)	PFIR		-			PEAK_SELECT	IDLY_PFIR	QDLY_PFIR	NO_SYM_PFIR	00	
		27 (0x1B)	Input		MSB_POL	-	IN_FMT		AB_SEL	INPUT_SEL			00
28 (0x1C)		Peak Control		-		PEAK_MODE	PEAK_THRESHOLD	PEAK_SYNC				1D	
29 (0x1D)		Peak Count		PEAK_COUNT								read only	
30 (0x1E)	Fine Gain Byte 0		FINE_GAIN[0:7]								00		
31 (0x1F)	Fine Gain Byte 1		-			FINE_GAIN[8:13]					04		
CHANNEL B	8,9	16-31	CFIR Coef								11 CFIR Coefficients for Channel B, Load LSBs in even addresses, MSBs in odd addresses		
	10-13	16-31	PFIR Coef								32 PFIR Coefficients for Channel B, Load LSBs in even addresses, MSBs in odd addresses		
	14	16,17	PHASE								16 bit channel B phase, LSBs in 16, MSBs in 17, PHASE= $2^{16}P/2\pi$	0000	
		18,19,20,21	FREQ								32 bit channel B tuning frequency, LSBs in 18, MSBs in 20, FREQ = $2^{32}F/F_{CK}$	00000000	
15	16-31	Channel Control		See above									
CHANNEL C	16,17	16-31	CFIR Coef								11 CFIR Coefficients for Channel C, Load LSBs in even addresses, MSBs in odd addresses		
	18-21	16-31	PFIR Coef								32 PFIR Coefficients for Channel C, Load LSBs in even addresses, MSBs in odd addresses		
	22	16,17	PHASE								16 bit channel C phase, LSBs in 16, MSBs in 17, PHASE= $2^{16}P/2\pi$	0000	
		18,19,20,21	FREQ								32 bit channel C tuning frequency, LSBs in 18, MSBs in 20, FREQ = $2^{32}F/F_{CK}$	00000000	
23	16-31	Channel Control		See above									
CHANNEL D	24,25	16-31	CFIR Coef								11 CFIR Coefficients for Channel D, Load LSBs in even addresses, MSBs in odd addresses		
	26-29	16-31	PFIR Coef								32 PFIR Coefficients for Channel D, Load LSBs in even addresses, MSBs in odd addresses		
	30	16,17	PHASE								16 bit channel D phase, LSBs in 16, MSBs in 17, PHASE= $2^{16}P/2\pi$	0000	
		18,19,20,21	FREQ								32 bit channel D tuning frequency, LSBs in 18, MSBs in 20, FREQ = $2^{32}F/F_{CK}$	00000000	
31	16-31	Channel Control		See above									

Power up initialization: (Assumes $\overline{S0}$ is tied to $\overline{S1A}$) (1) Set address 0 to F8; (2) Write to all registers and coefficients; (3) Set address 5 to D0; (4) Set address 0 to 08; (5) Set address 5 to 50.

SYNC MODE	SYNC SOURCE
0,1	off (never asserted)
2	S1A
3	S1B
4	ONE_SHOT
5	TC (terminal count of internal counter)
6,7	on (always active)

GC4016 REGISTER ASSIGNMENT QUICK REFERENCE GUIDE

Page	Address	Name	7(MSB)	6	5	4	3	2	1	0(LSB)	Suggested Default		
RESAMPLER	32-63	16-31	Filter Taps	Resampler Coefficients, 8 LSBs in even addresses, 4 MSBs in odd addresses. (Must be loaded in the blocks 16-23 and 24-31)								Bypass	
	64 (0x40)	16 (0x10)	N-Channels	-	RES_SYNC			NF=(NFILTER-1)		NC=(NCHAN-1)		23	
		17 (0x11)	N-Multiplies	-	NO_SYM_RES	NM=(NMULT-1)							46
		18 (0x12)	Filter Select	FILTER_SEL_3		FILTER_SEL_2		FILTER_SEL_1		FILTER_SEL_0		00	
		19 (0x13)	Final Shift	-	TAG_22	ROUND (12B,16B, 20B,24B)			FINAL_SHIFT			35	
		20 (0x14)	Channel Map	CHAN_MAP_D		CHAN_MAP_C		CHAN_MAP_B		CHAN_MAP_A		E4	
		21 (0x15)	Add To	-	RATIO_SYNC			(must be 0)	ADD_C_TO_D	ADD_B_TO_C	ADD_A_TO_B	70	
		22 (0x16)	Clock Divide	RES_CLK_DIV (The resampler clock rate is 2*F _{CLK} /(RES_CLK_DIV+1))									00
	23 (0x17)	Ratio Map	RATIO_MAP_3		RATIO_MAP_2		RATIO_MAP_1		RATIO_MAP_0		00		
	65 (0x41)	16-19	Res Ratio 0	RATIO_0, Resampler ratio 0. RATIO = 2 ²⁶ (Resampler input sample rate)/(Resampler output sample rate)								04000000	
20-23		Res Ratio 1	RATIO_1, Resampler ratio 1.								04000000		
24-27		Res Ratio 2	RATIO_2, Resampler ratio 2.								04000000		
28-31		Res Ratio 3	RATIO_3, Resampler ratio 3.								04000000		
96,97	16-31	Output Data	See Tables 4,5, and 6 for details										
OUTPUT	98 (0x62)	16 (0x10)	Tristate Controls	EN_PAR	EN_P3	EN_P2	EN_P1	EN_P0	EN_SFS	EN_RDY	EN_SCK	See Table 3	
	17 (0x11)	Output Format	OUT_BLK_SYNC			RDY_WIDTH	TAG_EN	INV_SFS	INV_RDY	INV_SCK			
	18 (0x12)	Output Mode	REVERSE_IQ	OUTPUT_MODE		REAL_ONLY	MASTER	PARALLEL	NIBBLE	LINK			
	19 (0x13)	Frame Control	SFS_MODE			FRAME_LENGTH							
	20 (0x14)	Word Sizes	BLOCK_SIZE			BITS_PER_WORD			WORDS_PER_FRAME				
	21 (0x15)	Clock Control	OUTPUT_ORDER			NSERIAL		SCK_RATE					
	22 (0x16)	Serial Mux	SMUX_3			SMUX_2		SMUX_1		SMUX_0			
	23 (0x17)	Output Tag A	TAG_AQ				TAG_AI				10		
	24 (0x18)	Output Tag B	TAG_BQ				TAG_BI				32		
	25 (0x19)	Output Tag C	TAG_CQ				TAG_CI				54		
	26 (0x1A)	Output Tag D	TAG_DQ				TAG_DI				76		
	27 (0x1B)	Revision	Mask Revision Number										read only
	28 (0x1C)	Miscellaneous	-							EN_SO	EN_4_FS		02

Global Syncs (Addresses 4 and 5)			Channel Syncs (Pages 7, 15, 23 and 31)		
Sync	Value	Description	Sync	Value	Description
DIAG_SYNC	7 (always)	Only used during diagnostics	PHASE_SYNC	7 (always)	Use phase settings as they are loaded
OUTPUT_SYNC	4 (OS)	The SO output is used during initialization	FREQ_SYNC	7 (always)	Use frequency settings as they are loaded
COUNTER_SYNC	4 (OS)	Sync counter with one shot pulse	NCO_SYNC	2 (SIA)	Sync the phase accumulator during initialization. Set to SIB for frequency hopping.
Outout Circuit Sync (Page 98)			DITHER_SYNC	0 (never) or 2 (SIA)	Can free run except during diagnostics, or reset during initialization
OUT_BLK_SYNC	2 (SIA)	Sync the output block during initialization	ZPAD_SYNC	2 (SIA)	Sync the zero pad circuit during initialization
Resampler syncs (Page 64)			DEC_SYNC	2 (SIA)	Sync the channel decimation during initialization
RES_SYNC	2 (SIA)	Sync the Resampler during initialization	FLUSH_SYNC	2 (SIA)	Flush the channels during initialization
RATIO_SYNC	7(always)	Set to always except when synchronously changing ratios	GAIN_SYNC	7 (always)	Use fine gain settings as they are loaded
			PEAK_SYNC	5 (TC)	Periodically capture peak count data

$$GAIN = \left\{ \left(\frac{1}{NZEROS + 1} \right) N^5 2^{(SHIFT + SCALE + 6 \times BIG_SCALE - 62)} \right\} (2^{COARSE}) \left(\frac{CFIR_SUM}{65536} \right) \left(\frac{PFIR_SUM}{65536} \right) \left(\frac{FINE_GAIN}{1024} \right) \left(\frac{RES_SUM}{32768 \times NDELAY} \right) (2^{FINAL_SHIFT})$$

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
GC4016-PB	ACTIVE	BGA	GJZ	160	126	TBD	Call TI	Level-3-220C-168 HR
GC4016-PBZ	ACTIVE	BGA	ZJZ	160	126	Pb-Free (RoHS)	SNAGCU	Level-3-260C-168 HR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008, Texas Instruments Incorporated